

LatticeECP3 SERDES/PCS Usage Guide

Technical Note

FPGA-TN-02190-1.9

January 2020



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Contents

1.	Intro	duction	9
2.	Featu	ires	9
2	2.1.	New Features Over LatticeECP2M [™] SERDES/PCS	9
3.	Using	This Technical Note	10
4.	Stand	lards Supported	10
5.	Archi	tecture Overview	11
5	5.1.	PCS Quads and Channels	12
5	5.2.	Per Channel SERDES/PCS and FPGA Interface Ports	12
5	5.3.	Detailed Channel Block Diagram	12
5	5.4.	Clocks and Resets	13
5	5.5.	Transmit Data Bus	13
5	5.6.	Receive Data Bus	.14
5	5.7.	Mode-Specific Control/Status Signal Descriptions	15
5	5.8.	SERDES/PCS	16
5	5.9.	I/O Descriptions	.17
6.	SERD	ES/PCS Functional Description	.19
7.	SERD	ES	20
7	' .1.	Equalizer	20
7	' .2.	Pre-Emphasis	20
7	′.3.	Reference Clocks	20
7	' .4.	SERDES Clock Architecture	20
7	' .5.	Rate Modes	21
7	' .6.	Reference Clock from an FPGA Core	22
7	.7.	Full Data, Div 2 and Div 11 Data Rates	23
7	′.8.	Dynamic Switching Between Full Rate and Half Rate (DIV2)	23
7	' .9.	Reference Clock Sources	24
7	<i>'</i> .10.	Spread Spectrum Clocking (SSC) Support	24
7	'.11.	Loss of Signal	.24
7	<i>'</i> .12.	Loss Of Lock	.25
7	<i>'</i> .13.	TX Lane-to-Lane Skew	25
7	<i>'</i> .14.	SERDES PCS Configuration Setup	26
7	<i>'</i> .15.	Auto-Configuration File	26
7	<i>'</i> .16.	Transmit Data	26
7	<i>'</i> .17.	Receive Data	26
7	<i>'</i> .18.	8b10b Decoder	.27
7	<i>'</i> .19.	External Link State Machine Option	.27
7	.20.	Clock Tolerance Compensation	.28
7	.21.	Calculating Minimum Interpacket Gap	31
7	.22.	PCS Module Generation in IPexpress	32
7	′.23.	8-Bit and 10-Bit SERDES-Only Modes	43
7	.24.	Generic 8b10b Mode	43
7	.25.	LatticeECP3 PCS in Gigabit Ethernet and SGMII Modes	.44
7	.26.	XAUI Mode	46
7	.27.	LatticeECP3 PCS in PCI Express Revision 1.1 (2.5Gpbs) Mode	46
7	.28.	PCI Express Beacon Support	50
7	.29.	SDI (SMPTE) Mode	51
7	′.30.	Serial RapidIO (SRIO) Mode	52
7	7.31.	Serial Digital Video and Out-Of-Band Low Speed SERDES Operation	52
7	.32.	Open Base Station Architecture Initiative (OBSAI)	53
7	′.33.	Common Public Radio Interface (CPRI)	54
7	′.34.	SONET/SDH	56
7	.35.	FPGA Interface Clocks	57

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7.36. Case	e I_a: 8/10-Bit, CTC FIFO and RX/TX FIFOs Not Bypassed	.60
7.37. Case	e I_b: 8/10-Bit, CTC FIFO Bypassed	.61
7.38. Case	e I_c: 8/10-Bit, RX/TX FIFO Bypassed	62
7.39. Case	e I_d: 8/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed	.62
7.40. Case	e II_a: 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed	.63
7.41. Case	e II_b: 16/20-bit, CTC FIFO Bypassed	.63
8. SERDES/PC	CS Block Latency	.64
8.1. SERD	DES Client Interface	65
8.2. Inter	rrupts and Status	.67
9. SERDES De	ebug Capabilities	.69
9.1. PCS I	Loopback Modes	.69
9.2. ORC/	Astra	.70
9.3. Othe	er Design Considerations	.72
9.4. 16/2	20-Bit Word Alignment	.72
10. SERDES/PC	CS RESET	.76
10.1. Rese	et Sequence and Reset State Diagram	.76
10.2. Rese	et Sequence Generation	.76
10.2.1. Lo	ock Status Signals Definitions	.76
10.3. TX R	eset Sequence	.77
10.4. RX R	leset Sequence	.77
Appendix A. Co	nfiguration Registers	.81
A.1. Quad Re	gisters Overview	.81
A.2. Per Quad	d PCS Control Registers Details	.81
A.3. Per Quad	d PCS Control Registers Details	.83
A.4. Per Quad	d Reset and Clock Control Registers Details	.85
A.5. Per Quad	d PCS Status Registers Details	.85
A.6. Per Quad	d SERDES Status Registers Details	.87
A.7. Channel	Registers Overview	.87
A.8. Per Chan	nnel PCS Control Registers Details	.88
A.9. Per Chan	nnel SERDES Control Registers Details	.92
A.10. Per Cha	annel Reset and Clock Control Registers Details	.95
A.11. Per Cha	annel PCS Status Registers Details	.95
A.12. Per Cha	annel SERDES Status Registers Details	.96
Appendix B. Reg	gister Settings for Various Standards	.98
B.1. Per Chan	nnel Register Settings for Various Standards	.98
B.2. Per Quad	d Register Settings for Various Standards	.98
Appendix C. Att	tribute Cross Reference Table	.99
Appendix D. Lat	ttice Diamond Overview1	.05
D.1. Converti	ing an ispLEVER Project to Lattice Diamond1	.05
D.2. Adjusting	g PCS Modules1	.05
D.3. Regenera	ate PCS Modules1	.05
D.4. Using IPe	express with Lattice Diamond1	.06
D.5. Creating	a New Simulation Project Using Simulation Wizard1	.06
References		.08
Technical Suppo	ort Assistance1	.09
Revision History	у1	.10

Figures

Figure 5.1 LatticeECP3-150 Block Diagram	11
Figure 5.2 SERDES/PCS Quad Block Diagram	12
Figure 5 3 LatticeFCP3 SERDES/PCS Detailed Channel Block Diagram	13
ingure 3.5 Eutroce of 5 ELDES/1 es Detailed endimer Dioek Didgram	



Figure 5.4 SERDES/PCS Block Signal Interface	16
Figure 7.1 SERDES Clock Architecture	21
Figure 7.2 Reference Clock Block Diagram	22
Figure 7.3 Example of Full Data Rate and Half Data Rate in the IPexpress GUI	23
Figure 7.4 Rate Mode Control Signals	24
Figure 7.5 Loss of Signal Detector	25
Figure 7.6 PCS Word Aligner and Link State Machine Options	28
Figure 7.7 PCS PCS Receive Path for Gigabit Ethernet Mode (Channel 0 Example)	28
Figure 7.8 Clock Tolerance Compensation 1-Byte Deletion Example	29
Figure 7.9 Clock Tolerance Compensation 1-Byte Insertion Example	29
Figure 7.10 Clock Tolerance Compensation 2-Byte Deletion Example	29
Figure 7.11 Clock Tolerance Compensation 2-Byte Insertion Example	30
Figure 7.12 Clock Tolerance Compensation 4-Byte Deletion Example	30
Figure 7.13 Clock Tolerance Compensation 4-Byte Insertion Example	30
Figure 7.14 SERDES_PCS Diamond User Flow	32
Figure 7.15 IPexpress PCS Main Window	33
Figure 7.16 Configuration GUI - Quad Setup Tab	34
Figure 7.17 Configuration GUI - Reference Clocks Setup Tab	35
Figure 7.18 Configuration GUI - SERDES Advanced Setup Tab	36
Figure 7.19 High-Speed I/O Terminations	38
Figure 7.20 Configuration GUI - PCS Advanced1 Setup Tab	38
Figure 7.21 Configuration GUI – PCS Advanced2 Setup Tab	39
Figure 7.22 Configuration GUI – Control Setup Tab	40
Figure 7.23 Configuration GUI – Generation Options Tab	41
Figure 7.24 PCI Express Interface Diagram	48
Figure 7.25 Transmit Electrical Idle	49
Figure 7.26 PCI Express Mode Receiver Detection Sequence	50
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support	51
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support	51 53
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario)	51 53 55
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface	51 53 55 57
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram	51 53 55 57 57
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOS NOT Bypassed	51 53 55 57 57 60
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed	51 53 55 57 57 60 61
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed	51 53 55 57 57 60 61 62
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed	51 53 55 57 60 61 62 62
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed	51 53 55 57 60 61 62 62 63
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support	51 53 55 57 60 61 62 62 63 63
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support	51 53 55 57 60 61 62 62 63 63 65
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support	51 53 57 57 60 61 62 63 63 65 66
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support	51 53 57 57 60 61 62 63 63 63 65 66 67
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 8.1 Transmitter and Receiver Latency Block Diagram Figure 8.3 SCI WRITE Cycle, Critical Timing Figure 8.4 SCI READ Cycle, Critical Timing	51 53 55 57 60 61 62 63 63 65 66 67 67
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 8.1 Transmitter and Receiver Latency Block Diagram Figure 8.3 SCI WRITE Cycle, Critical Timing Figure 8.4 SCI READ Cycle, Critical Timing	51 53 55 57 60 61 62 63 63 65 66 67 69
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 8.1 Transmitter and Receiver Latency Block Diagram Figure 8.3 SCI Interface Block Diagram Figure 8.4 SCI READ Cycle, Critical Timing Figure 9.1 Three Loopback Modes Figure 9.2 Loopback Enable Signals	51 53 57 57 60 61 62 62 63 63 65 66 67 69 69
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support	51 53 57 57 60 61 62 62 62 63 63 65 66 67 69 69 70
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOS Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 8.1 Transmitter and Receiver Latency Block Diagram Figure 8.2 SCI Interface Block Diagram Figure 8.4 SCI READ Cycle, Critical Timing Figure 9.1 Three Loopback Modes Figure 9.1 Three Loopback Modes Figure 9.3 ORCAstra Top-Level Screen Shot	51 53 57 57 60 61 62 63 63 63 65 66 67 69 70 70
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO Bypassed Figure 8.1 Transmitter and Receiver Latency Block Diagram Figure 8.2 SCI Interface Block Diagram Figure 8.3 SCI WRITE Cycle, Critical Timing Figure 8.4 SCI READ Cycle, Critical Timing Figure 9.1 Three Loopback Modes Figure 9.1 Three Loopback Modes Figure 9.2 Loopback Enable Signals	51 53 57 57 60 61 62 63 63 63 65 66 67 69 70 70 71
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 8.1 Transmitter and Receiver Latency Block Diagram Figure 8.2 SCI Interface Block Diagram Figure 8.4 SCI READ Cycle, Critical Timing Figure 9.1 Three Loopback Modes Figure 9.1 Oxed RASTR The Stote Sto	51 53 57 57 60 61 62 62 63 63 65 66 67 69 70 70 71 71
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 8.1 Transmitter and Receiver Latency Block Diagram Figure 8.2 SCI Interface Block Diagram Figure 8.3 SCI WRITE Cycle, Critical Timing Figure 8.4 SCI READ Cycle, Critical Timing Figure 9.1 Three Loopback Modes Figure 9.2 Loopback Enable Signals Figure 9.4 JTAG Device Selection Figure 9.4 JTAG Device Selection Figure 9.5 Hub ID Selection Figure 9.4 JTAG Device Selection Figure 9.5 Hub ID Selection Figure 9.7 SERDES Buffer Options Window	51 53 57 57 60 61 62 62 62 63 63 65 66 67 69 70 70 71 71 72
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support	51 53 57 57 60 61 62 62 62 63 63 65 66 67 69 70 71 71 71 72 74
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support	51 53 55 57 57 60 61 62 63 63 63 65 66 67 69 70 71 71 71 74 74
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, CTC FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 8.3 SL INCTC FIFO and RX/TX FIFOS NOT Bypassed Figure 8.3 SC INCTC FIFO Bypassed Figure 8.3 SCI Interface Block Diagram Figure 8.4 SCI READ Cycle, Critical Timing Figure 8.4 SCI READ Cycle, Critical Timing Figure 9.1 Three Loopback Modes Figure 9.2 Loopback Enable Signals Figure 9.3 ORCAstra Top-Level Screen Shot Figure 9.4 JTAG Device Selection Figure 9.4 SERDES Buffer Options Window Figure 9.7 SERDES Buffer Options Window Figure 9.7 SERDES Buffer Options Window Figure 9.7 SERDES PCS Reset Diagram	51 53 55 57 57 60 61 62 63 63 63 65 66 67 69 70 70 71 71 71 74 74 74
Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support Figure 7.28 Possible Implementation of Serial Digital Video Support Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario) Figure 7.30 SONET/SDH Line Interface Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 7.33 8b/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, CTC FIFO Bypassed Figure 7.34 8/10-Bit, CTC FIFO Bypassed Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOS Bypassed Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 7.37 16/20-bit, CTC FIFO and RX/TX FIFOS NOT Bypassed Figure 8.1 Transmitter and Receiver Latency Block Diagram Figure 8.2 SCI Interface Block Diagram Figure 8.3 SCI WRITE Cycle, Critical Timing Figure 8.4 SCI READ Cycle, Critical Timing Figure 9.1 Three Loopback Modes Figure 9.3 ORCAstra Top-Level Screen Shot Figure 9.4 JTAG Device Selection Figure 9.5 Hub ID Selection Figure 9.7 SERDES/PCS Quad Reset and Power-Down Controls Figure 9.7 SERDES/PCS Quad Reset and Power-Down Controls Figure 9.7 SERDES/PCS Reset Diagram Figure 10.1 TX Reset State Diagram	51 53 57 57 60 61 62 62 63 63 65 66 67 69 70 70 71 71 74 74 74 74 73



Tables

Table 4.1. Standards Supported by the SERDES	10
Table 5.1. Number of SERDES/PCS Quads per LatticeECP3 Device	11
Table 5.2. Data Bus Usage by Mode	14
Table 5.3. Control Signals and their Functions	15
Table 5.4. SERDES_PCS I/O Descriptions	17
Table 7.1. TXPLL and RX CDRPLL Supported Modes	22
Table 7.2. TXPLL and RX CDRPLL Supported Modes	23
Table 7.3. Response Time for Loss of Signal Detector	25
Table 7.4. Response Time for Loss-of-Lock Detector	25
Table 7.5. Minimum Interpacket Gap Multiplier	31
Table 7.6. SERDES_PCS GUI Attributes - Quad Tab Setup	34
Table 7.7. SERDES_PCS GUI Attributes - Reference Clocks Setup Tab	35
Table 7.8. SERDES_PCS GUI Attributes – SERDES Advanced Setup Tab	36
Table 7.9. SERDES/PCS GUI – PCS Advanced1 Setup Tab	39
Table 7.10. SERDES/PCS GUI – PCS Advanced2 Setup Tab	40
Table 7.11. Tab 5, SERDES_PCS GUI Attributes – Control Setup Tab	41
Table 7.12. GbE IDLE State Machine Control and Status Signals	45
Table 7.13. PCI Express Mode Specific Ports	47
Table 7.14. rxstatus Encoding	47
Table 7.15. Differential PCI Express Specifications	48
Table 7.16. Six Interface Cases Between the SERDES/PCS Quad and the FPGA Core	58
Table 7.17. Decision Matrix for Six Interface Cases	59
Table 8.1. SERDES/PCS Latency Breakdown	64
Table 8.2. Word Aligner Latency vs. Offset	65
Table 8.3. SCI Address Map for Up to Four SERDES/PCS Quads	66
Table 8.4. Timing Parameters	67
Table 8.5. Quad Interrupt Sources	68
Table 8.6. Quad Interrupt Sources	68
Table 9.1. Simulation Model Locations	72
Table 9.2. SERDES/PCS Reset Table	75
Table 9.3. Reset Controls Description ^{1, 2, 3}	75
Table 9.4. Reset Pulse Specification	75
Table 9.5. Power-Down Control Description	76
Table 9.6. Power-Down/Power-Up Timing Specification	76
Table A.1. Quad Interface Registers Map	81
Table A.2. PCS Control Register QD_00	81
Table A.3. PCS Control Register QD_01	82
Table A.4. PCS Control Register QD_02	82
Table A.5. PCS Control Register QD_03	82
Table A.6. PCS Control Register QD_04	82
Table A.7. PCS Control Register QD_05	82
Table A.8. PCS Control Register QD_06	82
Table A.9. PCS Control Register QD_07	82
Table A.10. PCS Control Register QD_08	82
Table A.11. PCS Control Register QD_09	83
Table A.12. SERDES Control Register QD_0A	83
Table A.13. SERDES Control Register QD_0B	84
Table A.14. PCS Control Register QD_0C	84
Table A.15. PCS Control Register QD_0D	84

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Table A.16.	PCS Control Register QD_0E	84
Table A.17.	PCS Control Register QD_0F	85
Table A.18.	PCS Control Register QD_10	85
Table A.19.	PCS Control Register QD_11	85
Table A.20.	PCS Status Register QD_20	85
Table A.21.	PCS Status Register QD_21	85
Table A.22.	PCS Interrupt Status Register QD_22	86
Table A.23.	PCS PCS Status Register QD_23	86
Table A.24.	PCS Status Register QD_24	86
Table A.25.	SERDES Status Register QD_25	87
Table A.26.	SERDES Interrupt Status Register QD_26	87
Table A.27.	SERDES Status Register QD_27	87
Table A.28.	SERDES Status Register QD_28	87
Table A.29.	Channel Interface Registers Map	87
Table A.30.	PCS Control Register CH_00	88
Table A.31.	PCS Control Register CH_01	88
Table A.32.	PCS Control Register CH_02	89
Table A.33.	PCS Control Register CH_03	89
Table A.34.	PCS Control Register CH_04	89
Table A.35.	PCS Control Register CH_05	90
Table A.36.	PCS Control Register CH_06	90
Table A.37.	PCS Control Register CH_07	90
Table A.38.	Control Register CH_08	90
Table A.39.	PCS Control Register CH_09	90
Table A.40.	PCS Control Register CH_0A	90
Table A.41.	PCS Control Register CH_0B	91
Table A.42.	PCS Control Register CH_OC	91
Table A.43.	PCS Control Register CH_0D	91
Table A.44.	PCS Control Register CH_0E	91
Table A.45.	PCS Interrupt Control Register CH_0F	91
Table A.46.	SERDES Control Register CH_10	92
Table A.47.	SERDES Control Register CH_11	92
Table A.48.	SERDES Control Register CH_12	92
Table A.49.	SERDES Control Register CH_13	93
Table A.50.	SERDES Control Register CH_14	93
Table A.51.	SERDES Control Register CH_15	93
Table A.52.	SERDES Control Register CH_16	94
Table A.53.	SERDES Interrupt Control Register CH_17	94
Table A.54.	Reset and Clock Control Register CH_18	95
Table A.55.	Reset and Clock Control Register CH_19	95
Table A.56.	PCS Status Register CH_20	95
Table A.57.	PCS Status Register CH_21	95
Table A.58.	PCS Status Register CH_22	95
Table A.59.	PCS Interrupt Status Register CH_23	96
Table A.60.	PCS Status Register CH_24	96
Table A.61.	PCS Status Register CH_25	96
Table A.62.	SERDES Status Register CH_26	96
Table A.63.	SERDES Status Register CH_27	97
Table A.64.	SERDES Status Register CH_28	97
Table A.65.	SERDES Status Register CH_29	97
Table A.66.	SERDES Interrupt Status Register CH_2A	97
Table A.67.	PCS Status Register CH_2B	97
Table A.68.	PCS Status Register CH_2C	97
Table B.1. F	Per Channel Register Settings for Various Standards	98



Table B.2. Per Quad Register Settings for Various Standards	98
Table C.1. Attribute Cross-Reference Table	99
Table C.2. Protocol-Specific SERDES Setup Options	103
Table D.1. SERDES PCS GUI Attributes – Generation Options Tab	106



1. Introduction

The LatticeECP3[™] FPGA family combines a high-performance FPGA fabric, high-performance I/Os and up to 16 channels of embedded SERDES with associated Physical Coding Sublayer (PCS) logic. The PCS logic can be configured to support numerous industry-standard, high-speed serial data transfer protocols.

Each channel of PCS logic contains dedicated transmit and receive SERDES for high-speed, full-duplex serial data transfer at data rates up to 3.2 Gbps. The PCS logic in each channel can be configured to support an array of popular data protocols including GbE, XAUI, SONET/SDH, PCI Express, SRIO, CPRI, OBSAI, SD-SDI, HD-SDI and 3G-SDI. In addition, the protocol-based logic can be fully or partially bypassed in a number of configurations to allow users flexibility in designing their own high-speed data interface.

The PCS also provides bypass modes that allow a direct 8-bit or 10-bit interface from the SERDES to the FPGA logic. Each SERDES pin can be independently DC-coupled and can allow for both high-speed and low-speed operation on the same SERDES pin for applications such as Serial Digital Video.

2. Features

- Up to 16 Channels of High-Speed SERDES
 - 150 Mbps to 3.2 Gbps for Generic 8b10b, 10-bit SERDES and 8-bit SERDES modes. Refer to Table 4.1.
 - 230 Mbps to 3.2 Gbps per channel for all other protocols
 - 3.2 Gbps operation with low 110 mW power per channel
 - Receive equalization and transmit pre-emphasis for small form factor backplane operation
 - Supports PCI Express, Gigabit Ethernet (1GbE and SGMII) and XAUI, plus multiple other standards
 - Supports user-specified generic 8b10b mode
 - Out-of-band (OOB) signal interface for low-speed inputs (video application)
- Multiple Clock Rate Support
 - Separate reference clocks for each PCS quad allow easy handling of multiple protocol rates on a single device
 - Full-Function Embedded Physical Coding Sub-layer (PCS) Logic Supporting Industry Standard Protocols
 - Up to 16 channels of full-duplex data supported per device
 - Multiple protocol support on one chip
 - Supports popular 8b10b-based packet protocols
 - SERDES Only mode allows direct 8-bit or 10-bit interface to FPGA logic
 - Multiple Protocol Compliant Clock Tolerance Compensation (CTC) Logic
 - Compensates for frequency differential between reference clock and received data rate
 - Allows user-defined skip pattern of 1, 2, or 4 bytes in length
- Integrated Loopback Modes for System Debugging
 - Three loopback modes are provided for system debugging

2.1. New Features Over LatticeECP2M[™] SERDES/PCS

- Supports multiple protocols/standards within one quad of SERDES. The standards are required to have nominal frequencies either at the full rate or half rate of the supported standards listed in Table 4.1. Configuration flexibility should not be a barrier to supporting different mixes of protocols and standards. PCI Express, Gigabit Ethernet, SGMII and Serial RapidIO modes are supported in the multi-protocol grouping.
- Supports XAUI compliance features and extended SERDES maximum performance to 3.2 Gbps.
- Supports SONET/SDH OC-3/STM-1, OC-12/STM-4 and OC-48/STM-16 rates.
- Added support for per RX and TX DIV11 for SD-SDI, HD-SDI and 3G-SDI. Multi-rate SDI support.



3. Using This Technical Note

The ispLEVER[®] design tools from Lattice support all modes of the PCS. Most modes are dedicated to applications for a specific industry standard data protocol. Other modes are more general purpose in nature and allow designers to define their own custom application settings. ispLEVER design tools allow the user to define the mode for each quad in their design. This technical note describes operation of the SERDES and PCS for all modes supported by ispLEVER. If you are using Lattice Diamond[®] design software, see Appendix D. Lattice Diamond Overview.

This document provides a thorough description of the complete functionality of the embedded SERDES and associated PCS logic. Electrical and timing characteristics of the embedded SERDES are provided in the LatticeECP3 Family Data Sheet. Operation of the PCS logic is provided in the PCS section of this document. A table of all status and control registers associated with the SERDES and PCS logic which can be accessed via the SCI Bus is provided in the appendices. Package pinout information is provided in the Pinout Information section of the LatticeECP3 Family Data Sheet.

4. Standards Supported

The supported standards are listed in Table 4.1.

Standard	Data Rate (Mbps)	System Reference Clock (MHz)	FPGA Clock (MHz)	Number of General/Link Width	Encoding Style
PCI Express 1.1	2500	100	250	x1, x2, x4	8b10b
Gigabit Ethernet, SGMII	1250	125	125	x1	8b10b
	2500	125	250	x1	8b10b
	3125	156.25	156.25	x1	8b10b
XAUI	3125	156.25	156.25	x4	8b10b
Serial RapidlO Type I, Serial RapidlO Type II, Serial RapidlO Type III	1250, 2500, 3125	125, 125, 156.25	125, 250, 156.25	x1, x4	8b10b
OBSAI-1, OBSAI-2, OBSAI-3, OBSAI-4	768, 1536, 2304, 3072	76.8, 76.8, 153.6, 115.2, 153.6	76.8, 153.6, 230.4, 153.6	x1	8b10b
CPRI-1, CPRI-2, CPRI-3, CPRI-4	614.4, 1228.8, 2457.6, 3072.0	61.44, 61.44, 122.88, 122.88, 153.6	61.44, 122.88, 122.88 153.6	x1	8b10b
SD-SDI (259M, 344M)	143 ¹ , 177 ¹ , 270, 360, 540	14.3 ¹ , 17.7 ¹ , 27, 36, 54	143, 177, 27, 36, 54	x1	NRZI/Scrambled
HD-SDI (292M)	1483.5 <i>,</i> 1485	74.175, 148.35, 74.25, 148.50	74.175, 148.35, 74.25, 148.5	x1	NRZI/Scrambled
3G-SDI (424M)	2967 <i>,</i> 2970	148.35, 148.5	148.35 <i>,</i> 148.5	x1	NRZI/Scrambled
SONET STS-3 ² SONET STS-12 ² SONET STS-48 ²	155.52 622.08 2488	15.552 62.208 248.8	15.552 62.208 248.8	x1	N/A
10-Bit SERDES	150 - 3125	15 - 312.5	15 - 312.5	x1, x2, x3, x4	N/A
8-Bit SERDES	150 - 3125	15 - 312.5	15 - 312.5	x1, x2, x3, x4	N/A
Generic 8b10b	150 - 3125	15 - 312.5	15 - 312.5	x1, x2, x3, x4	8b10b

Table 4.1. Standards Supported by the SERDES

Notes:

1. For slower rates, the SERDES are bypassed and signals are directly fed to the FPGA core.

2. The SONET protocol is supported in 8-Bit SERDES mode. Refer to the SONET section of this document for detailed information.

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5. Architecture Overview

The SERDES/PCS block is arranged in quads containing logic for four independent full-duplex data channels. Figure 5.1 shows the arrangement of SERDES/PCS quads on the LatticeECP3-150 FPGA (other devices have fewer quads).



Figure 5.1 LatticeECP3-150 Block Diagram

Table 5.1 shows the number of available SERDES/PCS quads for each device in the LatticeECP3 family.

 Table 5.1. Number of SERDES/PCS Quads per LatticeECP3 Device

Standard	Data Rate (Mbps)	System Reference Clock (MHz)	FPGA Clock (MHz)	Number of General/Link Width	Encoding Style
8-Bit SERDES	150 - 3125	15 - 312.5	15 - 312.5	x1, x2, x3, x4	N/A
Generic 8b10b	150 - 3125	15 - 312.5	15 - 312.5	x1, x2, x3, x4	8b10b

Note:

1. Channels 0 and 3 are available.

Every quad can be programmed into one of several protocol-based modes. Each quad requires its own reference clock which can be sourced externally from package pins or internally from the FPGA logic.

Each quad can be programmed with select protocols that have nominal frequencies which can utilize the full and halfrate options per channel. For example, a PCI Express x1 at 2.5 Gbps and a Gigabit Ethernet channel can be utilized in the same quad using the half-rate option on the Gigabit Ethernet channel. If a quad shares a PCI Express x1 channel with a non-PCI Express channel, ensure that the reference clock for the quad is compatible with all protocols within the quad. For example, a PCI Express spread spectrum reference clock is not compatible with most Gigabit Ethernet applications.



Since each quad has its own reference clock, different quads can support different standards on the same chip. This feature makes the LatticeECP3 family of devices ideal for bridging between different standards.

PCS quads are not dedicated solely to industry standard protocols. Each quad (and each channel within a quad) can be programmed for many user-defined data manipulation modes. For example, word alignment and clock tolerance compensation can be programmed for user-defined operation.

5.1. PCS Quads and Channels

Each quad on a device supports up to four channels of full-duplex data. One to four channels in a quad can be utilized, depending on the application. Users can set many options for each channel independently within a given quad.

Figure 5.1 shows an example of a device with four PCS quads which contain a total of 16 PCS channels.

5.2. Per Channel SERDES/PCS and FPGA Interface Ports

All PCS quads regardless of the mode used have the same external high-speed serial interface at the package pins. However, every PCS mode has its own unique list of input/output ports from/to the FPGA logic appropriate to the protocol chosen for the quad. A detailed description of the quad input/output signals for each mode is provided in this document. Figure 5.2 describes a simplified SERDES/PCS quad.



Figure 5.2 SERDES/PCS Quad Block Diagram

5.3. Detailed Channel Block Diagram

Figure 5.3 is a detailed block diagram representation of the major functionality in a single channel of the LatticeECP3 SERDES/PCS. This diagram shows all the major blocks and the majority of the control and status signals that are visible to the user logic in the FPGA. This diagram also shows the major sub-blocks in the channel – SERDES, SERDES Bridge, PCS Core and the FPGA Bridge.







Figure 5.3 LatticeECP3 SERDES/PCS Detailed Channel Block Diagram

5.4. Clocks and Resets

A PCS quad supplies per-channel locked reference clocks and per-channel recovered receive clocks to the FPGA logic interface. Each PCS quad provides clocks on both primary and secondary FPGA clock routing. The PCS/FPGA interface also has ports for the transmit and receive clocks supplied from the FPGA fabric for all four channels in each quad.

Each quad has reset inputs to force reset of both the SERDES and PCS logic in a quad or just the SERDES. In addition, separate resets dedicated for the PCS logic are provided for each channel for both the transmit and receive directions.

5.5. Transmit Data Bus

The signals for the transmit data path are from the FPGA to the FPGA Bridge in the PCS Block. The datapath can be geared 2:1 to the internal PCS data path, which is 8 bits wide (plus control/status signals). The highest speed of the interface for PCI Express x1 is 250 MHz in 1:1 geared mode. With 2:1 gearing (i.e. a 16-bit wide data path), a possible speed is 156.25 MHz (for XAUI 4x channel mode). The SERDES and PCS will support data rates up to 3.2 Gbps data that correspond to an interface speed of 160 MHz (with 2:1 gearing).



5.6. Receive Data Bus

The signals for the receive path are from the FPGA Bridge in the PCS Block to the FPGA. The data path may be geared 2:1 to the internal PCS data path which is 8 bits wide. The data bus width at the FPGA interface is 16 bits wide. It is possible to disable the 2:1 gearing via a software register bit, in which case, the bus widths are halved (8 bits wide). When the data is geared 2:1, the lower bits (rxdata[9:0]) correspond to the word that has been received first and the higher bits (rxdata[19:10]) correspond to the word that has been received second. If the data is not geared 2:1, the lower bits ((rxdata[9:0]) are the active bits and the higher bits should not be used. Table 5.2 describes the use of the data bus for each protocol mode.

Table 5.2. Data Bus Usage by Mode

Data Bus PCS	G8B10B	CPRI	OBSAI	PCI Express	SRIO	Gigabit Ethernet	XAUI	8-Bit	10-Bit SERDES	SDI
Cell Name ⁴								SERDES		
FF_TX_D_0_0	txdata_ch0[0]									
FF_TX_D_0_1	xdata_ch0[1]									
FF_TX_D_0_2	<pre>kdata_ch0[2]</pre>									
FF_TX_D_0_3	txdata_ch0[3]	data_ch0[3]								
FF_TX_D_0_4	txdata_ch0[4]									
FF_TX_D_0_5	txdata_ch0[5]									
FF_TX_D_0_6	txdata_ch0[6]									
FF_TX_D_0_7	txdata_ch0[7]						1		1	
FF_TX_D_0_8	tx_k_ch0[0]						txc_ch0[0]	GND	txdata_ch0[8]	
FF_TX_D_0_9	tx_force_disp_ch0[0] ¹				GND				txdata_ch0[9]	
FF_TX_D_0_10	tx_disp_sel_ch0[0] ¹				GND	xmit_ch0[0] ²	GND			
FF_TX_D_0_11	GND			pci_ei_en_ch0[0]	GND	tx_disp_correct_ch0[0]	GND			
FF_TX_D_0_12	txdata_ch0[8]								txdata_ch0[10]	
FF_TX_D_0_13	txdata_ch0[9]								txdata_ch0[11]	
FF_TX_D_0_14	txdata_ch0[10]								txdata_ch0[12]	
FF_TX_D_0_15	txdata_ch0[11]								txdata_ch0[13]	
FF_TX_D_0_16	txdata_ch0[12]								txdata_ch0[14]	
FF_TX_D_0_17	txdata_ch0[13]								txdata_ch0[15]	
FF_TX_D_0_18	txdata_ch0[14]								txdata_ch0[16]	
FF_TX_D_0_19	txdata_ch0[15]								txdata_ch0[17]	
FF_TX_D_0_20	tx_k_ch0[1]				-		txc_ch0[1]	GND	txdata_ch0[18]	
FF_TX_D_0_21	tx_force_disp_ch0[1] ¹				GND				txdata_ch0[19]	
FF_TX_D_0_22	tx_disp_sel_ch0[1] ¹				GND	xmit_ch0[1] ²	GND			
FF_TX_D_0_23	GND			pci_ei_en_ch0[1]	GND	tx_disp_correct_ch0[1]	GND			
FF_RX_D_0_0	rxdata_ch0[0]									
FF_RX_D_0_1	rxdata_ch0[1]									
FF_RX_D_0_2	rxdata_ch0[2]									
FF_RX_D_0_3	rxdata_ch0[3]									
FF_RX_D_0_4	rxdata_ch0[4]									
FF_RX_D_0_5	rxdata_ch0[5]									
FF_RX_D_0_6	rxdata_ch0[6]									
FF_RX_D_0_7	rxdata_ch0[7]						1	[1	
FF_RX_D_0_8	rx_k_ch0[0]			1	[rxc_ch0[0]	NC	rxdata_ch0[8]	
FF_RX_D_0_9	rx_disp_err_ch0[0]			rxstatus0_ch0[0]	rx_disp_err_ch0[0]			NC	rxdata_ch0[9]	
FF_RX_D_0_10	rx_cv_err_ch0[0] ³			rxstatus0_ch0[1]	rx_cv_err_ch0[0] ³			NC		
FF_RX_D_0_11	NC			rxstatus0_ch0[2]	NC				1	
FF_RX_D_0_12	rxdata_ch0[8]								rxdata_ch0[10]	
FF_RX_D_0_13	rxdata_ch0[9]								rxdata_ch0[11]	
FF_RX_D_0_14	rxdata_ch0[10]								rxdata_ch0[12]	
FF_RX_D_0_15	rxdata_ch0[11]								rxdata_ch0[13]	
FF_RX_D_0_16	rxdata_ch0[12]								rxdata_ch0[14]	
FF_RX_D_0_17	rxdata_ch0[13]								rxdata_ch0[15]	
FF_RX_D_0_18	rxdata_ch0[14]								rxdata_ch0[16]	
FF_RX_D_0_19	rxdata_ch0[15]						1		rxdata_ch0[17]	
FF_RX_D_0_20	rx_k_ch0[1]						rxc_ch0[1]	NC	rxdata_ch0[18]	

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Data Bus PCS	G8B10B	CPRI	OBSAI	PCI Express	SRIO	Gigabit Ethernet	XAUI	8-Bit SERDES	10-Bit SERDES	SDI
Cell Name ⁺								SERBES		
FF_RX_D_0_21	rx_disp_err_ch0[1]		rxstatus1_ch0[0]	rx_disp_err_ch0[1]			NC	rxdata_ch0[19]		
FF_RX_D_0_22	rx_cv_err_ch0[1] ³		rxstatus1_ch0[1]	rx_cv_err_ch0[1] ³			NC			
FF_RX_D_0_23	NC		rxstatus1_ch0[2]	NC						

Notes:

- 1. The force_disp signal will force the disparity for the associated data word on bits [7:0] to the column selected by the tx_disp_sel signal. If disp_sel is a one, the 10-bit code is taken from the 'current RD+' column (positive disparity). If the tx_disp_sel is a zero, the 10-bit code is taken from the 'current RD-' (negative disparity) column.
- 2. The Lattice Gigabit Ethernet PCS IP core provides an auto-negotiation state machine that generates the signal xmit. It is used to interact with the Gigabit Ethernet Idle State Machine in the hard logic.
- 3. When there is a code violation, the packet PCS 8b10b decoder will replace the output from the decoder with hex EE and K asserted (K=1 and d=EE is not part of the 8b10b coding space).
- 4. FF_TX_D_0_0: FPGA Fabric Transmit Data Bus Channel 0 Bit 0.

5.7. Mode-Specific Control/Status Signal Descriptions

Table 5.3 describes the mode-specific control/status signals.

Signal Name	Description				
Transmit Control Signals					
tx_k_ch[3:0]	Per channel, active-high control character indicator.				
tx_force_disp_ch[3:0]	Per channel, active-high signal which instructs the PCS to accept disparity value from the disp_sel_ch(0-3) FPGA interface input.				
tx_disp_sel_ch[3:0]	Per channel, disparity value supplied from FPGA logic. Valid when force_disp_ch(0-3) is high.				
tx_correct_disp_ch[3:0]	Corrects disparity identifier when asserted by adjusting the 8b10b encoder to begin in the negative disparity state.				
Receive Status Signals					
rx_k_ch[3:0]	Per channel, active-high control character indicator.				
rx_disp_err_ch[3:0]	Per channel, active-high signal driven by the PCS to indicate a disparity error was detected with the associated data.				
rx_cv_err_ch[3:0]	Per channel, code violation signal to indicate an error was detected with the associated data.				

Table 5.3. Control Signals and their Functions

Control

Each mode has its own set of control signals which allows direct control of various PCS features from the FPGA logic. In general, each of these control inputs duplicates the effect of writing to a corresponding control register bit or bits.

{signal}_c is the control signal from the FPGA core to the FPGA bridge. All of the control signals are used asynchronously inside the SERDES/PCS.

Status

Each mode has its own set of status or alarm signals that can be monitored by the FPGA logic. In general, each of these status outputs corresponds to a specific status register bit or bits. The Diamond design tools give the user the option to bring these ports out to the PCS FPGA interface.

{signal}_s is the status the signal to the FPGA core from the FPGA bridge. All of the status signals are asynchronous from the SERDES/PCS. These should be synchronized to a clock domain before they are used in the FPGA design.

Please refer to the Mode-Specific Control/Status Signals section of this document for detailed information about control and status signals.

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5.8. SERDES/PCS

The quad contains four channels with both RX and TX circuits, and an auxiliary channel that contains the TX PLL. The reference clock to the TX PLL can be provided either by the primary differential reference clock pins or by the FPGA core. The quad SERDES/PCS macro performs the serialization and de-serialization function for four lanes of data. In addition, the TxPLL within the SERDES/PCS block provides the system clock for the FPGA logic. The quad also supports both full-data-rate and half-data-rate modes of operation on each TX and RX circuit independently. The block-level diagram is shown in Figure 5.4.



Figure 5.4 SERDES/PCS Block Signal Interface

FPGA-TN-02190-2 9



5.9. I/O Descriptions

Table 5.4 lists all default and optional inputs and outputs to/from a PCS quad. Users can choose optional ports for a PCS quad using the IPexpress[™] GUI.

Table	5.4.	SERDES	PCS I/C) Descri	ptions
	••••	0211020			p

Signal Name	I/O	Туре	Description
Primary I/O, SERDES Quad			
hdinp_ch0	1	Channel	High-speed CML input, positive, channel 0
hdinn_ch0	1	Channel	High-speed CML input, negative, channel 0
hdinp_ch1	1	Channel	High-speed CML input, positive, channel 1
hdinn_ch1	T	Channel	High-speed CML input, negative, channel 1
hdinp_ch2	T	Channel	High-speed CML input, positive, channel 2
hdinn_ch2	I	Channel	High-speed CML input, negative, channel 2
hdinp_ch3	1	Channel	High-speed CML input, positive, channel 3
hdinn_ch3	1	Channel	High-speed CML input, negative, channel 3
hdoutp_ch0	0	Channel	High-speed CML output, positive, channel 0
hdoutn_ch0	0	Channel	High-speed CML output, negative, channel 0
hdoutp_ch1	0	Channel	High-speed CML output, positive, channel 1
hdoutn_ch1	0	Channel	High-speed CML output, negative, channel 1
hdoutp_ch2	0	Channel	High-speed CML output, positive, channel 2
hdoutn_ch2	0	Channel	High-speed CML output, negative, channel 2
hdoutp_ch3	0	Channel	High-speed CML output, positive, channel 3
hdoutn_ch3	0	Channel	High-speed CML output, negative, channel 3
refclkp	I	Quad	Reference Clock input, positive, dedicated CML input
refclkn	I	Quad	Reference Clock input, negative, dedicated CML input
Receive / Transmit Data Bus (See Table 5.	2 and Table	5.3 for Detailed Data Bus Usage)
rxdata_ch0[23:0]	0	Channel	Data signals for the channel 0 receive path
rxdata_ch1[23:0]	0	Channel	Data signals for the channel 1 receive path
rxdata_ch2[23:0]	0	Channel	Data signals for the channel 2 receive path
rxdata_ch3[23:0]	0	Channel	Data signals for the channel 3 receive path
txdata_ch0[23:0]	1	Channel	Data signals for the channel 0 transmit path
txdata_ch1[23:0]	1	Channel	Data signals for the channel 1 transmit path
txdata_ch2[23:0]	1	Channel	Data signals for the channel 2 transmit path
txdata_ch3[23:0]	1	Channel	Data signals for the channel 3 transmit path
Control Signals			
tx_idle_ch[3:0] _c	I	Channel	Controls transmission of electrical idle by SERDES transmitter. 1 = Force SERDES transmitter to output electrical idle 0 = Normal operation
pcie_det_en_ch[3:0]_c	1	Channel	FPGA logic (user logic) informs the SERDES block that it will be requesting for a PCI Express Receiver Detection operation. 1 = Enable PCI Express receiver detect, 0 = Normal operation
pcie_ct_ch[3:0]_c	I	Channel	1 = Request transmitter to do far-end receiver detection 0 = Normal data operation
rx_invert_ch[3:0]_c	1	Channel	Control the inversion of received data. 1 = Invert the data, 0 = Do not invert the data
word_align_en_ch[3:0]_c	1	Channel	Control comma aligner. 1 = Re-acquire COMMA alignment, 0 = Clears internal aligned status Once alignment is found, it is locked at current position until the signal is pulsed to HIGH.
sb_felb_ch[3:0]_c	1	Channel	SERDES Bridge Parallel Loopback 1 = Enable loopback from RX to TX, 0 = Normal data operation

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Signal Name	I/O	Туре	Description
sb_felb_rst_ch[3:0]_c	1	Channel	SERDES Bridge Parallel Loopback FIFO Clear
			1 = Reset Loopback FIFO, 0 = Normal Loopback operation
tx_sync_qd_c	1	Quad	Serializer Reset
			Transition = Reset, Level = Normal Operation
rx_div2_mode_ch[3:0]_c	I	Channel	Receiver Rate Mode Select (Full/Half Rate) 1 = Half Rate, 0 = Full Rate
tx_div2_mode_ch[3:0]_c	1	Channel	Transmitter Rate Mode Select (Full/Half Rate) 1 = Half Rate, 0 = Full Rate
rx_div11_mode_ch[3:0]_c	I	Channel	Receiver Rate Mode Select (Div11/Full Rate) 1 = Div11 Rate, 0 = Full Rate
tx_div11_mode_ch[3:0]_c	I	Channel	Transmitter Rate Mode Select (Div11/Full Rate) 1 = Div11 Rate, 0 = Full Rate
txd_ldr_en_ch{3:0]_c	I	Channel	Low Data Rate TX Serial Path Enable 1 = Enable, 0 = Disable
Reset Signals			
rx_pcs_rst_ch[3:0]_c	I	Channel	Active-high, asynchronous input. Resets individual receive channel logic only in PCS.
tx_pcs_rst_ch[3:0]_c	I	Channel	Active-high, asynchronous input. Resets individual transmit channel logic only in PCS.
rx_serdes_rst_ch[3:0]_c	I	Channel	Active-high. Resets selected digital logic in the SERDES receive channel.
tx_serdes_rst_c	I	Quad	Active-high. Resets selected digital logic in all SERDES transmit channels.
rst_qd_c	I	Quad	Active-high, asynchronous input. Resets all SERDES channels including the auxiliary channel and PCS.
serdes_rst_qd_c	I	Quad	Active-high, asynchronous input to SERDES quad. Resets all SERDES channels including the Quad channel but not PCS logic.
tx_pwrup_ch[3:0]_c	I	Channel	Active-high transmit channel power up. 0 = Transmit channel power- down.
rx_pwrup_ch[3:0]_c	I	Channel	Active-high receive channel power up. 0 = Receive channel power- down.
Status Signals	I		
pcie_done_ch[0:3]_s	0	Channel	1 = Far-end receiver detection complete 0 = Far-end receiver detection incomplete
pcie_con_ch[3:0]_s	0	Channel	Result of far-end receiver detection. 1 = Far-end receiver detected
			0 = Far end receiver not detected.
rx_los_low_ch[3:0]_s	0	Channel	Loss of signal (LO THRESHOLD RANGE) detection for each channel.
lsm_status_ch[3:0]_s	0	Channel	1 = Lane is synchronous to commas 0 = Lane has not found comma
ctc_urrun_ch[3:0]_s	0	Channel	1 = Receive clock compensator FIFO underrun error 0 = No FFIFO errors
ctc_orun_ch[3:0]_s	0	Channel	1 = Receive clock compensator FIFO overrun error 0 = No FIFO errors
rx_cdr_lol_ch[3:0]_s	0	Channel	1 = Receive CDR loss of lock 0 = Lock maintained
tx_pll_lol_qd_s	0	Quad	1 = Transmit PLL loss of lock 0 = Lock maintained
ctc_ins_ch[3:0]_s	0	Channel	1 = SKIP Character Added by CTC
ctc_del_ch[3:0]_s	0	Channel	1 = SKIP Character Deleted by CTC
FPGA Interface Clocks			
rx_full_clk_ch[3:0]	0	Channel	Receive channel recovered clock. In user mode, the source is always the channel's recovered clock. For standards such as 10 GbE that support
			clock compensation, the source is the respective transmit channel's system clock. For PCS bypass modes, it is also the transmit system clock.
			thus requiring raw mode to actually be done using either 8b10b mode with the 8b10b decoder disabled (10-bit or 20-bit data path).
rx_half_clk_ch[3:0]	0	Channel	Receive channel recovered half clock. In 2:1 gearing mode, it is a divide- by-2 output.
tx_full_clk_ch[3:0]	0	Channel	TX PLL full rate clock. Only tx_full_clk_ch0 can drive the primary clock routing directly. All of the tx_full_clk_ch[3:0] signals can drive the secondary clock routing by applying a USE SECONDARY clocking preference ³
			preference.

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Signal Name	I/O	Туре	Description
tx_half_clk_ch[3:0]	0	Channel	TX PLL half clock. Only tx_half_clk_ch0 can drive the primary clock routing directly. All of the tx_half_clk_ch[3:0] signals can drive the secondary clock routing by applying a USE SECONDARY clocking preference. ³
refclk2fpga	0	Quad	Reference clock to FPGA core. If selected, this clock is always active as long as reference clock is active even when the quad is in power down mode.
fpga_rxrefclk_ch[3:0]	1	Quad	RX reference clock from FPGA logic, for CDR PLL
fpga_txrefclk	1	Quad	TX reference clock from FPGA logic, for TX SERDES PLL
ebrd_clk_ch[3:0] ²	T	Channel	Receive channel clock input from FPGA for CTC FIFO read.
rxiclk_ch[3:0]	I	Channel	Receive channel clock input from FPGA. Used to clock the RX FPGA Interface FIFO with a clock synchronous to the reference and/or receive reference clock.
txiclk_ch[3:0]	1	Channel	Transmit channel clock input from FPGA.Per channel transmit clock inputs from FPGA. Used to clock the TX FPGA Interface FIFO with a clock synchronous to the reference clock. Also used to clock the RX FPGA Interface FIFO with a clock synchronous to the reference clock when CTC is used.
Low-Speed Receive/Transmit	Data and SE	RDES Client	Interface Signals
rxd_ldr_ch[3:0]	0	Channel	Single-ended serial low data rate outputs (RX) to FPGA core
txd_ldr_ch[3:0]	1	Channel	Single-ended serial low data rate inputs (TX) from FPGA core
sci_wrdata[7:0]	T	_	Write data input
sci_wrn	T	_	Write input strobe
sci_sel_quad	I	_	Selects quad registers
sci_sel_ch[3:0]	1	_	Selects channel registers
sci_addr[5:0]	1	_	Address bus input
sci_rd	I	_	Read data select
sci_rddata[7:0]	0	_	Read data output
sci_int	0	_	Interrupt output

Notes:

1. During configuration, both hdoutp and hdoutn are pulled high to VCCOB.

2. This clock is not provided in the wrapper module port list. Software automatically assigns the clock depending on the CTC mode. See the FPGA Interface Clocks section of this document for detailed information.

3. General routing is used to access the Secondary Clock Net. The user may get a PAR warning but the delay will be small enough to ignore in most applications. Use the Timing Preferences and review the Trace Report to make sure the timing is not violated.

6. SERDES/PCS Functional Description

LatticeECP3 devices have from one to four quads of embedded SERDES/PCS logic. Each quad, in turn, supports four independent full-duplex data channels. A single channel can support a data link and each quad can support up to four such channels.

The embedded SERDES CDR PLLs and TX PLLs support data rates that cover a wide range of industry standard protocols. Refer to Figure 5.3 for each of the items below.

SERDES

- Equalizer
- CDR (Clock and Data Recovery)
- Deserializer
- PreEmphasis
- Serializer
- Two Serial Loopback modes, TX-to-RX or RX-to-TX
- SERDES Bridge (SB)
 - Inverter Inverts receive data, required by PCI Express

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- SERDES Bridge Parallel Loopback
- PCS Core
 - Word Alignment
 - 8b10b Decoder
 - 8b10b Encoder
 - Link State Machine
 - Clock Tolerance Compensation
- FPGA Bridge (FB)
 - Downsample FIFO
 - Upsample FIFO

7. SERDES

7.1. Equalizer

As the data rate of digital transmission advances over Gbps, frequency-dependent attenuation results in severe intersymbol interference in the received signal and makes it mandatory to use an equalizer in the data transceiver to recover data correctly. Six pole positions are provided: Mid_Low, Mid_Med, Mid_High, Long_Low, Long_Med, Long_High frequency ranges.

A default selection of the pole position is included when a protocol standard is selected. This selection is based on most commonly used condition on user's system board. However, user may wish to optimize the signal by adjusting this setting. User has to perform bit-error-rate tests on all different pole settings to determine the optimal one.

7.2. Pre-Emphasis

Pre-emphasis refers to a system process designed to increase the magnitude of some frequencies with respect to the magnitude of other frequencies. The goal is to improve the overall signal-to-noise ratio by minimizing the adverse effects of such phenomena as attenuation differences. Users can select up to 80% of pre-emphasis.

By default, pre-emphasis is not enabled. User can determine if the Tx drive signal has to route a long distance to the Rx side. If the routing trance length is long, he can try out different pre-emphasis settings to determine the best signal eye at the Rx-end of the trace.

7.3. Reference Clocks

The SERDES quad contains four channels with both RX and TX circuits, and an auxiliary channel that contains the TX PLL. The reference clock to the TX PLL can be provided either by the primary differential reference clock pins, by the neighbor quad's reference clock or by the FPGA core. In addition, the PLL within the SERDES block provides an output clock that can be used as the system clock driving the FPGA fabric.

The reference clock to the RX can be provided either by the reference clock to the TX PLL or by the FPGA core. The reference clocks from the FPGA core to the TX PLL and to the RX may come from different sources.

7.4. SERDES Clock Architecture

Figure 7.1 shows the overall SERDES clock architecture. The diagram is split into two halves, Quad and Channel. Only one per-channel section is shown for the sake of brevity. Also, the various control bits for the different blocks are shown. These could be quad-based control register bits or channel-based control register bits. In some cases, it can be channel control port based. Some are a combination of both register and control ports. Using both modes enables dynamic control of certain functional properties.





1. All control bits are quad based.

All control bits are channel based, except as indicated (*)
 These clocks are user-transparent.

Figure 7.1 SERDES Clock Architecture

The main components of the clock architecture include:

- Per RX and per TX Divider (DIV) modes DIV2, DIV11
- Multi-quad REFCLK connections
- Multiple channel transmit synchronization using the tx_sync_qd_c signal from the FPGA
- OOB low data rate application support

7.5. Rate Modes

The TX in each channel can be independently programmed to run at one of the following rates:

- FULL_RATE
- HALF_RATE (DIV2)
- DIV11

The RX can also use a separate reference clock per channel, allowing the transmitter and receiver to run at completely different rates.

It is important to note that the PLL VCO is left untouched, supporting the highest rate for that protocol. All divided rates required by that protocol are supported by programming the divider mux selects. This enables very quick data rate changeover since the PLL does not need to be reprogrammed. This is valuable in many applications.

Note: The LatticeECP3 PCS cannot handle a change in rates at runtime. Simply changing the refclk rate will not allow the SERDES to work at a new range. The SERDES settings must be re-configured, either with a new bitstream, or changed via the SERDES' SCI interface. The SERDES link must be reset after the settings are changed.

The TX PLL and the four CDR PLLs generally run at the same frequency, which is a multiple of the reference clock frequency. Table 7.1 illustrates the various clock rate modes possible. The bit clock indicated is a multiple of the reference clock frequency.



Table 7.1.	TXPLL and RX	CDRPLL Supported Modes
------------	--------------	-------------------------------

Reference Clock Mode	refclkPmode (Quad)	Bus_width	Bit Clock (Full Rate)	Bit Clock (div2, div11)
20x	0	10	Refclk x 20	Refclk x 10
16x	0	8	Refclk x 16	Refclk x 8
10x	1	10	Refclk x 10	Refclk x 5
8x	1	8	Refclk x 8	Refclk x 4
25x	—	8	Refclk x 25	Refclk x 12.5
25x	_	10	Refclk x 25	Refclk x 12.5

Note:

1. DIV11 mode.

7.6. Reference Clock from an FPGA Core

As described in Figure 7.1, the TX reference clock can be brought from the FPGA core. In this case, the extra jitter caused by the FPGA resources to route the clock to the SERDES will be passed onto the transmit data and may violate TX jitter specifications on a case-by-case basis. Caution should be used when using an FPGA-originated SERDES TX reference clock.



Figure 7.2 Reference Clock Block Diagram



7.7. Full Data, Div 2 and Div 11 Data Rates

Each TX Serializer and RX Deserializer can be split into full data rate and div2 rate or div11 rate depending on the protocol, allowing for different data rates in each direction and in each channel. Refer to Figure 7.2 for further information.

	PCS	1	Quad 1 Reference Clocks	SerDes Ad	vanced	PCS Adv	anced1	PCS A	dvance	d2 \ Optic	nal Port
1	Nazarit		Clocking Setup								
	refolkp	hdoutn ch0	Data Rate 1 0	ibps							
	hdino ch0	rx_full_clk_ch0	Transmit								
-+	hdinn_ch0	rx_half_clk_ch0	Ty Balck Source	EXTERN		Tu/Rul	1. Dinin	100	-		
-	biclk_ch0	tx half ck ch0	TATIGACIÓ DOUCO	- Level -	-	1 100100	Tumpac	i lina	- Marine		
-	[7:0] txdata_ch0	[7:0] rxdata_ch0	Tx Reference Clock B	ate 100	MHz	102210		1522523		0.00	
-	tx_k_ch0	rx_k_ch0		Ch0		Ch1		Ch2		Ch3	
-	tx_force_disp_ch0	rx_cv_err_ch0	Protocol	FIXTX		BXTX		FIXTX		RXIX	
	tx_disp_sel_cnu	rx_los_low_ch0_s	Tx Rate	FULL	-	DIV_2	-	FULL	-	DIV_2	-
	rx serdes ist ch0 c	rx_los_high_ch0_s	FPGA Bus Width	8	-	8	-	16	-	16	-
-+	bc_pcs_rst_ch0_c	ctc urun ch0 s	FPGA Interface Clock	100	MHz	100	MH	2 50	MH	12 50	MHz
-	tx_pwrup_ch0_c	ctc_orun_ch0_s		1.000		1				-1	
-+	rx_pcs_rst_ch0_c	ctc_ins_ch0_s	Receive								
-	rx_pwrup_ch0_c	tx cdt lol ch0 s		Ch0		Ch1	_	Ch2		Ch3	
	hanp_ch1	hdoutp_ch1	Protocol	EDCEX		FIXEX		RMTX		RIXER	
	bick ch1	hdoutn_ch1	Reference Clock Sou	ICE EXTER	NAL -	EXTERN	AL V	EXTERN	IAL -	EXTERN	AL V
-	[7:0] txdata_ch1	rx_halt_clk_ch1	Multiplier	104	-	10%	-	10%	-	105	-
	br_k_ch1	tx_ful_ck_ch1	P. Pata	E III		DBC 2		ELU I	- 1	DB/ 2	
-	tx_force_disp_ch1	tx_hat_ck_ch1	nx nate	FULL		1014_2	-	FULL	-	1014_2	
-	tx_disp_set_ch1	nx_k_ch1	Rx Reference Clock	Rate 100	MHz	100	MHz	100	MHz	100	MHz
	rx_serdes_rst_ch1_c	rx_disp_err_ch1	FPGA Bus Width	8	-	8	-	16	-	16	-
	tx pcs_rst_ch1_c	rx los low ch1 s	EPGA Interface Clock	100	- MH-	100	MU	En.	- MU-	En.	MH
	tx_pwrup_ch1_c	rx_los_high_ch1_s	FF GA Intellace Gloca	11005	mm	1100	mm2	100	menz	1-m	minz
-+	rx_pcs_rst_ch1_c	lsm_status_ch1_s									
	we were also a	cic unun chi si 🕨									

As shown in Figure 7.3, all four channels can be configured differently.

Figure 7.3 Example of Full Data Rate and Half Data Rate in the IPexpress GUI

The actual data rate and FPGA interface clock rate for this example are described in Table 7.2. The IPexpress GUI will be discussed in detail later in this document.

Channel	Data Rate	Reference Clock Multiplier	Data Rate Mode	Calculated Reference Clock Rate	FPGA Interface Data Bus Width	FPGA Interface Clock Rate	tx_full_clk	tx_half_clk
Channel 0	1 Gbps	10 x	FULL	100 MHz	8 (10) ³	100 MHz	100 MHz	50 MHz
Channel 1	500 Mbps	10 x	DIV2	100 MHz	8 (10)	50 MHz	50 MHz	25 MHz
Channel 2	1 Gbps	10 x	FULL	100 MHz	16 (20)	50 MHz	100 MHz	50 MHz
Channel 3	500 Mbps	10 x	DIV2 ²	100 MHz	16 (20)	25 MHz	50 MHz	25 MHz

Table 7.2. TXPLL and RX CDRPLL Supported Modes

Notes:

1. The clocks in the shaded cells are used as the FPGA interface clocks in each mode.

- 2. In DIV2 mode, the tx_full_clk is adjusted to half rate. tx_half_clk is used for the 16-bit bus interface only.
- 3. 10-bit SERDES only mode or SDI mode.

7.8. Dynamic Switching Between Full Rate and Half Rate (DIV2)

This section describes how to switch between Full Rate and Half Rate (DIV) dynamically.

The two rate mode control signals are or'ed as shown in Figure 7.4.





Figure 7.4 Rate Mode Control Signals

tx_div2_mode_chx_c is an input control signal to the TX path from the FPGA fabric. rx_div2_mode_chx_c is an input control signal to the RX path from the FPGA fabric. Rate_Mode_Tx(CH_14[1]) is the Control Register bit for the TX path. Rate_Mode_Rx(CH_15[1]) is the Control Register bit for the RX path. In the rx lane, the pcs_rst should be applied after switching. In the tx lane, no reset is required for the new rate to take place.

7.9. Reference Clock Sources

refclkp, refclkn

Dedicated CML input. This is the first choice unless different clock sources for RX and TX are used. The clock signal may be CML, LVDS or LVPECL. Refer to Electrical Recommendations for Lattice SERDES (FPGA-TN-02077), for example interface circuits.

fpga_txrefclk, fpga_rxrefclk

Reference clock from FPGA logic. The Primary Clock pad (PCLK) should be used as the clock input pin to the FPGA. The clock signal may be CML, LVDS, LVPECL or single-ended.

FPGA PLL

When an FPGA PLL is used as the reference clock, the reference clock to the PLL should be assigned to a dedicated PLL input pad. The FPGA PLL output jitter may not meet system specifications at higher data rates. Use of an FPGA PLL is not recommended in jitter-sensitive applications.

7.10. Spread Spectrum Clocking (SSC) Support

The ports on the two ends of Link must transmit data at a rate that is within 600 pm of each other at all times. This is specified to allow bit-rate clock source with a +/- 300 ppm tolerance. The minimum clock period cannot be violated. The preferred method is to adjust the spread technique to not allow for modulation above the nominal frequency. The data rate can be modulated from +0% to -0.5% of the nominal data rate frequency, at a modulation rate in the range not exceeding 30 KHz to 33 KHz. Along with the +/- 300 ppm tolerance limit, both ports require the same bit rate clock when the data is modulated with an SSC.

In PCI Express applications, the root complex is responsible for spreading the reference clock. The endpoint will use the same clock to pass back the spectrum through the TX. Thus, there is no need for a separate RXREFCLK. The predominant application is an add-in card. Add-in cards are not required to use the REFCLK from the connector but must receive and transmit with the same SSC as the PCI Express connector REFCLK.

While the LatticeECP3 architecture will allow the mixing of a PCI Express channel and a Gigabit Ethernet, Serial RapidIO or SGMII channel within the same quad, using a PCI Express SSC as the transmit reference clock will cause a violation of the Gigabit Ethernet, Serial RapidIO and SGMII transmit jitter specifications.

7.11. Loss of Signal

Each channel contains a programmable loss-of-signal detector as shown in Figure 7.5.



The loss-of-signal threshold depends on the value of the programmable current source. The current source value is chosen using the rlos_lset[2:0] control bit. The result of threshold detection is indicated to the FPGA through the rx_los_low status signal.



Note: rx_los_low shows that a signal has been detected for data rates above 1 Gbps with a maximum CID (Consecutive Identical Digits) of 7 bits (i.e., a minimum input signal transition density as is sent by 8b10b).

rx_los_low is supported with a default setting of rlos_lset[2:0] = 2, except in PCI Express mode and SDI mode. In PCI Express mode, 2 and 3 are supported.

In SDI mode, it is recommended to use the carrier detect output signal (/CD) from the external SDI cable equalizer.

Figure 7.5 Loss of Signal Detector

Table 7.3. Response Time for Loss of Signal Detector

Description	Min.	Тур.	Max.	Units
Time to detect that signal is lost (rx_los_low 0 to 1)	—	8	10	ns
Time to detect that signal is present (rx_los_low 1 to 0)	_	8	10	ns

7.12. Loss Of Lock

Both the transmit PLL and the individual channel CDRs have digital counter-based, loss-of-lock detectors. If the transmit PLL loses lock, the loss-of-lock for the PLL is asserted and remains asserted until the PLL reacquires lock. If a CDR loses lock, the loss-of-lock for that channel is asserted and locking to the reference clock retrains the VCO in the CDR. When this is achieved, loss-of-lock for that channel is de-asserted and the CDR is switched back over to lock to the incoming data. The CDR will either remain locked to the data, or will go back out of lock again in which case the re-training cycle will repeat. For detailed information on CDR loss-of-lock, refer to the SERDES/PCS RESET section of this document.

Table 7.4. Respor	nse Time for Loss	-of-Lock Detector
-------------------	-------------------	-------------------

Description	Min.	Тур.	Max.	Units
Time to detect that loop is unlocked (tx_pll_lol, rx_cdr_lol, 0 to 1)	—	200	500	us
Time to detect that loop is locked (tx_pll_lol, rx_cdr_lol, 1 to 0)	-	200	500	us

7.13. TX Lane-to-Lane Skew

A control signal, tx_sync_qd_c, resets all of the active TX channels to start serialization with bit 0. Most multi-channel protocol standards have requirements to ensure that the TX lane-to-lane skew is within a certain specification.

The reset to the TX serializers is generated either by toggling the tx_sync_qd_c signal or by a transition in PLL loss of lock.



7.14. SERDES PCS Configuration Setup

The LatticeECP3 PCS can be configured for use in various applications. Setup is chosen with the IPexpress module generation tool which allows the user to select the mode and feature options for the PCS. Option selections are saved in an auto-configuration file which is subsequently used by the Bitstream Generator to write the user selections into the bitstream. To change PCS option selections it is recommended that the user rerun IPexpress to regenerate a PCS module and create a new auto-configuration file. Some options can be changed by manually editing the auto-configuration file before running the Bitstream Generator. After configuration, PCS options can be changed dynamically by writing to PCS registers via the optional SERDES Client Interface bus. The SERDES Client Interface allows the SERDES/PCS quad to be controlled by registers as opposed to configuration memory cells. A table of control and status registers accessible through the SCI is provided in Appendix A.

7.15. Auto-Configuration File

Initial register setup for each PCS mode can be performed by using the auto-configuration feature in IPexpress. The module generator provides an auto-configuration file which contains the quad and channel register settings for the chosen mode. This file can be referred to for front-end simulation and also can be integrated into the bitstream. When an auto-configuration file is integrated into the bitstream all the quad and channel registers will be set to values defined in the auto-configuration file during configuration. The SCI must be included in a design if the user needs to change control registers or monitor status registers during operation.

7.16. Transmit Data

The PCS quad transmit data path consists of an 8b10b encoder and serializer per channel.

8b10b Encoder

This module implements an 8b10b encoder as described within the IEEE 802.3ae-2002 1000BASE-X specification. The encoder performs the 8-bit to 10-bit code conversion as described in the specification, along with maintaining the running disparity rules as specified. The 8b10b encoder can be bypassed on a per-channel basis by setting the attribute CHx_8B10B to "BYPASS" where x is the channel number.

Serializer

The 8b10b encoded data undergoes parallel-to-serial conversion and is transmitted off-chip via the embedded SERDES.

7.17. Receive Data

The PCS quad receive data path consists of the following sub-blocks per channel: Deserializer, Word Aligner, 8b10b Decoder, Optional Link State Machine, and Optional Receive Clock Tolerance Compensation (CTC) FIFO.

Deserializer

Data is brought on-chip to the embedded SERDES where it goes from serial to parallel.

Word Alignment (Byte Boundary Detect)

This module performs the comma codeword detection and alignment operation. The comma character is used by the receive logic to perform 10-bit word alignment upon the incoming data stream. The comma description can be found in section 36.2.4.9 of the 802.3.2002 1000BASE-X specification as well as section 48.2.6.3, Figure 7.7 of the 10GBASE-X specification.

A number of programmable options are supported within the word alignment module:

- Word alignment control from either embedded Link State Machine (LSM) or from FPGA control. Supported in 8- bit SERDES Only, 10-bit SERDES Only and SDI modes, in addition to 8b10b packet mode.
- Ability to set two programmable word alignment characters (typically one for positive and one for negative disparity) and a programmable per bit mask register for alignment comparison. Alignment characters and the mask register is set on a per quad basis. For many protocols, the word alignment characters can be set to "XX00000011" (jhgfiedcba bits for positive running disparity comma character matching code groups K28.1, K28.5, and K28.7) and



"XX01111100" (jhgfiedcba bits for negative running disparity comma character matching code groups K28.1, K28.5, and K28.7). However, the user can define any 10-bit pattern.

- The first alignment character is defined by the 10-bit value assigned to attribute COMMA_A. This value applies to all channels in a PCS quad.
- The second alignment character is defined by the 10-bit value assigned to attribute COMMA_B. This value applies to all channels in a PCS quad.
- The mask register defines which word alignment bits to compare (a '1' in a bit of the mask register means check the corresponding bit in the word alignment character register). The mask registers defined by the 10-bit value assigned to attribute COMMA_M. This value applies to all channels in a PCS quad. When the attribute CHx_RXWA (word alignment) is set to "ENABLED" and CHx_ILSM (Internal Link State Machine) is set to "ENABLED", one of the protocol-based Link State Machines, see the Protocol-Specific Link State Machine section below.

7.18. 8b10b Decoder

The 8b10b decoder implements an 8b10b decoder operation as described with the IEEE 802.3-2002 specification. The decoder performs the 10-bit to 8-bit code conversion along with verifying the running disparity. When a code violation is detected, the receive data, rxdata, is set to 0xEE with rx_k _chn set to '1'.

7.19. External Link State Machine Option

When the attribute CHx_ILSM (Internal Link State Machine) is set to DISABLED, and CHx_RXWA (word alignment) is set to ENABLED, the control signal word_align_en_ch(0-3)_c is used to enable the word aligner. This signal should be sourced from a FPGA external Link State Machine implemented in the FPGA fabric.

When the CHx_RXWA is set to ENABLED, the word_align_enable CH_01[7] shown in Figure 7.6 is set to HIGH, enabling the word_align_en_ch(0-3)_c signal to be controlled by FPGA fabric. When the signal word_align_en_ch(0-3)_c is HIGH, the Word Aligner looks for incoming data for either COMMA_A or COMMA_B for alignment. Once it is aligned, it stays locked and aligned, and stops comparing incoming data.

If re-alignment is required, the word_align_en_ch(0-3)_c should be pulsed from HIGH to LOW, then to HIGH. Driving the signal to LOW clears up the Word Aligner internal status to unlock. Alignment does not start until the word_align_en_ch(0-3)_c signal is driven back to HIGH. When it is driven to HIGH, it constantly compares the incoming data to either COMMA_A or COMMA_B for alignment. When alignment is found, it stays locked and aligned, and stops comparing data.

After each alignment or re-alignment, the Word Aligner keeps aligning to that state, until the signal word_algin_en_ch(0-3)_c is pulsing to HIGH and either COMMA_A or COMMA_B character is found. Before that, when the signal is LOW, or pulsed to HIGH but before the comma character is detected, the Word Aligner would still keep aligning to the current state.

External Link State Machine allows the user to perform re-alignment with a change in word alignment under specific conditions, and also allows the user to perform re-alignment if the External Link State Machine finds some issue with the link.

Figure 7.6 illustrates the Link State Machine options.

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Figure 7.6 PCS Word Aligner and Link State Machine Options

When a Link State Machine is selected and enabled for a particular channel, that channel's lsm_status_ch(0-3)_s status signal will go high upon successful link synchronization.

Note that the lsm_status_ch(0:3)_s status signal may have glitches. User should add deglitch logic on this output to ensure stable signal transition.

Idle Insert for Gigabit Ethernet Mode

The PCS set to Gigabit Ethernet Mode provides for insertion of /l2/ symbols into the receive data stream for autonegotiation. Gigabit Ethernet auto-negotiation is performed in soft logic. This function inserts a sequence of 8 /l2/ ordered sets every 2048 clock cycles. /l2/ insertion is controlled by the xmit_ch(0-3) input to the PCS which is driven from the autonegotiation soft logic. Figure 7.7 shows one channel (channel 0 in this example) of receive logic when the PCS is set to Gigabit Ethernet Mode showing these control/status signals.



Figure 7.7 PCS PCS Receive Path for Gigabit Ethernet Mode (Channel 0 Example)

7.20. Clock Tolerance Compensation

The Clock Tolerance Compensation (CTC) module performs clock rate adjustment between the recovered receive clocks and the locked reference clock. Clock compensation is performed by inserting or deleting bytes at pre- defined positions, without causing loss of packet data. A 16-byte CTC FIFO is used to transfer data between the two clock domains and will accommodate clock differences of up to the specified ppm tolerance for the LatticeECP3 SERDES (see DC and Switching Characteristics section of the LatticeECP3 Family Data Sheet).



A channel has the Clock Tolerance Compensation block enable when that channel's attribute CHx_CTC is set to "ENABLED". The CTC is bypassed when that channel's attribute CHx_CTC is set to "DISABLED".

A diagram illustrating 1-byte deletion is shown in Figure 7.8.



Figure 7.8 Clock Tolerance Compensation 1-Byte Deletion Example

A diagram illustrating 1-byte insertion is shown in Figure 7.9.





A diagram illustrating 2-byte deletion is shown in Figure 7.10.



A diagram illustrating 2-byte insertion is shown in Figure 7.11.





Figure 7.11 Clock Tolerance Compensation 2-Byte Insertion Example

A diagram illustrating 4-byte deletion is shown in Figure 7.12.



Figure 7.12 Clock Tolerance Compensation 4-Byte Deletion Example

A diagram illustrating 4-byte insertion is shown in Figure 7.13.



Figure 7.13 Clock Tolerance Compensation 4-Byte Insertion Example

When the CTC is used, the following settings for clock compensation must be set, as appropriate, for the intended application:

• Set the insertion/deletion pattern length using the CC_MATCH_MODE attribute. This sets the number of skip bytes the CTC compares to before performing an insertion or deletion. Values for CC_MATCH_MODE are "1" (1-byte insertion/deletion), "2" (2-byte insertion/deletion), and "4" (4-byte insertion/deletion). The minimum interpacket gap must also be set as appropriate for the targeted application. The interpacket gap is set by assigning values to attribute CC_MIN_IPG. Allowed values for CC_MIN_IPG are "0", "1", "2", and "3". The minimum allowed

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interpacket gap after skip character deletion is performed based on these attribute settings is described in Table 7.5.

• The skip byte or ordered set must be set corresponding to the CC_MATCH_MODE chosen. For 4-byte insertion/deletion (CC_MATCH_MODE = "4"), the first byte must be assigned to attribute CC_MATCH1, the second byte must be assigned to attribute CC_MATCH2, the third byte must be assigned to attribute CC_MATCH3, and the fourth byte must be assigned to attribute CC_MATCH4. Values assigned are 10-bit binary values.

For example:

If a 4-byte skip ordered set is /K28.5/D21.4/D21.5/D21.5, then "CC_MATCH1" should be "0110111100", "CC_MATCH2" = "0010010101", "CC_MATCH3" = "0010110101" and "CC_MATCH4" = "0010110101".

For a 2-byte insertion/deletion (CC_MATCH_MODE = "2"), the first byte must be assigned to attribute CC_MATCH3, and the second byte must be assigned to attribute CC_MATCH4.

For a 1-byte insertion/deletion (CC_MATCH_MODE = "1"), the skip byte must be assigned to attribute CC_MATCH4.

- The clock compensation FIFO high water and low water marks must be set to appropriate values for the targeted protocol. Values can range from 0 to 15 and the high water mark must be set to a higher value than the low water mark (they should not be set to equal values). The high water mark is set by assigning a value to attribute CCHMARK. Allowed values for CCHMARK are hex values ranging from "0" to "F". The low water mark is set by assigning a value to culto assigning a value to attribute CCLMARK. Allowed values for CCLMARK. Allowed values for CCLMARK are hex values for CCLMARK are hex values ranging from "0" to "F".
- Clock compensation FIFO overrun can be monitored on a per-channel basis on the PCS/FPGA interface port labeled cc_overrun_ch(0-3) if "Error Status Ports" is selected when generating the PCS block with the module generator.
- Clock compensation FIFO underrun can be monitored on a per-channel basis on the PCS/FPGA interface port labeled cc_underrun_ch(0-3) if "Error Status Ports" is selected when generating the PCS block with the module generator.

7.21. Calculating Minimum Interpacket Gap

Table 7.5 shows the relationship between the user-defined values for interpacket gap (defined by the CC_MIN_IPG attribute), and the guaranteed minimum number of bytes between packets after a skip character deletion from the PCS. The table shows the interpacket gap as a multiplier number. The minimum number of bytes between packets is equal to the number of bytes per insertion/deletion times the multiplier number shown in the table. For example, if the number of bytes per insertion/deletion is 4 (CC_MATCH_MODE is set to "4"), and the minimum interpacket gap attribute CC_MIN_IPG is set to "2", then the minimum interpacket gap is equal to 4 (CC_MATCH_MODE = "4") times 3 (Table 7.5 with CC_MIN_IPG = "2") or 12 bytes. The PCS will not perform a skip character deletion until the minimum number of interpacket bytes have passed through the CTC.

Table	7.5.	Minimum	Inter	nacket	Gan	Multi	olier
Table	/	Willing	inter	μαικει	Jap	IVIUIU	pilei

CC_MIN_IPG	Insert/Deletion Multiplier Factor
0	1x
1	2x
2	3x
3	4x

Note on CTC support in the LatticeECP3-150EA device family with TW suffix: For the initial release of LatticeECP3-150EA device with TW suffix, the CTC in the PCS is not supported. The CTC feature can be bypassed and implemented in soft IP. Many IP cores from Lattice implement the CTC logic in soft form.

Using IPexpress with Diamond

IPexpress is used to create and configure SERDES and PCS blocks. Designers use the GUI to select the SERDES Protocol Standard for a particular quad or channel. IPexpress takes the input from this GUI and generates a configuration file (.txt file) and HDL netlist. The HDL model is used in the simulation and synthesis flow. The configuration file contains attribute-level map information. This file is input for simulation and the bitgen program. It is strongly recommended that designers make changes and updates in IPexpress and then regenerate the configuration file. In some exceptional situations, users can modify the configuration file.



Figure 7.14 shows the tools flow when using IPexpress to generate the SERDES/PCS block for the SERDES Protocol Standard.



Figure 7.14 SERDES_PCS Diamond User Flow

7.22. PCS Module Generation in IPexpress

Figure 7.15 shows the main window when PCS is selected in the IPexpress GUI.



🕈 IPexpress							_ 🗆 🛛
File Tools Help							
🗠 🖻 🐁 🐂 🔗							
Name Module Architecture_Modules IO DLL DUL DUL DBCAstra	Version 3.5 1.0 1.0	To generat enabled fields on the Custon customization	e the module or IF (such as Project nize button. A dialo of the selected mo	, enter the inform Path, File Name, e og will open to allo odule or IP.	ation in the etc.) and click w	k	
전 PCS - 전화 PLL - 교환 System_Bus	8.1 5.1 4.0	Macro Type:	Module	Version:	8.1		
Tag Memory Arithmetic_Modules DSP_Modules Memory Modules	2.0	Module Name:	PCS				
∎ iP		Project Path:	s demo files\copy o	f ecp3 150ea demo vrik	og 8112 ok		
		File Name:	Schematic Merilon k	IDI.			
		Device Family:	LatticeECP3				
		Part Name:	LFE3-150EA-6FN11	56CES			
				[Customize	isp	Lever-
🗐 Local 🎯 IP Server		Configuration	About				

Figure 7.15 IPexpress PCS Main Window

Quad Setup Tab

Figure 7.16 shows the Quad Setup Tab window when the file name is entered and the **Customize** button is checked in the main window. The first entry required in this window is to select a Protocol Mode for each channel. Each channel can be configured as 'RX and TX', 'RX Only', 'TX Only', 'Disabled' or 'Low Speed Data Port'.



PCS		Quad	Reference Clocks	Ser)es Advan	ced \ PC	S Advance	edt \ P	CS Advanced2	Control Setu	p \ Generation Op
refclkp refclkn refclkn refclkn hdinp_ch0 sci_sel_ch0 sci_sel_ch0 roick_ch0 tick_ch0 [1:0] tv_k_ch0 [1:0] tv_k_ch0 [1:0] tv_k_ch0 [1:0] tv_k_ch0 [1:0] tv_kcek0 [1:0] tv_kcek0	hdoutp_ch0 → hdoutp_ch0 → nc_full_cik_ch0 → nc_hall_cik_ch0 → tx_full_cik_ch0 → tx_full_cik_ch0 → [1:0] nx_dsta_ch0 → [1:0] nx_cten0 → [1:0] nx_cer_ench0 → nc_los_low_ch0_s →		nel Protocol Chan Chan Chan	F inel0 inel1 inel2 inel3	K and TX ← ← ←	RX Only C C C	TX Only (Disable Channel C	Protocol (688108 (688108 (688108 (688108	Low Spec Data Por	ed te
tx_div2_mode_ch0_c	Ism_status_ch0_s	¥.									
Import LPC to isol EVER	project					Gener	rate	1	Close		Help

Figure 7.16 Configuration GUI - Quad Setup Tab

Table 7.6. SERDES	PCS GUI Attributes	- Quad Tab	Setup

GUI Text	Attribute Name	Range	Default Value
Channel Protocol	CHx_MODE	RX and TX, RX Only, TX Only	DISABLED
Disable Channel ¹	CHx_MODE	ENABLE, DISABLE	DISABLED
Protocol	CHx_PROTOCOL	GIGE, SGMII, XAUI, SRIO, PCIE, SDI, G8B10B, 10BSER, 8BSER, CPRI, OBSAI	G8B10B
Low Speed Data Port	CHx_LDR	RX and TX, RX Only, TX Only	DISABLED

Note:

1. For the LatticeECP3-17EA device in the 328-ball csBGA package, only channels 0 and 3 are available.

Reference Clock Setup Tab

In this tab, the attributes of the TX and RX reference clock sources are selected. Users can select either a EXTERNAL or INTERNAL reference clock. Further, there is a tool to provide the required clock rate and multiplier settings for a particular data rate. In addition, for a given data bus width the tool provides the required clock rate to interface the channel to the core.



	PCS	5	60	Quad Refe	rence Clocks \ SerDes Ac	dvanced \	PCS A	dvanced1	PCS.	Advanced	12 \ Con	trol Setup	Generation Opti
+ + + + + + + +	retclkp retclkn hdinp_ch0 hdinn_ch0 sci_sel_ch0 niclk_ch0 biclk_ch0 [15:0] txdsta_ch0	hdoutp_ch0 hdoutn_ch0 rx_full_clk_ch0 rx_hall_clk_ch0 tx_full_clk_ch0 tx_full_clk_ch0		Clocking S	etup Max Data Rate Tx Refolk Source Tx Reference Clock Rate Protocol Tx Rate FPGA Bus Width FPGA Interface Clock	3.125 EXTERN 156.25 Ch0 FULL 16 156.25	Gbps AL MHz MHz	Ch1 G8810E DIV2 8 156.25	Multiplier	20X Ch2 DISABL FULL 8 2312.5	ED MH2	Ch3 DISABLE FULL 8 3125	D MHz
† † † † † † † †	[1:0] bc_k_ch0 [1:0] bc_force_disp_ch0 [1:0] bc_disp_sel_ch0 nc_serdes_nt_ch0_c bc_pcs_nt_ch0_c bc_pwup_ch0_c nc_pcs_nt_ch0_c nc_pwup_ch0_c bc_dv2_mode_ch0_c	(1:0) rx_k_ch0 [1:0) rx_k_ch0 [1:0] rx_cv_er_ch0 [1:0] rx_cv_er_ch0 rx_los_low_ch0_s Ism_status_ch0_s		Receive	Max Data Rate Protocol Reference Clock Source Multiplier Rx Rate Rx Reference Clock Rate FPGA Bus Width	Ch0 3.125 G68108 EXTERN 20X FULL 156.25 16	Gbps	Ch1 3.125 G88108 EXTERN 20X DIV2 156.25 8	Gbps AL	Ch2 3.125 DISABLE EXTERN 20X FULL 156.25 8	Gbps IAL V MHz	Ch3 3 125 DISABLE EXTERN 20X FULL 155.25 8	Gbps Gbps MHz
	rx div2 mode ch0 c		×		FPGA Interface Clock	156.25	MHz	156.25	MHz	312.5	MHz	312.5	MHz

Figure 7.17 Configuration GUI - Reference Clocks Setup Tab

Table 7.7. SERDE	S_PCS GUI Attributes - Reference C	Clocks Setup Tab
------------------	------------------------------------	------------------

GUI Text	Attribute Name	Range	Default Value (GUI)	Default Value (Attribute)
Transmit	·			
Max. Data Rate ¹	N/A	0.23 to 3.2 Gbps	2.5 Gbps	N/A
TX Refclk Source	PLL_SRC	INTERNAL, EXTERNAL	INTERNAL	REFCLK_INT
TX/RX Multiplier	REFCK_MULT	8X, 10X, 16X, 20X, 25X	Protocol Dependent	
TX Reference clock Rate	#REFCLK_RATE ²		Protocol Dependent	
Protocol	No user access. For inform	ation only.		
TX Rate	CHx_TX_DATA_RATE	FULL, DIV2, DIV11	FULL	FULL
FPGA Bus Width	CHs_TX_DATA_WIDTH	8, 10, 16, 20	Protocol Dependent	
FPGA Interface Clock	#CH0_TX_FICLK_RATE			
Receive				
Max. Data Rate ¹	N/A	0.23 to 3.2 Gbps	2.5 Gbps	N/A
Protocol	No user access. For inform	ation only.		
Refclk Source	CHx_CDR_SRC	INTERNAL, EXTERNAL	INTERNAL	REFCLK_INT
Multiplier	No user access. For inform	ation only		
RX Rate	CHx_RX_DATA_RATE	FULL, DIV2, DIV11	FULL	FULL
RX Reference Clock Rate	#CH0_RXREFCLK_RATE			
FPGA Bus Width	CHx_RX_DATA_WIDTH	8, 10, 16, 20	Protocol Dependent	
FPGA Interface Clock	#CH0_RX_FICLK_RATE			

Notes:

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- 1. Rate is not reflected in the autoconfig file. Instead, DATARATE RANGE is specified for a given data rate as: 150 Mbps ≤ LOWLOW ≤ 230 Mbps, 230 Mbps < LOW ≤ 450 Mbps, 450 Mbps < MEDLOW ≤ 0.9 Gbps, 0.9 Gbps < MED ≤ 1.8 Gbps, 1.8 Gbps < MEDHIGH ≤ 2.55 Gbps, 2.55 Gbps < HIGH ≤ 3.2Gbps.
- 2. Attributes preceded by '#' represent attributes that are for user information only. These attributes are also included in the autoconfig file for reference.

SERDES Advance Setup

This tab is used to access the advanced attributes of the transmit and receive SERDES for all four channels. Transmit attributes such as PreEmphasis, Termination, Differential Output Voltage selection are selected. Receive attributes such as Equalization, Termination, I/O Coupling are selected. Attributes for Transmit SERDES Clock and PLL are also selected.

	PCS	5		Quad \ Reference Clocks \ SerDes Adv	vanced \ PC	S Adv	anced1 \ PC	S Ad	Ivanced2 \	Contro	ISetup ∫ Ge	neration Opti
+ + + +	refclkp refclkn hdinp_ch0 hdinn_ch0	hdoutp_ch0 → hdoutn_ch0 → nx_full_clk_ch0 →		Transmit Settings Differential Output Voltage PreEmphasis TX 1/0 Termination (Ohms)	Ch0 0 DISABLED		Ch1 0 <u></u> DISABLED 50 		Ch2 0 j DISABLED		Ch3 0 DISABLED	1 1
† † † † † † † †	sci_sel_ch0 nsidk_ch0 bsidk_ch0 [15:0] txdsta_ch0 [1:0] tx_k_ch0 [1:0] tx_force_disp_ch0 [1:0] tx_disp_sel_ch0 n<_serdes_rst_ch0_c tx_pcs_rst_ch0_c	rs_hall_clk_ch0 → bc_full_clk_ch0 → bc_hall_clk_ch0 → [15:0] rxdata_ch0 → [1:0] rx_k_ch0 → [1:0] rx_disp_err_ch0 →		Receive Settings Equalization Setting RX I/O Termination (Ohms) RX I/O Coupling Loss of Signal Threshold Mode Loss of Signal Threshold Settin Clock and PLL Settings	Ch0 DISABLE 50 AC LOS_E 9 2		Ch1 DISABLED 50 AC LOS_E 2		Ch2 DISABLE 50 AC LOS_E 2		Ch3 DISABLED 50 AC LOS_E 2	N N N N
\uparrow \uparrow \uparrow \uparrow	bt_pwrup_ch0_c rx_pcs_rst_ch0_c rx_pwrup_ch0_c bt_div2_mode_ch0_c rx_div2_mode_ch0_c	[1:0] rx_cv_err_ch0 rx_los_low_ch0_s lsm_status_ch0_s	8	Reference Clock I0 Termination(Ohms) Reference Clock I0 Coupling TX PLL Loss of Lock	5 A 0	0						

Figure 7.18 Configuration GUI - SERDES Advanced Setup Tab

Table 7.8. SERDES_PCS GUI Attributes – SERDES Advanced Setup Tab

GUI Text	Attribute Name	Value	Default Value
Differential Output Voltage	CHx_TDRV ⁸	-4 (640mV) ⁵ , -3 (780mV), -2 (870mV), -1 (920mV), 0 (1040mV:default), 1 (1130mV) ⁶ , 2 (1260mV) ⁷ , 3 (1350mV) ⁷ , 4 (1440mV) ⁷	0
PreEmphasis	CHx_TX_PRE	Disabled, 0 (0%), 1 (5%), 2 (12%), 3 (18%), 4 (25%), 5 (33%), 6 (40%), 7 (48%)	DISABLED
TX I/O Termination (Ohms) ³	CHx_RTERM_TX	50, 75, 5K	50
Equalization ¹	CHx_RX_EQ	Disabled, Mid_Low, Mid_Med, Mid_High, Long_Low, Long_Med, Long_High	DISABLED
RX I/O Termination (Ohms) ³	CHx_RTERM_RX	50, 60, 75, High	50
RX I/O Coupling	CHx_RX_DCC	AC, DC	AC ²
Loss of Signal Threshold	CHx_LOS_THRESHOLD_LO	2 (+15%),3 (+25%)	2 ⁴
TX PLL Reference Clock I/O Termination (Ohms) ³	PLL_TERM	50, 2К	50

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GUI Text	Attribute Name	Value	Default Value
TX PLL Reference Clock I/O Coupling	PLL_DCC	AC, DC	AC ¹⁰
PLL Loss of Lock	PLL_LOL_SET	0: +/- 1350ppm x2 ⁹ 1: +/- 2400ppm x2 2: +/- 6800ppm 3: +/- 400ppm	0

Notes:

- 1. Refer to Table C.2 for details.
- 2. The typical capacitor value of the internal on-chip AC coupling is 5 pF.
- 3. Termination resistors and their usage: RX I/O Termination:
 - 50: So far all of the protocols except SMTPE use a 50-Ohm termination resistor.
 - 60: Provided for flexibility.
 - 75: SMPTE uses a 75-Ohm termination resistor.
 - HIGH: Default value when Rx is not used. TX I/O Termination:
 - 50: So far all of the protocols except SMTPE use a 50-Ohm termination resistor.
 - 75: SMPTE uses a 75-Ohm termination resistor.
 - 5K: Such as PCI Express electric idle and PCI Express RX detection. User does not set this termination value for RX

detection. Refer to the PCI Express Receiver Detection section.

TX PLL Termination:

- 50: If there is no 50-Ohm termination resistor on the PCB.
- 2K: If there is a 50-Ohm termination resistor on the PCB.
- 4. PCS configuration, GUI supports only the value 2 for all protocols except PCI Express. For PCI Express, both values 2 and 3 are supported.
- 5. TDRV_AMP_BOOST(CH_13[3]) is set to 1 to achieve this amplitude.
- 6. This setting is the PCI Express default setting. It is recommended to use this default setting with the PCI Express protocol. The IPexpress GUI TDRV drop-down window is grayed out for this reason. Other settings can still be used by editing the attribute CHn_TDRV in the auto- config file(.txt file).
- 7. VCCOB must be 1.5V for these settings.
- 8. The values are typical numbers. There is about +/-20% of margin for the whole frequency range. Refer to Table C.1, CHn_TDRV row for details.
- 9. 'x2' indicates successful double count of ppm in the internal LOL counter.
- 10. AC-coupling is recommended for most applications. DC-coupling should be used only in conjunction with an external AC-coupling capacitor.

Assignment of PCS Location

Users can specify their desired location of the PCS quad by writing in the constraint file (.lpf). The preference "locate" is used. An example of the syntax is shown below.

LOCATE COMP "pcs inst name" SITE "PCSB" ;

	<u> </u>
Quad Name	Site Name
Quad A	PCSA
Quad B	PCSB
Quad C	PCSC
Quad D	PCSD

High-speed I/O termination topology is shown in Figure 7.19.

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Figure 7.19 High-Speed I/O Terminations

PCS Advanced1 Setup

This tab is used to access the advanced attributes of the transmit and receive PCS for all four channels. The polarity and operating mode (e.g. 8b10b) of each individual TX and RX channel can be individually selected. In addition, word alignment values such as comma values, comma mask and comma align can be selected.

	PC	S	Qui	ad \ Reference Clocks \ SerDes A	dvanced PC	S A	dvanced1 \ P	CS A	idvanced2 \	Conta	rol Setup \ G	eneration 0
Г			-1	Fransmit Settings								
->	refclkp	hdoutp ch0			Ch0		Ch1		Ch2		Ch3	
	refcikn			Invert the Transmit Signal	DISABLED	•	DISABLED	•	DISABLED	-	DISABLED	*
->	hdinp_ch0	hdoutn_ch0		Enable 88108 Encoder	ENABLED	-	ENABLED	-	ENABLED	-	ENABLED	*
	hdinn_ch0	rx_full_clk_ch0		FPGA FIFO Bridge	ENABLED	-	ENABLED	-	ENABLED	-	ENABLED	-
	sci_sel_ch0							_		_		
\rightarrow	rxiclk_ch0	rx_half_clk_ch0	· _ f	Receive Settings	C1-0		6 14		Ch2		Ch2	
-	txiclk_ch0	tx_full_clk_ch0		In und the Density Cincel		-	DICADIED	_		-	LINS DISABLED	
-	[15:0] txdata_ch0			Invertine Necerve Signal	DISABLED	•	DISABLED	-	DISABLED	-	DISABLED	
-	[1:0] tx_k_ch0	tx_nat_cik_chu	5	Dynamically Invert Port	DISABLED	•	DISABLED	•	DISABLED	*	DISABLED	
-	[1:0] tx_force_disp_ch0	[15:0] rxdata_ch0	6 - E	Enable 88108 Decoder	ENABLED	•	ENABLED	•	ENABLED	*	ENABLED	*
-	[1:0] tx_disp_sel_ch0	(1:01 m k cb0		FPGA FIFO Bridge	ENABLED	•	ENABLED	•	ENABLED	*	ENABLED	*
	rx_serdes_rst_ch0_c	11.01.0_0_010		Word Alignment								
-	tx_pcs_rst_ch0_c	[1:0] rx_disp_err_ch0	·		Ch0		Ch1		Ch2		Ch3	
-	tx_pwrup_ch0_c	[1:0] rx cy err ch0		Word Alignment Block	ENABLED		ENABLED	-	ENABLED	w	ENABLED	-
\rightarrow	rx_pcs_rst_ch0_c	• • • • • • • • • • • • • • • • • • •		Internal Link State Machine	e ENABLED		ENABLED	-	ENABLED	-	ENABLED	-
-	rx_pwrup_ch0_c	rx_los_low_ch0_s	·	Specific Comma	K28P157	-	K28P157	-	K28P157	-	K28P157	-
-	tx_div2_mode_ch0_c	lsm_status_ch0_s	÷	Plus Comma Value	110000010	1	110000010	-	110000010	1	110000010	1
_	rx div2 mode ch0 c		~			_		_				

Figure 7.20 Configuration GUI - PCS Advanced1 Setup Tab

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GUI Text		Attribute Name	Default
Transmitter	Invert the Transmit Signal	CHx_TX_SB	DISABLED
	Enable 8b10b Encoder	CHx_TX_8B10B	Protocol Dependent
	FPGA FIFO Bridge	CHx_TX_FIFO	Protocol Dependent
Receiver	Invert the Receive Signal	CHx_RX_SB	DISABLED
	Dynamically Invert Port	N/A	DISABLED
	Enable 8b10b Decoder	CHx_RX_8B10B	Protocol Dependent
	FPGA FIFO Bridge	CHx_RX_FIFO	Protocol Dependent
Word Alignment	Word Alignment Block	CHx_RXWA	Protocol Dependent
	Internal Link	CHx_ILSM	Protocol Dependent
	Specific Comma	#CHx_SCOMMA	Protocol Dependent
	Plus Comma Value	CHx_COMMA_A ¹	1100000101
	Minus Comma Value	CHx_COMMA_B	0011111010
	Comma Mask	CHx_COMMA_M	Protocol Dependent ²

Table 7.9. SERDES/PCS GUI – PCS Advanced1 Setup Tab

Notes:

 By definition, COMMA_A and COMM_B are one set of 8b10b-encoded control characters with positive and negative running disparities. Users must provide the proper IDLE sequence per the protocol in order to get the link state machine synchronization. For example, 1 GbE protocol needs K28.5+D5.6 or D16.2 as IDLE (word alignment and sync state machine). The default values are in little endian format.

2. In most applications, K28.5 is used as the comma character. The default value of the mask is 1111111111. In G8B10B mode, any comma can be used so the mask will be 111111100 to detect any of the three comma characters, K28.1, 28.5, 28.7.

PCS Advanced2 Setup

This tab is used for setting values for the Clock Tolerance Compensation block.

3	PC	s		Quad \ Reference Clocks \ Se	nDes Advanced \ PC	S Advanced1 \ PCS A	dvanced2 \ Control S	etup \ Generation Op
† † † † † † † † † † †	refclkp refclkn hdnp_ch0 hdnn_ch0 sci_sel_ch0 niclk_ch0 [15:0] txdsta_ch0 [1:0] tx_k_ch0 [1:0] tx_k_ch0 [1:0] tx_disp_sel_ch0 [1:0] tx_disp_sel_ch0	$\begin{array}{c} hdoutp_ch0 \longrightarrow \\ hdoutn_ch0 \longrightarrow \\ nx_ful_clk_ch0 \longrightarrow \\ nx_halt_clk_ch0 \longrightarrow \\ tx_full_clk_ch0 \longrightarrow \\ tx_full_clk_ch0 \longrightarrow \\ tx_halt_clk_ch0 \longrightarrow \\ (15:0) \mathsf{nxdata_ch0} \longrightarrow \\ (1:0) \mathsf{nx_k_ch0} \longrightarrow \end{array}$		Receive Settings CTC CTC block Size of the ordered set to match (Bytes) ByteN(Hex) ByteN+1(Hex) ByteN+2(Hex) ByteN+3(Hex) Inter packet gap to enforce Amount of Offset Before Ins Deletion Threshold 9	Ch0 DISABLED ▼ 1 ▼ K 0x 00011100 FK 0x 0001100 FK 0x 000100 FK 0x 0001100 FK 0x 0001100 FK 0x 00000 FK 0x 00000 FK 0x 0000 FK 0x 00000 FK 0x 0000 FK 0x 00000 FK 0x 00000 FK 0x 0000 FK 0x 00000 FK 0x 000000 FK 0x 000000 FK 0x 000000 FK 0x 0000000 FK 0x 0000000000000000000000000000000000	Ch1 DISABLED ▼ 1 ▼ K 0x 00011100 FF K 0x 0001100 FF K 0x 00001100 FF K 0x 0000100 FF K 0x 000000 FF K 0x 000000 FF K 0x 0000000 FF K 0x 00000000 FF K 0x 00000000000000000000000000000000	Ch2 DISABLED ▼ 1 ▼ F K 0x 00000000 F K 0x 00011100 F K 0x 00011100 3 ▼	Ch3
* † † † † † †	to_becs_rst_ch0_c to_pos_rst_ch0_c to_pwrup_ch0_c rs_pwrup_ch0_c to_drv2_mode_ch0_c to_drv2_mode_ch0_c to_drv2_mode_ch0_c	[1:0] ⋈_disp_err_ch0 [1:0] ⋈_cv_err_ch0 ⋈_los_low_ch0_s Ism_status_ch0_s	×	Insertion Threshold 7 Deletion/Insertion Threshol an ordered set is controllabl	s: The point at which o	clock tolerance compen	sation block inserts or	deletes

Figure 7.21 Configuration GUI – PCS Advanced2 Setup Tab

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Table 7.10. SERDES/PCS GUI – PCS Advanced2 Setup Tab

GUI Text	Attribute Name	Default
CTC block	CHx_CTC	Protocol Dependent ¹
Size of ordered set	CHx_CC_MATCH_MODE	Protocol Dependent
Byte N	CHx_CC_MATCH1	Protocol Dependent
Byte N+1	CHx_CC_MATCH2	Protocol Dependent
Byte N+2	CHx_CC_MATCH3	Protocol Dependent
Byte N+3	CHx_CC_MATCH4	Protocol Dependent
Interpacket gap	CHx_CC_MIN_IPG	Protocol Dependent
Deletion threshold	CCHMARK	9
Insertion threshold	CCLMARK	7

Note:

1. Always disabled: XAUI, SDI, CPRI, OBSAI, Serial Rapid IO, 10-bit SERDES, 8-bit SERDES All other modes: Disabled by default. Most of the CTC features are provided in IP.

Control Setup

This tab is used to select the SCI interface and other debug and control options. In addition, users can enable the SCI, error reporting, PLL quarter clock, and loopback capability.

PC	9	Queit Pleternce Clocks Selles Advanced	PCS Advanceds { PCS	Advanced2 1	Control Seitury Generation Co
	héputp_chi	Loopback Selection Loopback Made CH0 Loopback Made CH1	DISABLED DISABLED		N N
- reicilun	hown_in	Loopbeck Hode Chil	DIPUTED		1 1
hdinp_ch0	11 M (A 117-1	Cartal Pola Travoniter Electrical Ide	IT DIE IT DIE	r or	F (51
-+ ಹತ್ಮರಗಿ	nchel_ck_ck	Preed Sequence Generation Provide Sectors Sequence Generation Provide SetDec Clent Interface (SCOIts dury	micala careal PCS/SeCv	n options at hard	me
→ sidk_ch0 → (7.0)tedata_ch0	NM_CR_CH0-+	Provide the Section Clark Heritics (5.3) Provide more Clark to PPSA Core			
-+ ujkjehů	ts,hal_ck_ctil-+				
	17 0) todata_ch0 🛶				
	*				

Figure 7.22 Configuration GUI – Control Setup Tab



Table 7.11. Tab 5, SERDES_PCS GUI Attributes – Control Setup Tab

GUI Text	Attribute Name	Default
Loopback Mode (Ch0, Ch1, Ch2, Ch3)	DISABLED	DISABLED ¹
	Loopback serial data after equalizer Loopback serial	
	data after transmit driver Loopback parallel data after	
	de_serializer	
Transmitter Electrical Idle	signal tx_idle_ch0_c is provided	DISABLED
Include Reset Sequence Generation ²	Include the TX and RX Reset Sequence	ENABLED
Provide SERDES Client Interface	N/A	
Provide the SERDES Client Interface Interrupt Port	INT_ALL	DISABLED
Reference Clock to FPGA core	QD_REFCK2CORE	DISABLED

Notes:

 When loopback mode is in default mode (DISABLED), the two SERDES Bridge Parallel loopback control signals (sb_felb_ch[3:0]_c and sb_felb_rst_ch[3:0]_c) are available in the HDL module for users to turn on and off the loopback mode dynamically. These signals should be tied to ground if loopback mode is not used.

2. Reset Sequence Generation is described in the SERDES/PCS RESET section of this document.

Reference Clock to FPGA Core and Reset Sequence

The reset sequence uses a reference clock in the Reset State Machine.

If "Internal" is selected as the Tx Refclk source, the Reset State Machine uses the internal reference clock.

If "External" is selected as the Tx Refclk source, the Reset State Machine uses the Reference Clock to FPGA Core signal transparent to the user (Control Register bit, QD_0A[1] is set). The REFCLK2FPGA signal will be included in the wrapper module only when "Reference Clock to FPGA Core" is selected.

Generation Options

This tab provides options for users to select the PCS module generation output files of their choice.

PC	S	Quad \ Reference Clocks \ SerDes Advanced \ PCS Advanced1 \ PCS Advanced2 \ Control Setup \ Generation Option
refclkp refclkn refclkn hding_ch0 hding_ch0 sci_sel_ch0 rsck_ch0 tsick_ch0 (15.0)tsdsta_ch0 (15.0)tsdsta_ch0 (10)ts_ch0_ch0 (1:0)ts_ch0_ch0_ch0_c rscedes_ts_ch0_c ts_pwrup_ch0_c rs_pwrup_ch0_c	hdoutp_ch0 → hdoutp_ch0 → nc_hall_ck_ch0 → tx_tull_ck_ch0 → tx_tull_ck_ch0 → tx_hall_ck_ch0 → [15:0] ndsta_ch0 → [1:0] nc_k_ch0 → [1:0] nc_cv_en_ch0 → nc_los_low_ch0_s →	Automatic (Generate Module and Settings as needed) Force Module and Settings Generation Force Settings Generation Only (error if module generation required)
-> tx_div2_mode_ch0_c	lsm_status_ch0_s	

Figure 7.23 Configuration GUI – Generation Options Tab

When migrating an older project created in a previous version of Diamond to the latest version for the first time, it is highly recommended to regenerate the PCS module in the latest version even if no configuration changes are required.



This will ensure the most current set of primitive library elements is used. If this is not done, it is possible that the design may either fail in the flow or go through the flow but show unexpected behavior on the board.

When regenerating the PCS module in an existing project, often the HDL file remains the same and only the configuration file must be regenerated. In this case, users can run the "Generate Bitstream Data" and "Force One Level" option to save compile time.

- Automatic When selected, IPexpress will generate only the necessary files. This can include both the HDL and TXT files or just the TXT file. This is the default setting.
- Force Module and Settings Generation When selected, both the HDL and TXT files will be generated. This forces the Project Navigator processes to be reset back to synthesis.
- Force Settings Generation Only When selected, only the TXT file will be generated. If HDL generation is necessary, an error message will be provided.
- Flow Definitions The generation option works differently between the two module flows.
 - HDL Source Flow: HDL File in Project Navigator
 The existing LPC file can be opened from IPexpress for regeneration. In this case, the reset point set by the GUI will be the new starting point. So, when the user double-clicks a process or runs the "Force One Level" option, it will start at that reset point.
 - LPC Source Flow: LPC File in Project Navigator
 Opening the LPC file and regenerating the PCS module will reset the whole process whether or not the HDL module is regenerated.
 In either case, the checkmarks in the Processes window will remain unchanged but will be updated as soon as

Configuration File Description

the user starts the process.

IPexpress generates this file which contains attribute-level map information. This file is used by the simulation model as well as the bitstream generation process to automatically initialize the PCSD quad to the mode selected in IPexpress.

The configuration file uses "txt" as the file type extension. Below is an example of the configuration file. # This file is used by the simulation model as well as the bitstream # generation process to automatically initialize the PCSD quad to the mode # selected in the IPexpress. This file is expected to be modified by the # end user to adjust the PCSD quad to the final design requirements.

```
DEVICE_NAME "LFE3-95E" CH0 MODE
                                    "RXTX"
CH1 MODE "DISABLED"
CH2 MODE
            "DISABLED"
CH3 MODE "DISABLED"
TX DATARATE RANGE "HIGH"
            "REFCLK EXT"
PLL SRC
REFCK MULT "10X"
#REFCLK RATE
                  250.0
CHO PROTOCOL
                  "G8B10B"
CH0 LDR
            "RXTX"
CH0 RX DATARATE RANGE
                        "HIGH" CHO TX DATA RATE "FULL"
CHO TX DATA WIDTH "8"
CHO TX FIFO "DISABLED"
CH0 CDR SRC "REFCLK EXT"
#CH0 TX FICLK RATE
                        250.0
CHO RX DATA RATE "FULL"
CHO RX DATA WIDTH "8"
CH0_RX FIFO "DISABLED"
#CH0 RX FICLK RATE
                        250.0
            "0"
CH0 TDRV
CHO TX PRE "DISABLED"
```



```
"50"
CHO RTERM TX
CHO RX EQ "DISABLED"
CHO RTERM RX
                 "50"
CHO RX DCC "AC"
CHO LOS THRESHOLD LO
                      "2" CHO TX SB
                                        "DISABLED"
CHO TX 8B10B "ENABLED"
CHO RX SB "DISABLED"
CHO RX 8B10B
                 "ENABLED"
CHO RXWA "ENABLED"
CHO ILSM
          "ENABLED"
#CH0 SCOMMA "1111111111"
CH0 COMMA A "1100000101"
CH0 COMMA B "0011111010"
CH0 COMMA M "1111111100"
CH0 CTC "ENABLED"
CH0 CC MATCH MODE "2"
CH0 CC MATCH1
                "0000000000"
CH0 CC MATCH2
                 "0000000000"
              "3"
CHO CC MIN IPG
CHO SSLB "DISABLED"
                "DISABLED"
CH0 SPLBPORTS
CH0 PCSLBPORTS
                 "DISABLED"
PLL TERM "50"
        "AC"
PLL DCC
PLL LOL SET "0"
           "9"
CCHMARK
           "7"
CCLMARK
           "DISABLED"
INT ALL
                 "ENABLED"
QD REFCK2CORE
```

7.23. 8-Bit and 10-Bit SERDES-Only Modes

This section describes the operation of the two modes of the SERDES/PCS block, 8-bit SERDES-Only and 10-bit SERDES-Only. These modes are intended for applications requiring access to a high-speed I/O interface without the protocolbased manipulation provided in the LatticeECP3 PCS logic.

Transmit Path

• Serializer: Conversion of 8-bit or 10-bit parallel data to serial data.

Receive Path

- Deserializer: Conversion of serial data to 8-bit or 10-bit parallel data.
- Optional word alignment to user-defined alignment pattern.

7.24. Generic 8b10b Mode

The Generic 8b10b mode of the SERDES/PCS block is intended for applications requiring 8b10b encoding/decoding without the need for additional protocol-specific data manipulation. The LatticeECP3 SERDES/PCS block can support Generic 8b10b applications up to 3.2 Gbps per channel. In Generic 8b10b mode, the word aligner can be controlled from the embedded PCS Link State Machine (LSM).

When the embedded Link State Machine is selected and enabled, the lsm_status_ch[3:0]_s status signal will go high upon successful link synchronization.

To achieve link synchronization in this mode, the following conditions need to be satisfied on the 8b10b patterns received at the SERDES channel's receiver input (hdinp_ch[0-3]/hdinn_ch[0-3]):



- Periodic 8b10b encoded comma characters need to be present in the serial data. Periodicity is required to allow the LSM to re-synchronize to commas upon loss of sync. The comma characters should correspond to the "Specific Comma" value shown in Figure 7.20. For example, when the Specific Comma is set to K28P157, the comma value on the serial link can be the 8b10b encoded version of any of K28.1 (k=1, Data=0x3C), K28.5 (k=1, Data=0xBC), or K28.7 (k=1, Data=0xFC). Note though that K28.5 is most commonly used.
- A comma character has to be followed by a data character
- Two comma characters have to be an even number of word clock cycles apart

Additional information:

- It takes roughly four good comma/data pairs for the LSM to reach link synchronization
- It takes four consecutive errors (illegal 8b10b encoded characters, code violations, disparity errors, uneven number of clock cycles between commas) to cause the LSM to unlock
- A CDR loss of lock condition will cause the LSM to unlock by virtue of the many code violation and disparity errors that will result
- When the internal reset sequence state machine is used, a CDR loss of lock (rx_cdr_lol_ch[3:0]_s) or a loss of signal (rx_los_low_ch[3:0]_s) condition will cause the RX reset sequence state machine to reset the SERDES and cause the LSM to unlock

The two examples below illustrate the difference between a valid and an invalid even clock cycle boundary between COMMA occurrences (Note: C = comma, D = data).

Valid (even) comma boundary:

Word Clock Cycle	0	1	2	3	4	5	6	7	8	9	10	11
CHARACTER	С	D	С	D	С	D	D	D	D	D	С	D

Invalid (odd) comma boundary:

Word Clock Cycle	0	1	2	3	4	5	6	7	8	9	10	11	12
CHARACTER	С	D	С	D	С	D	D	D	D	С	D	С	D

In the invalid (odd) comma boundary case above, the comma occurrences on cycles 9 and 11 are invalid since they do not fall on an even boundary apart from the previous comma.

Alternatively, the LSM can be disabled, and the word aligner is controlled from the fabric word_align_en_ch[3:0]_c input pin. See External Link State Machine Option section on page 27 and PCS Advanced1 Setup section on page 38 for more information.

Transmit Path

- Serializer
- 8b10b encoder

Receive Path

- Deserializer
- Word alignment to a user-defined word alignment character or characters from embedded GbE Link State Machine
- 8b10b decoding
- Clock Tolerance Compensation (optional)

7.25. LatticeECP3 PCS in Gigabit Ethernet and SGMII Modes

The Gigabit Ethernet mode of the LatticeECP3 SERDES/PCS block supports full compatibility, from the Serial I/O to the GMII/SGMII interface of the IEEE 802.3-2002 1000 BASE-X Gigabit Ethernet standard.

Transmit Path

- Serializer
- 8b10b encoding



Receive Path

- Deserializer
- Word alignment based on IEEE 802.3-2002 1000 BASE-X defined alignment characters.
- 8b10b decoding
- The Gigabit Ethernet Link State Machine is compliant to Figure 7.3 (Synchronization State Machine, 1000BASE-X) of IEEE 802.3-2002 with one exception. Figure 7.3 requires that four consecutive good code groups are received in order for the LSM to transition from one SYNC_ACQUIRED_{N} (N=2,3,4) to SYNC_ACQUIRED_{N-1}. Instead, the actual LSM implementation requires five consecutive good code groups to make the transition.
- Gigabit Ethernet Carrier Detection: Section 36.2.5.1.4 of IEEE 802.3-2002 (1000BASE-X) defines the carrier_detect function. In Gigabit Ethernet mode, this feature is not included in the PCS and a carrier_detect signal is not provided to the FPGA fabric.
- Clock Tolerance Compensation logic capable of accommodating clock domain differences.

Gigabit Ethernet (1000BASE-X) Idle Insert

This is required for Clock Compensation and Auto-negotiation. Auto-negotiation is done in FPGA logic. The Lattice Gigabit Ethernet PCS IP core provides the auto-negotiation discussed below.

Idle pattern insertion is required for clock compensation and auto-negotiation. Auto-negotiation is done in FPGA logic. This module automatically inserts /I2/ symbols into the receive data stream during auto-negotiation. While auto-negotiating, the link partner will continuously transmit /C1/ and /C2/ ordered sets. The clock-compensator will not delete these ordered sets as it is configured to only insert/delete /I2/ ordered sets. In order to prevent overruns and underruns in the clock-compensator, /I2/ ordered sets must be periodically inserted to provide insertion/deletion opportunities for the clock compensator.

While performing auto-negotiation, this module will insert a sequence of eight /l2/ ordered sets (two bytes each) every 2048 clock cycles. As this module is after the 8b10b decoder, this operation will not introduce any running disparity errors. These /l2/ ordered sets will not be passed on to the FPGA receive interface as the GMII interface is driven to IDLE by the RX state machine during auto-negotiation. Once auto-negotiation is complete, /l2/ insertion is disabled to prevent any corruption of the received data.

Note that this state machine is active only during auto-negotiation. The auto-negotiation state machine and the GbE receive state machines are implemented in the soft logic. This state machine depends on the signal xmit_ch[3:0] from the auto-negotiation state machine. This signal is provided on the TX data bus. Though this signal is relatively static (especially after auto-negotiation) it is included in the TX data bus.

Module Signal	Direction	Description
xmit_ch[3:0]	In	From FPGA logic Auto-Negotiation State Machine

Gigabit Ethernet Idle Insert and correct_disp_ch[3:0] Signals

The correct_disp_ch[3:0] signal is used on the transmit side of the PCS to ensure that an interpacket gap begins in the negative disparity state. Note that at the end of an Ethernet frame, the current disparity state of the transmitter can be either positive or negative, depending on the size and data content of the Ethernet frame.

However, from the FPGA soft-logic side of the PCS, the current disparity state of the PCS transmitter is unknown. This is where the correct_disp_ch[3:0] signal comes into play. If the correct_disp_ch[3:0] signal is asserted for one clock cycle upon entering an interpacket gap, it will force the PCS transmitter to insert an IDLE1 ordered-set into the transmit data stream if the current disparity is positive. However, if the current disparity is negative, then no change is made to the transmit data stream.

From the FPGA soft-logic side of the PCS, the interpacket gap is typically characterized by the continuous transmission of the IDLE2 ordered set which is as follows: $tx_k_ch=1$, txdata=0xBC $tx_k_ch=0$, txdata=0x50.

Note that in the PCS channel, IDLE2s mean that current disparity is to be preserved. IDLE1s mean that the current disparity state should be flipped. Therefore, it is possible to ensure that the interpacket gap begins in a negative disparity state. If the disparity state before the interpacket gap is negative, then a continuous stream of IDLE2s are transmitted during the interpacket gap. If the disparity state before the interpacket gap is positive, then a single IDLE1 is transmitted followed by a continuous stream of IDLE2s.



In the FPGA soft-logic side of the PCS, the interpacket gap is always driven with IDLE2s into the PCS. The correct_disp_ch[3:0] signal is asserted for one clock cycle, k_cntrl=0, data=0x50 when the interpacket gap first begins. If necessary, the PCS will convert this IDLE2 into an IDLE1. For the remainder of the interpacket gap, IDLE2s should be driven into the PCS and the correct_disparity_chx signal should remain deasserted.

For example, if a continuous stream of 512 bytes of Ethernet frames and 512 bytes of /I/ are sent, it can be observed that:

- During the first interpacket gap, all negative disparity /l2/s are seen (K28.5(-) D16.2(+))
- During the next interpacket gap, the period begins with positive disparity /l1/ (K28.5 (+), D5.6 (+/- are the same)), then all remaining ordered sets are negative disparity /l2/s
- During the next interpacket gap, all negative disparity /l2/s are seen
- During the next interpacket gap, the period begins with positive disparity /l1/ (K28.5 (+), D5.6 (+/- are the same)), then all remaining ordered sets are negative disparity /l2/s

A number of programmable options are supported within the encoder module. These are:

- Ability to force negative or positive disparity on a per-word basis
- Ability to input data directly from the FIFO Bridge external multiplexer
- Ability to replaced code words dependant upon running disparity (100BASE-X and FC)
- Software register controlled bypass mode

7.26. XAUI Mode

With the Lattice XAUI IP Core, the XAUI mode of the SERDES/PCS block supports full compatibility from Serial I/O to the XGMII interface of the IEEE 802.3-2002 XAUI standard. XAUI Mode supports 10 Gigabit Ethernet.

Transmit Path

- Serializer
- Transmit State Machine which performs translation of XGMII idles to proper ||A||, ||K||, ||R|| characters according to the IEEE 802.3ae-2002 specification
- 8b10b Encoding

Receive Path

- Deserializer
- Word alignment based on IEEE 802.3-2002 defined alignment characters.
- 8b10b Decoding
- The XAUI Link State Machine is compliant to Figure 7.7 PCS synchronization state diagram of IEEE 802.3ae 2002 with one exception. Figure 7.7 requires that four consecutive good code groups be received in order for the LSM to transition from one SYNC_ACQUIRED_{N} (N=2,3,4) to SYNC_ACQUIRED_{N-1}. Instead, the actual LSM implementation requires five consecutive good code groups to make the transition.
- Clock Tolerance Compensation logic in PCS is disabled in XAUI mode. MCA (Multi-Channel Alignment) and CTC are done in the XAUI IP core.
- x4 multi-channel alignment should be done in FPGA core logic.

7.27. LatticeECP3 PCS in PCI Express Revision 1.1 (2.5Gpbs) Mode

The PCI Express mode of the SERDES/PCS block supports x1, x2, and x4 PCI Express applications.

Transmit Path

- Serializer
- 8b10b Encoding
- Receiver Detection
- Electrical Idle

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Receive Path

- Deserializer
- Word alignment based on the Sync Code
- 8b10b Decoding
- Link Synchronization State Machine functions incorporating operations defined in the PCS Synchronization State Machine (Figure 7.7) of the IEEE 802.3ae-2002 10GBASE-X Specification.
- x2 or x4 PCI Express operation with one PCS quad set to PCI Express mode.
- Clock Tolerance Compensation logic capable of accommodating clock domain differences.
- x2 or x4 multi-channel alignment should be done in FPGA core logic. Table 7.13 describes the PCI Express mode specific ports.

Table 7.13 describes the PCI Express mode specific ports.

Signal	Direction	Class	Description
pcie_done_ch[3:0]_s	Out	Channel	1 = Far-end receiver detection complete 0 = Far-end receiver detection incomplete
pcie_con_ch[3:0]_s	Out	Channel	Result of far-end receiver detection 1 = Far-end receiver detected 0 = Far-end receiver not detected
pcie_det_en_ch[3:0]_c	In	Channel	FPGA logic (user logic) informs the SERDES block that it will request a PCI Express Receiver Detection operation. 1 = Enable PCI Express Receiver Detect 0 = Normal Operation
pcie_ct_ch[3:0]_c	In	Channel	1 = Request transmitter to do far-end receiver detection 0 = Normal data operation
rxstatus[2:0]	Out	Channel	Per-channel PCI Express receive status port. RxStatus# is an encoded status of the receive data path. 2 bits wide if in 16-bit data bus mode.

Table 7.13. PCI Express Mode Specific Ports

The status signal, rxstatus, is an encoded status of the receive data path. The encoding is as follows.

rxstatus[2:0]			Description	Priority
0	0	0	Received data OK	8
0	0	1	1 byte inserted by CTC	7
0	1	0	1 byte deleted by CTC	6
0	1	1	Receiver detected (pcie_done, pcie_con)	1
1	0	0	8b10b decode error (code violation - rx_cv_err)	2
1	0	1	CTC FIFO overflow (ctc_orun)	3
1	1	0	CTC FIFO underflow (ctc_urun)	4
1	1	1	Receive disparity error (rx_disp_err)	5

Table 7.14. rxstatus Encoding

PCI Express Termination

At the electrical level, PCI Express utilizes two uni-directional low voltage differential signaling pairs at 2.5 Gbps for each lane. Transmit and receive are separate differential pairs, for a total of four data wires per lane. An input receiver with programmable equalization and output transmitters with programmable pre-emphasis permits optimization of the link. The PCI Express specification requires that the differential line must be common mode terminated at the receiving end. Each link requires a termination resistor at the far (receiver) end. The nominal resistor values used are 100 ohms. This is accomplished by using the embedded termination features of the CML inputs as shown in Figure 7.24. The specification requires AC coupling capacitors (CTX) on the transmit side of the link. This eliminates potential common-mode bias mismatches between transmit and receive devices. The capacitors must be added external to the Lattice CML outputs.



PCI Express L2 State

For the PCI Express L2 state, the rx_pwrup_c signal should not be de-asserted to power-down the rx channel. This will force the RX termination to high impedance and will not allow the far-end to detect the receiver. Rather, the rx pcs rst c signal should be used to hold the channel in reset to save power.



Figure 7.24 PCI Express Interface Diagram

Table 7.15. Differential PCI Express Specification
--

Symbol	Parameter	Min.	Nom.	Max.	Units	Comments	Location
ZTX-DIFF-DC	DC Differential TX Impedance	80	100	120	Ohm	TX DC Differential mode low impedance. ZTX-DIFF-DC is the small signal resistance of the transmitter measured at a DC operating point that is equivalent to that established by connecting a 100 Ohm resistor from D+ and D- while the TX is driving a static logic one or logic zero.	Internal
ZRX-DIFF-DC	DC Differential Input Impedance	80	100	120	Ohm	RX DC Differential mode impedance during all LTSSM states. When transmitting from a Fundamental Reset to Detect, (the initial state of the LTSSM), there is a 5 ms transition time before receiver termination values must be met on all unconfigured lanes of a port.	Internal
СТХ	AC Coupling Capacitor	75		200	nF	All transmitters shall be AC coupled. The AC coupling is required either within the media or within the transmitting component itself.	External

PCI Express Electrical Idle Transmission

Electrical Idle is a steady state condition where the transmitter P and N voltages are held constant at the same value (i.e., the Electrical Idle Differential Peak Output Voltage, VTX-IDLE-DIFFp, is between 0 and 20 mV). Electrical Idle is primarily used in power saving and inactive states.

Per the PCI Express base specification, before a transmitter enters Electrical Idle, it must always send the Electrical Idle Ordered Set (EIOS), a K28.5 (COM) followed by three K28.3 (IDL). After sending the last symbol of the Electrical Idle Ordered Set, the transmitter must be in a valid Electrical Idle state as specified by TTX-IDLE-SET- TO-IDLE is less than 20 UI.

To achieve this, the Electrical Idle Enable (tx_idle_chx_c) from the FPGA core logic to the PCS is sent in along with each transmit data. This signal is pipelined similarly all the way to the PCS-SERDES boundary. For all valid data this signal is LOW. To initiate Electrical Idle, the FPGA logic pulls this signal HIGH on the clock after it transmits the last K28.3 (IDL)



symbol. As the signal is pipelined to the PCS-SERDES boundary, the relationship between the transmit data and this signal is exactly the same as on the FPGA-PCS boundary.

14 UI after the rising edge of the Electrical Idle enable signal at the PCS-SERDES boundary the last bit (bit7) of the last K28.3 (IDL) symbol is transmitted. 16 UI (<20 UI) later the transmit differential buffer achieves Electrical Idle state.



Figure 7.25 Transmit Electrical Idle

As long as the FPGA core logic deems that the transmitter needs to stay in Electrical Idle state it needs to clock in data (preferably all zeros) along with the Electrical Idle Enable (tx_idle_chx_c) signal active (HIGH). The transmitter is required to stay in the Electrical Idle state for a minimum of 50 UI (20 ns) (TTX-IDLE-MIN).

PCI Express Electrical Idle Detection

Each channel in the quad has a loss-of-signal detector. The Electrical Idle is detected once two out of the three K28.3 (IDL) symbols in the Electrical Idle Ordered Set (EOS) have been received. After the Electrical Idle Ordered Set is received, the receiver should wait for a minimum of 50ns (TTX-IDLE-MIN) before enabling its Electrical Idle Exit detector.

These signals (one per channel, four per quad) should be routed through the PCS, and should be made available to the FPGA core. The required state machine(s) to support electrical idle can then be constructed in the FPGA core.

PCI Express Receiver Detection

Figure 7.26 shows a Receiver Detection sequence. A Receiver Detection test can be performed on each channel of a quad independently. Before starting a Receiver Detection test, the transmitter must be put into electrical idle by setting the tx_idle_ch#_c input high. The Receiver Detection test can begin 120 ns after tx_elec_idle is set high by driving the appropriate pci_det_en_ch#_c high. This puts the corresponding SERDES Transmit buffer into receiver detect mode by setting the driver termination to high impedance and pulling both differential outputs to VCCOB through the high impedance driver termination.

Setting the SERDES Transmit buffer into receiver detect state takes up to 120 ns. After 120 ns, the receiver detect test can be initiated by driving the channel's pcie_ct_ch#_c input high for four byte (word) clock cycles. The corresponding channel's pcie_done_ch#_s is then cleared asynchronously. After enough time for the receiver detect test to finish has elapsed (determined by the time constant on the transmit side), the pcie_done_ch#_s receiver detect status port will go high and the Receiver Detect status can be monitored at the pcie_con_ch#_s port. If at that time the pcie_con_ch#_s port is high, then a receiver has been detected on that channel. If, however, the pcie_con_ch#_s port is low, then no receiver has been detected for that channel. Once the Receiver Detect test is complete, tx_idle_ch#_c can be deasserted.

Receiver detection proceeds as follows:

1. The user drives pcie_det_en high, putting the corresponding TX driver into receiver detect mode. This sets the driver termination to high-impedance (5K ohm) and pulls both outputs of the differential driver toward common mode through the high-impedance driver termination. The TX driver takes some time to enter this state so the pcie_det_en must be driven high for at least 120ns before pcie_ ct is asserted.



- 2. The user drives pcie_ct high for four byte clocks.
- 3. SERDES drives the corresponding pcie_done low.
- 4. SERDES drives the internal signal (corresponding to pcie_ct) for as long as it is required (based on the time constant) to detect the receiver.
- 5. SERDES drives the corresponding pcie_con connection status.
- 6. SERDES drives the corresponding pcie_done high.
- 7. The user can use this asserted stated of pcie_done to sample the pcie_con status to determine if the receiver detection was successful.



Figure 7.26 PCI Express Mode Receiver Detection Sequence

PCI Express Power Down Mode

rx_serdes_rst_ch[3:0] reset signal should be used instead of rx_pwrup_ch[3:0] signal. This allows the RX termination to remain enabled at 50 Ohms so that the far-end transmitter can detect that a receiver is connected.

7.28. PCI Express Beacon Support

This section highlights how the LatticeECP3 PCS can support Beacon detection and transmission. The PCI Express requirements for Beacon detection are presented with the PCS support for Beacon transmission and detection.

Beacon Detection Requirements

- Beacon is required for exit from L2 (P2) state.
- Beacon is a DC-balanced signal of periodic arbitrary data, which is required to contain some pulse widths ≥ 2ns (500 MHz) and < 16 us (30 KHz).
- Maximum time between pulses should be < 16 us.
- DC balance must be restored within < 32 us.
- For pulse widths > 500 ns, the output beacon voltage level must be 6 db down from VTX-DIFFp-p (800 mV to 1200 mV).
- For pulse widths < 500 ns, the output beacon voltage level must be ≤ VTX-DIFFp-p and ≥ 3.5 db down from VTX-DIFFp-p.

PCS Beacon Detection Support

- The signal loss threshold detection circuit senses if the specified voltage level exists at the receiver buffer.
- This is indicated by the rlos_lo_ch(0-3) signal.
- This setting can be used both for PCI Express Electrical Idle Detection and PCI Express beacon detection (when in power state P2).
- The remote transmitting device can have a beacon output voltage of 6 db down from VTX-DIFFpp (i.e., 201 mV). If this signal can be detected, then the beacon is detected.



PCS Beacon Transmission Support

Sending the K28.5 character (IDLE) (5 ones followed by 5 zeroes) provides a periodic pulse with of 2 ns occurring every 2 ns (1.0 UI = 400 ps, multiplied by 5 = 2 ns). This meets the lower requirement. The output beacon voltage level can then be VTX-DIFFp-p. This is a valid beacon transmission.

7.29. SDI (SMPTE) Mode

The SDI mode of the LatticeECP3 SERDES/PCS block supports all three SDI modes, SD-SDI, HD-SDI and 3G-SDI.

Transmit Path

Serializer

Receive Path

- Deserializer
- Optional word alignment to user-defined alignment pattern.

The following data rates are the most popular in the broadcast video industry.

- SD-SDI (SMPTE259M): 270Mbps
- HD-SDI (SMPTE292M): 1.485Gbps, 1.485Gbps/1.001 = 1.4835Gbps
- 3G-SDI (SMPTE424M): 2.97Gbps, 2.97Gbps/1.001 = 2.967Gbps

Most designers have indicated that they would like to see support for all these rates. The reason is that in a broadcast studio, or a satellite head-end or cable head-end, they do not necessarily have prior knowledge of what the RX data rate will be.

The switchover time between different rates should be as low as possible. The time to re-lock the CDR is unavoidable. In the LatticeECP3 SERDES, the PLL does not have to be re-locked. This is possible because the LatticeECP3 has per RX and TX dividers. Video links generally have a unidirectional nature (i.e., different channels can run at different rates, and more importantly, the RX and TX in the same channel can run at different rates).

Also, depending on the geography where the equipment is deployed, either the full HD/3G-SDI rates (Europe/Asia) are used while transmitting video or the fractional rates (North America - NTSC). This allows us to develop two potential solution example cases for multi-rate SMPTE support with high quad utilization.

Please note that simultaneous support of 3G/HD Full TX Rate(s) and Fractional TX Rate(s) is not possible in the same SERDES quad. In general, based on the above, geographically partitioned usage is an acceptable limitation.



Figure 7.27 Example A: 3G/HD/SD Full RX/TX Rate Support and 3G/HD Fractional TX Rate Support



To support the major application requirements, a selectable DIV per RX and TX is supported. In LatticeECP3, DIV11 has been added. One potential multi-rate configuration is to provide a 148.5 MHz REFCLK from the primary pins to the TX PLL. The TX PLL would be in the x20 mode. The resulting output clock would be 2.97 GHz. Then, by using the DIV2 for 1.485 Gbps and DIV11 for 270 Mbps, a very quick switchover can be achieved without having to re-train and lock the PLL.

7.30. Serial RapidIO (SRIO) Mode

This section describes the operation of the Serial RapidIO mode of the SERDES/PCS block. The LatticeECP3 supports 1x and 4x Serial RapidIO applications with one PCS quad. SRIO1.0 highlights multiple frequency support, 3.125 Gbps, 2.5 Gbps and 1.25 Gbps. The ratio of these rates is 2.5:2:1. Supporting all of these rates with integer dividers in the same quad is not possible, but the ratio of 2.5 Gbps to 1.25 Gbps is 2:1 (full rate : half rate).

Transmit Path

- Serializer
- 8b10b encoding

Receive Path

- Deserializer
- Word alignment based on the Sync Code Group as defined in the RapidIO Physical Layer 1x/4x LP-Serial specification.
- 8b10b decoding
- Clock Tolerance Compensation logic capable of accommodating clock domain differences

7.31. Serial Digital Video and Out-Of-Band Low Speed SERDES Operation

The LatticeECP3 SERDES/PCS supports any data rates that are slower than what the SERDES TX PLL and RX CDR natively support (<250 Mbps: Out-Of-Band signal, OOB), by bypassing the receiver CDR and associated SERDES/PCS logic (e.g., 100 Mbps Fast Ethernet, SD-SDI at 143 Mbps or 177 Mbps). Though these out-of-band paths primarily use low data rates, higher rates can be used for other functional reasons. See the Multi-Rate SMPTE Support section of this document for more information.

In addition, for SD-SDI, these rates sometimes must co-exist on the same differential RX pair with HD-SDI rates (i.e., SD-SDI rates may be active and then the data rate may switch over to HD-SDI rates). Since there is no way to predict which of these two rates will be in effect, it is possible to send the input data stream to two SERDES in parallel, a high-speed SERDES (already in the quad) and a lower-speed SERDES (implemented outside the quad). One possible implementation is shown in Figure 7.28.

There is an input per channel RXD_LDR, low data rate single-ended input from the RX buffer to the FPGA core. In the core a low-speed Clock Data Recovery (CDR) block or a Data Recovery Unit (DRU) can be built using soft logic. A channel register bit, RXD_LDR_EN, can enable this data path. If enabled by another register bit, a signal from the FPGA can also enable this in LatticeECP3.

In the transmit direction, it is also possible to use a serializer built in soft logic in the FPGA core and use the TXD_LDR pin to send data into the SERDES. It will be muxed in at a point just before the pre-emphasis logic near where the regular high-speed SERDES path is muxed with the boundary scan path. This is shown conceptually in Figure 7.28. The low data rate path can be selected by setting a channel register bit, TX_LDR_EN.

Alternatively, on the output side, the high-speed SERDES is used to transmit either high-speed data, or lower speed data using decimation (the SERDES continues to run at high-speed, but the output data can only change every nth clock where n is the decimation factor).

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Figure 7.28 Possible Implementation of Serial Digital Video Support

7.32. Open Base Station Architecture Initiative (OBSAI)

OBSAI is an open forum that is aimed at an open market for cellular base stations.

The LatticeECP3 SERDES/PCS supports most of the OBSAI features except the 3.84 Gbps rate.

Transmit Path

- Serializer
- Transmit State Machine is set to Gigabit Ethernet Mode
- 8b10b Encoding

Receive Path

- Deserializer
- Word alignment based on IEEE 802.3-2002 1000 BASE-X defined alignment characters
- 8b10b Decoding

A Basestation Transceiver System (BTS) has four main components/modules and there are three major interfaces, or Reference Points (RPs), between them.

- RP3 RF Module receives signals from portable devices (terminals) and down converts it to digital data.
- **RP2** The baseband module takes the encoded signal and processes it and sends it to the transport module, which will send it over the terrestrial network.
- **RP1** A control module maintains coordination between these three functions.

Currently, most of the focus in the industry revolves around providing lower RF modules and power amplifiers and hence OBSAI's primary effort has been to define Reference Point 3 (RP3). In fact, the specification of interest is RP3-01, which is focused on Remote Radio Heads (RRHs).

The OBSAI RP3 electrical specification is based on the XAUI electrical specification and customized to the needs of a Base Transceiver System. The XAUI electrical interface is specified in Clause 47 of IEEE 802.3ae-2002. RP3 version 3.1 specifies the following electrical rates 3.84 Gbps, 3.072 Gbps, 2.304 Gbps, 1.536 Gbps and 0.736 Gbps out of which the last four are supported.

The RP3 electrical specification defines a receiver compliance mask and provides a sample transmitter output mask. The BER should be better than $1 \times 10-15$, which is more stringent than XAUI requirement of $1 \times 10-12$. The RP3



electrical specification also differs from the XAUI specification in the definition of the UI. XAUI allows for a difference of +/- 100 ppm. This difference does not apply to OBSAI systems since the BTSes are fully synchronous systems.

Since a BTS is a synchronous system, it is imperative to measure and calibrate the delay across any bus. OBSAI has carefully considered this and, as a result, come up with a method for synchronizing the master frame across the RP3 link. Delay calibration takes into account all factors, including processing, and buffer delay, in transmit and receive modules, as well as the latency across the link.

Another major item in the data-link layer is the synchronization between the transmitter and receiver. Synchronization ensures the actual data can be decoded successfully over the link. The frequency of errors as well as the synchronization status is constantly monitored.

RP3-01 has gone further and specified line rates that are integer multiples of 768 Mbps, up to 3.84 Gbps, and are considered OBSAI compatible line rates. Due to the number of line rates available, auto-negotiation between the remote RF units and the local units is defined. This extension of the specification includes Ethernet transmission between two RP3-01 nodes, mapping of RP1 information into the RP3 link because the RRH does not have a physical RP1 link, delay measurement, synchronization between RP3-01 units, and data multiplexing across the RP3-01 link.

The delay of each functional block in the LatticeECP3 SERDES/PCS is described in the CPRI section.

7.33. Common Public Radio Interface (CPRI)

The goal of CPRI is to allow base station manufacturers and component vendors to share a common protocol and more easily adapt platforms from one user to another.

Transmit Path

- Serializer
- Transmit State Machine is set to Gigabit Ethernet Mode
- 8b10b Encoding

Receive Path

- Deserializer
- Word alignment based on IEEE 802.3-2002 1000 BASE-X defined alignment characters
- 8b10b Decoding

Unlike OBSAI, CPRI does not specify mechanical or electrical interface requirements. In terms of scope, CPRI has a much narrower focus than OBSAI. CPRI looks solely at the link between the RRH and the baseband module(s). In CPRI nomenclature, those modules are known as Radio Equipment (RE) and Radio Equipment Control (REC), respectively. In other words, CPRI is specifying the same interface as the OBSAI RP3 specification. CPRI primarily covers the physical and data link layer of the interface. It also specifies how to transfer the user plane data, control and management (C&M) plane data and the synchronization plane data.

CPRI has had better "traction" for two reasons - the muscle of the companies backing it and the focus on just one interface link (between the RF modules and the Baseband modules) and even at that focusing primarily on the physical and data link layers.

CPRI allows four line bit rate options; 614.4 Mbps, 1.2288 Gbps, 2.4576 Gbps and 3.072 Gbps; at least one of these rates needs to be supported. The higher line rate is always compared to the one that is immediately lower.

CPRI does not have a mandatory physical layer protocol, but the protocol used must meet the BER requirement of 1 x 10-12, which is less stringent than OBSAI. It also specifies the clock stability and the phase noise requirements.

CPRI also recommends two electrical variants: high voltage (HV) and low voltage (LV). HV is guided by 1000Base- CX specifications in IEEE 802.3-2002 clause 39 with 100-ohm impedance. LV is guided by XAUI. LV is recommended for all rates and will be the focus for this device.

It is important to understand two link layer requirements when dealing with the CPRI and OBSAI specifications:

- Link delay accuracy and cable delay calibration
- Startup synchronization



Link Delay Accuracy and Cable Delay Calibration

Though the following discussion largely leverages from the CPRI requirements, the same requirements also apply to OBSAI implementations.

The REs or RRHs are frequency locked to the REC or BTS. Thus, in this synchronous system it is necessary to calibrate all delays between RRHs and the BTS to meet air-interface timing requirements. The interface requires the support of the basic mechanisms to enable calibrating the cable delay on links and the round trip delay on single- and multi-hop connections. Specifically, the reference points for delay calibration and the timing relationship between input and output signals at RE (Radio Equipment) are defined. All definitions and requirements are described for a link between REC Master Port and RE Slave Port in the single-hop scenario as shown in Figure 7.29.



Figure 7.29 Link Between REC Master Port and RE Slave Port (Single Hop Scenario)

Reference points R1-4 correspond to the output point (R1) and the input point (R4) of REC, and the input point (R2) and the output point (R3) of an RE terminating a particular logical connection. The antenna is shown as Ra for reference.

- T12 is the delay of the downlink signal from the output point of REC (R1) to the input point of RE (R2), essentially the downlink cable delay.
- T34 is the delay of the uplink signal from the output point of RE (R3) to the input point of the REC (R4), essentially the uplink cable delay.
- Toffset is the frame offset between the input signal at R2 and the output signal at R3.
- T14 is the frame timing difference between the output signal at R1 and the input signal at R4 (i.e., the round trip delay RTT).

Delay measurement is accomplished using frame timing. CPRI has a 10 ms frame based on the UMTS radio frame number or Node B Frame Number, also known as BFN. Each UMTS Radio Frame has 150 hyperframes (i.e., each HyperFrame is 66.67 us) with the corresponding hyperframe number (HFN = $0 \le Z \le 149$). Each hyperframe has 256 ($0 \le W \le 255$) basic frames (i.e. each basic frame is 260.42 ns = Tchip or Tc).

An RE determines the frame timing of its output signal (uplink) to be the fixed offset (Toffset) relative to the frame timing of its input signal (downlink). Toffset is an arbitrary value, which is greater than or equal to 0 and less than 256 Tc (it cannot slip beyond a hyperframe). Different REs may use different values for Toffset. REC knows the value of Toffset of each RE in advance (pre-defined value or RE informs REC by higher layer message).

To determine T14, the downlink BFN and HFN from REC to RE is given back in uplink from the RE to the REC. In the case of an uplink-signaled error condition, the REC treats the uplinks BFN and HFN as invalid. So, T14 = T12 + Toffset + T34.

As stated earlier the system is synchronous. Further, assuming that hyperframes are of fixed length and the RRH- BTS interconnect (cable length) is equal in both directions (i.e., T12 = T34, both optical fibers are in one bundle), the interconnect delay devolves down to (T14 - Toffset)/2. The method for determining T14 has been discussed earlier. So the major component that affects delay calibration is Toffset. Thus, the interconnect delay is the difference in hyperframe arrival and departure times measured at each side of the link.

Delay calibration requirements are driven by 3GPP and UTRAN requirements specifically requirements R-21 in the CPRI specification (CPRI v3.0 page 20), which states that the accuracy of the round trip delay measurement of the cable delay of one link is +/- Tc/16. Additionally, requirement R-20 states that the round trip time absolute accuracy of the interface, excluding the round trip group delay on the transmission medium (excluding the cable length), shall meet a similar requirement (+/- Tc/16 for T14). Taking into account the previous discussion, the absolute link delay accuracy in



the downlink between REC master port and RE slave port excluding the cable length is half of the above requirement (+/- Tc/32 or approximately 8 ns (8.138 ns)). Thus, both T14 and Toffset need absolute accuracy less than +/- 8 ns.

Next it is important to determine how many bits of uncertainty can be acceptable for the different rates. Essentially, the various CPRI and OBSAI bit rates can be multiplied by 8.138 ns to determine the number of bits worth of indeterminism/variance is acceptable. The impact of this will become clear subsequently when the SERDES serial/parallel data path is discussed.

Most SERDES have a certain level of uncertainty that is introduced in the serializing and de-serializing process. Thus, a SERDES with 16-bit bus architecture may have twice the delay uncertainty as a SERDES with a 8-bit architecture because the number of bits per word is doubled.

TX and RX latency respectively in Table 8.1 is listed. The table also lists the variability between the latency. This variability directly contributes to the absolute delay accuracy required from earlier discussion. The variability comes from three sources: TX FPGA Bridge FIFO, RX FPGA Bridge FIFO and RX Clock Tolerance Compensation FIFO. Since the CPRI system is a synchronous system, the RX CTC FIFO is bypassed and the RX recovered clock is used.

The remaining contributors to the latency variability are the FPGA Bridge FIFO. This FIFO can be bypassed if the interface to the FPGA is 8-bit bus mode. In 16-bit interface mode, the FPGA Bridge FIFO cannot be bypassed because the 2:1 gearing is done via the FIFO.

7.34. SONET/SDH

Synchronous Optical Networking (SONET) and Synchronous Digital Hierarchy (SDH) are standardized multiplexing protocols that transfer data over optical fiber or via an electrical interface. SONET generic criteria are detailed in the Telcordia Technologies Generic Requirements document GR-253-CORE. Generic criteria applicable to SONET and other transmission systems (e.g., asynchronous fiber optic systems or digital radio systems) are found in Telcordia GR-499-CORE. SONET and SDH were originally designed to transport circuit mode communications (e.g., T1, T3) from a variety of different sources. The primary difficulty in doing this prior to SONET was that the synchronization sources of these different circuits were different. This meant each circuit was operating at a slightly different rate and with different phase. SONET allowed for the simultaneous transport of many different circuits of differing origin within a single framing protocol.

The LatticeECP3 SERDES/PCS offers transceivers capable of supporting three SONET/SDH data rates, STS- 3/STM-1 (155.52 Mbps), STS-12/STM-4 (622.08 Mbps) and STS-48/STM-16 (2.488 Gbps). 8-bit SERDES mode is

used for SONET/SDH applications.

In order to be SONET/SDH line-compliant, external components are required with the LatticeECP3. An external line driver is required on the output of the SERDES. To filter out high frequency jitter from the incoming data stream, a jitter cleaner can be applied to the recovered clock before using it as the transmit reference clock.

For chip-to-chip or backplane applications, the external line driver and the clock jitter cleaner are not required. Figure 7.30 shows the line-side solution using external components.





Figure 7.30 SONET/SDH Line Interface

7.35. FPGA Interface Clocks

Figure 7.31 shows a conceptual diagram of the later stage of the PCS core and the FPGA Bridge and the major clocks that cross the boundary between PCS and the FPGA.



Figure 7.31 Conceptual PCS/FPGA Clock Interface Diagram

In the above diagram and in the subsequent clock diagrams in this section, please note that suffix "i" indicates the index [3:0] i.e., one for each channel.

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It is a requirement that if any of the selectors to the clock muxes are changed by writes to register bits, the software agent will reset the logic clocked by that muxed clock.

The PCS outputs 16 clocks. There are two transmit clocks (per channel) and two receive clocks (per channel). The two transmit clocks provide full rate and half rate clocks and are all derived from the TX PLL. There are also two clocks (full and half) per receive channel. All 16 clocks can be used as local (secondary) or global (primary) clocks for the FPGA logic as required. tx_half_clks are used when the gearing is in 2:1 mode. As described in Table 5.4, only tx_full_clk_ch0 and tx_half_clk_ch0 can drive the primary clock routing directly. Other channel clocks can also drive the primary clock net but general routing is used. All of the tx_full_clk_ch[3:0] and tx_half_clk_ch[3:0] signals can drive the secondary clock net by applying a USE SECONDARY clocking preference. General routing is also used to drive Secondary clock net.

The transmit clock is used on the write port of the TX FIFO (or Phase Shift FIFO, depending on the case). One of the two receive clocks is connected to the read clock of the RX FIFO. The other clock is used on the read port of the CTC FIFO and potentially on the write port of the RX FIFO (depending on the case). Based on the whether the CTC and the TX FIFO are bypassed and whether the PCS is in 8bit/10bit interface mode or 16bit/20bit interface mode, four use cases are possible. The active paths are highlighted with weighted lines. It is also indicated how many and what kind of clock trees are required. There are some modes that would more commonly be preferred by the user.

This section describes the operation of the six supported cases. The cases are outlined in Table 7.16.

Table 7.16. Six Interface Cases Between the SERDES/PCS Quad and the FPGA Core

Interface	Data Width	RX CTC FIFO	RX Phase-Shift/ Down- Sample FIFO	TX Phase-Shift/ Up- Sample FIFO
Case I-a ²	8/10 bit	Yes	Yes	Yes
Case I-b ²	8/10 bit	Bypass	Yes	Yes
Case I-c ²	8/10 bit	Yes	Bypass	Bypass
Case I-d ²	8/10 bit	Bypass	Bypass	Bypass
Case II-a ^{1, 2}	16/20 bit	Yes	Yes	Yes
Case II-b ^{1, 2}	16/20 bit	Bypass	Yes	Yes

|--|

Notes:

1. When using a 16/20-bit datapath width, the TX phase-shift (upsample) FIFO and the RX phase-shift FIFO (downsample) are always used. They cannot be bypassed. It is not required that both RX and TX have the same FPGA interface datapath width simultaneously. There is independent control available. For the sake of brevity, they have been represented together in the same use case.

2. The TX phase-shift (upsample) FIFO and the RX phase-shift FIFO (downsample) do not need to be bypassed together. They are indepen- dently controllable. Again, for the sake of brevity, they have been represented here in the same case.

2:1 Gearing

For guaranteed performance of the FPGA global clock tree, it is recommended to use a 16/20-bit wide interface for SERDES line rates greater than 2.5 Gbps. In this interface, the FPGA interface clocks are running at half the byte clock frequency.

Even though the 16/20-bit wide interface running at half the byte clock frequency can be used with all SERDES line rates, the 8/10-bit wide interface is preferred when the SREDES line rate is low enough to allow it (2.5 Gbps and below) because this results in the most efficient implementation of IP in the FPGA core.

The decision matrix for the six interface cases is explained in Table 7.17.



SERDES Line Rate	Datapath Width	Multi-Channel Alignment Required?	CTC Required?	RX FIFO Required?	Interface Case
2.5 Gbps and	8/10 bit	No, single-channel	Yes	Yes	Case I_a ¹
below	(1:1 gearing)	link		No	Case I_c ¹
			No	Yes	Case I_b ²
				No	Case I_d ²
		Yes, multi-channel	Must bypass, not available	Yes	Case I_b ³
		link		No	Case I_d ³
3.2 Gbps and	3.2 Gbps and 16/20 bit (2:1 No, single-channel		Yes	Yes	Case II_a ⁴
below	gearing)	link	No	Yes	Case II_b ^₅
		Yes, multi-channel link	Must bypass, not available	Yes	Case II_b ⁶

Table 7.17. Decision Matrix for Six Interface Cases

Notes:

- 1. This case is intended for single-channel links at line rates of 2.5 Gbps and lower (8/10-bit wide interface) that require clock tolerance com- pensation in the quad. CTC is required when both ends of the link have separate reference clock sources that are within +/- 300 ppm of each other. Case I_a is used if the IP in the core requires the RX phase-shift FIFO. Case I_b is used if the IP does not require this FIFO.
- 2. This case is intended for single-channel links at line rates of 2.5 Gbps and lower (8/10-bit wide interface) that do NOT require clock tolerance compensation in the quad. CTC is not required when both ends of the link are connected to the same reference clock source. This is often the case for chip-to-chip links on the same circuit board. There is exactly 0ppm difference between the reference clocks and so CTC is not required and can be bypassed. CTC is also not required in the quad when this function is performed by the IP in the core.
- 3. This case is intended for multi-channel links at line rates of 2.5 Gbps and lower (8/10-bit wide interface). Multi-channel alignment MUST be done in the FPGA design. Since multi-channel alignment must be done prior to CTC, the CTC FIFO in the quad MUST be bypassed when multi-channel alignment is required and so both multi-channel alignment and CTC (if required) are done by the FPGA design.
- 4. This case is intended for single-channel links at line rates of 3.2 Gbps and lower that require a 2:1 gearbox between the quad and the FPGA core (16/20 bit wide interface). Clock tolerance compensation is included in the quad. CTC is required when both ends of the link have separate reference clock sources that are within +/- 300 ppm of each other.
- 5. This case is intended for single-channel links at line rates of 3.2 Gbps and lower that require a 2:1 gearbox between the quad and the FPGA core (16/20-bit wide interface). Clock tolerance compensation is NOT included in the quad. CTC is not required when both ends of the link are connected to the same reference clock source. This is often the case for chip-to-chip links on the same circuit board. There is exactly 0 ppm difference between the reference clocks and so CTC is not required and can be bypassed. CTC is also not required in the quad when this function is performed by the FPGA design.
- 6. This case is intended for multi-channel links at line rates of 3.2 Gbps and lower that require a 2:1 gearbox between the quad and the FPGA core (16/20-bit wide interface). Multi-channel alignment MUST be done by the FPGA design. Since multi-channel alignment must be done prior to CTC, the CTC FIFO in the quad MUST be bypassed when multi-channel alignment is required and so both multi-channel alignment and CTC (if required) are done by the FPGA design.



7.36. Case I_a: 8/10-Bit, CTC FIFO and RX/TX FIFOs Not Bypassed



Figure 7.32 8/10-Bit, CTC FIFO and RX/TX FIFOs NOT Bypassed

- 1. The TX FIFO acts as a Phase Shift FIFO only in this case.
- 2. The RX FIFO acts as a Phase Shift FIFO only in this case.
- 3. The quad-level full rate clock from the TX PLL (tx_full_clk) has direct access to the FPGA center clock mux. This is a relatively higher performance path. A Global Clock Tree out of the Center Clock Mux is used to clock the user's interface logic in the FPGA. Some leaf nodes of the clock tree are connected to the FPGA Transmit Input clock (txiclk), the CTC FIFO Read Clock per Channel (ebrd_clk) through the FPGA Receive Input clock (rxiclk). This case is possibly the most common single-channel use case.

Example of Clock and Data Signals Interface in FPGA Logic (Case I_a)

Below is a portion of the SERDES/PCS module instantiation in the top module which describes how clock and data ports are mapped in Verilog.

```
.txiclk_ch0(txclk),
.rxiclk_ch0(txclk),
.rx_full_clk_ch0(),
.tx_full_clk_ch0(txclk),
.tx_half_clk_ch0(),
.txdata_ch0(txdata_2_pcs),
.rxdata_ch0(rxdata_from_pcs),
.tx_k_ch0(txkcntl_2_pcs),
.rx_k_ch0(rxkcntl_from_pcs),
ebrd_clk_ch0 is routed automatically by the software, depending on the case.
```

Note that tx_full_clk_ch0 uses wire name 'txclk' and feeds both txi_clk_ch0 and rxi_clk_ch0, as shown in Figure 7.32.

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#LATTICE



Figure 7.33 8b/10-Bit, CTC FIFO Bypassed

- 1. The TX FIFO acts as a Phase Shift FIFO only in this case.
- 2. The RX FIFO acts as a Phase Shift FIFO only in this case.
- 3. The TX FPGA Channel input clock is clocked similarly as in the previous case using a clock tree driven by a direct connection of the full rate transmit FPGA output clock to the FPGA center clock mux. Once the CTC FIFO is bypassed, the recovered clock needs to control the write port of the RX FIFO. The recovered clock of each channel may need to drive a separate local or global clock tree (i.e., up to four local or global clock trees per quad). The clock tree will then drive the FPGA receive clock input to control the read port of the RX FIFO. The reason for bypassing the CTC FIFO in this case is most likely for doing multi-channel alignment in the FPGA core. It implies that CTC using an elastic buffer will be done in the FPGA core. The CTC FIFOs can be written by either the recovered clocks or by a master recovered clock. The read of the CTC FIFO will be done using the TX clock via the TX clock tree.



7.38. Case I_c: 8/10-Bit, RX/TX FIFO Bypassed



Figure 7.34 8/10-Bit, RX/TX FIFO Bypassed

1. The TX channel clocking is similar to the previous two cases. On the RX channel, the FPGA input clock is now ebrd_clki. The FPGA TX clock tree drives this clock. In this case, ebrd_clki is automatically routed by the software.

7.39. Case I_d: 8/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed



Figure 7.35 8b/10-Bit, CTC FIFO and RX/TX FIFOs Bypassed

1. FPGA clock trees can be interchangeably thought of as clock domains in this case. The TX channel clocking is similar to the previous three cases. On the RX channel, the recovered channel RX clock is sent out to the FPGA. This case is useful for supporting video applications.



7.40. Case II_a: 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed



Figure 7.36 16/20-bit, CTC FIFO and RX/TX FIFOs NOT Bypassed

- 1. The TX FIFO acts both as a Phase Shift FIFO and Upsample FIFO in this case.
- 2. The RX FIFO acts both as a Phase Shift FIFO and Downsample FIFO in this case.
- 3. This is a very common single channel use case when the FPGA is unable to keep up with full byte frequency. Two clock trees are required. These clock trees are driven by direct access of transmit full-rate clock and transmit half-rate clock to the FPGA clock center mux. The full-rate clock tree drives the CTC FIFO read port and the RX FIFO write port. The half-rate clock tree drives the RX FIFO and the FPGA logic.

7.41. Case II_b: 16/20-bit, CTC FIFO Bypassed



Figure 7.37 16/20-bit, CTC FIFO Bypassed



- 1. The TX FIFO acts both as a Phase Shift FIFO and Upsample FIFO in this case.
- 2. The RX FIFO is acting both as a Phase Shift FIFO and Downsample FIFO in this case.
- 3. This is a very common multi-channel alignment use case when the FPGA is unable to keep up with full byte frequency. The receive clock trees (up to four) can be local or global. They are running a half-rate clock. The transmit clock tree is driven by direct access of the transmit half-rate clock to the FPGA clock center mux.

8. SERDES/PCS Block Latency

Table 8.1 describes the latency of each functional block in the transmitter and receiver. Latency is given in parallel clock cycles. Figure 8.1 shows the location of each block.

Item	Description	Min.	Avg.	Max.	Fixed	Bypass	Units
Transmit	: Data Latency ¹						
T1	FPGA Bridge – 1:1 gearing with different clocks	1	3	5	—	1	byte clk
	FPGA Bridge – 1:1 gearing with the same clocks	—			3	1	byte clk
	FPGA Bridge – 2:1 gearing	1	3	5	—	-	word clk
T2	8b10b Encoder	—			2	1	byte clk
Т3	SERDES Bridge transmit	—			2	1	byte clk
T4	Serializer: 8-bit mode	_			15 + Δ 1		UI + ps
	Serializer: 10-bit mode	—	-	-	18 + Δ 1	-	UI + ps
T5	Pre-emphasis ON	_	-	-	1 + ∆2	_	UI + ps
	Pre-emphasis OFF	_	-	-	0 + ∆3	_	UI + ps
Receive	Data Latency ²						
R1	Equalization ON	—	-	-	Δ1	-	UI + ps
	Equalization OFF	_			Δ2		UI + ps
R2	Deserializer: 8-bit mode	_			10 + ∆ 3		UI + ps
	Deserializer: 10-bit mode	_	-	-	12 + ∆ 3		UI + ps
R3	SERDES Bridge receive	_	-	-	2	1	byte clk
R4	Word alignment ³	3.1	-	4	—	_	byte clk
R5	8b10b decoder	—			1	1	byte clk
R6	Clock Tolerance Compensation	7	15	23	1	1	byte clk
R7	FPGA Bridge – 1:1 gearing with different clocks	1	3	5	—	1	byte clk
	FPGA Bridge – 1:1 gearing with same clocks	_	_	_	3	1	byte clk
	FPGA Bridge – 2:1 gearing	1	3	5	—	_	word clk

Table 8.1. SERDES/PCS Latency Breakdown

Notes:

1. $\Delta 1 = -245$ ps, $\Delta 2 = +88$ ps, $\Delta 3 = +112$ ps.

2. $\Delta 1 = +118$ ps, $\Delta 2 = +132$ ps, $\Delta 3 = +700$ ps.

3. Table 8.2 shows word aligner latency depending on word alignment offset. The exact offset can be found in channel status register, CH_22, bit [3:0].



Table 8.2. Word Aligner Latency vs. Offset

wa_offset[3:0] (CH_22[3:0])	Latency (Word Clock)
0	4.0
1	3.9
2	3.8
3	3.7
4	3.6
5	3.5
6	3.4
7	3.3
8	3.2
9	3.1



Figure 8.1 Transmitter and Receiver Latency Block Diagram

8.1. SERDES Client Interface

The SCI allows the SERDES/PCS quad to be controlled by registers as opposed to the configuration memory cells. It is a simple register configuration interface. The block diagram of the SCI that resides in the FPGA core is shown in Figure 8.2.





Figure 8.2 SCI Interface Block Diagram

The interface logic that resides in the FPGA core should be developed by users per their interface scheme. Contact Lattice Technical Support for example code.

The SCI_ADDR bus is six bits wide within the block. The bus width at the block boundary is 11 bits. The upper five bits are used for quad block selection and channel selection. Table 8.3 shows the SCI address map for the SERDES quad.

Refer to Appendix A. Configuration Registers and Appendix B. Register Settings for Various Standards for SERDES/PCS register address and bit descriptions.

Table 0.3. JCI AUULESS Mab TOL OD LO FOUL JENDES/ FCS OUdu	Table 8.3. SCI A	ddress Map f	for Up to	Four SERDES	/PCS O	uads
--	------------------	--------------	-----------	-------------	--------	------

Address Bits	Description
SCI_ADDR[5:0]	Register address bits 000000 = select register 0
	000001 = select register 1
	111110 = select register 62
	111111 = select register 63
SCI_ADDR[8:6]	Channel address bits 000 = select channel 0
	001 = select channel 1
	010 = select channel 2
	011 = select channel 3 100 = select Quad 101 = Unused
	110 = Unused
	111 = Unused
SCI_ADDR[10:9]	Quad address bits 00 = select Quad A 01 = select Quad B 10 =
	select Quad C 11 = select Quad D

Read and write operations through this interface are asynchronous. In the WRITE cycle the write data and write address must be set up and held in relation to the falling edge of the SCI_WR. In the READ cycle the timing has to be in relation with the SCI_RD pulse. Figure 8.3 and Figure 8.4 show the WRITE and READ cycles, respectively.

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1. tsu is the setup time for address and write data prior to the falling edge of the write strobe. 2. th is the hold time for address and write data after the falling edge of the write strobe.

Note: To avoid accidental writing to control registers, registers should be used at the SCI input ports to drive them low at power-up reset.





Figure 8.4 SCI READ Cycle, Critical Timing

Table 8.4. Timing Parameters

Parameter	Typical Value	Units
tsu, trddv, taddv	1.127	ns
th, trdde	0.805	ns

The SCI interface is as simple as memory read/write. Here is an example of the pseudo code: Write:

- Cycle 1: Set sci addr[5:0], sciw data[7:0], sci sel = 1'b1
- Cycle 2: Set sci_wrn from $0 \ge 1$
- Cycle 3: Set sci_wrn from $1 \ge 0$, sci_sel = 1'b0

Read:

- Cycle 1: Set sci_addr[5:0], sci_sel = 1'b1
- Cycle 2: Set sci_rd from $0 \ge 1$
- Cycle 3: Obtain reading data from sci_rddata[7:0]
- Cycle 4: Set sci_rd from $1 \ge 0$

8.2. Interrupts and Status

The status bit may be read via the SCI, which is a byte wide and thus reads the status of eight interrupt status signals at a time. The SCI_INT signal goes high to indicate that an interrupt event has occurred. The user is then required to read the QIF status register that indicates whether the interrupt came from the quad or one of the channels. This register is not cleared on read. It is cleared when all interrupt sources from the quad or channel are cleared. Once the aggregated source of the interrupt is determined, the user can read the registers in the associated quad or channel to determine the source of the interrupt. Table 8.5 and Table 8.6 list all the sources of interrupt.



Table 8.5. Quad Interrupt Sources

Quad SCI_INT Source	Description	Register Name
int_qd_out	Quad Interrupt. If there is an interrupt event anywhere in the quad this register bit will be active. This register bit is cleared when all interrupt events have been cleared.	PCS Quad Status Register QD_20
int_ch_out[0:3]	Channel Interrupt. If there is an interrupt event anywhere in the respective channel this register bit will be active. These register bits are cleared when all interrupt sources in the respective channel have been cleared.	PCS Quad Status Register QD_20
ls_sync_statusn_[0:3]_int ls_sync_status_[0:3]_int	Link Status Low (out of sync) channel interrupt Link Status High (in sync) channel interrupt	PCS Quad Interrupt Status Register QD_22
~PLOL, PLOL	Interrupt generated on ~PLOL and PLOL - PLL Loss of Lock	SERDES Quad Status Register QD 25

Table 8.6. Quad Interrupt Sources

Channel SCI_INT Source	Description	Register Name
fb_tx_fifo_error_int fb_rx_fifo_error_int cc_overrun_int cc_underrun_int	FPGA Bridge TX FIFO Error Interrupt FPGA Bridge RX FIFO Error Interrupt CTC FIFO Overrun and Underrun Interrupts	PCS Channel General Interrupt Status Register CH_23
pci_det_done_int rlos_lo_int ~rlos_lo_int rlol_int ~rlol_int	Interrupt generated for pci_det_done Interrupt generated for rlos_lo Interrupt generated for ~rlos_lo Interrupt generated for rlol Interrupt generated for ~rlol	SERDES Channel Interrupt Status Register CH_2A

SERDES Client Interface Application Example

Lattice ORCAstra FPGA configuration software is a PC-based GUI that allows users to configure the operational mode of a Lattice FPGA by programming control bits in the FPGA registers.

SERDES/PCS status information is displayed on-screen in real time, and any configuration can be saved to control registers for additional testing. Use of the GUI does not interfere with the programming of the FPGA core portion. More information and downloadable files for ORCAstra can be found on the Lattice Semiconductor website at www.latticesemi.com/products/designsoftware/orcastra.cfm.

Users can get a complete LatticeECP3 ORCAstra interface design from IPexpress. In addition to the HDL file that contains the ORCAstra interface, a file called "chip.v" (for Verilog) that wraps the ORCAstra interface is also provided.

Dynamic Configuration of the SERDES/PCS Quad

The SERDES/PCS quad can be controlled by registers that are accessed through the optional SERDES Client Interface.

When controlled by the configuration memory cells, it is a requirement that the SERDES/PCS quads must reach a functional state after configuration is complete, without further intervention from the user. This means that any special reset sequences that are required to initialize the SERDES/PCS quad must be handled automatically by the hardware. In other words, use of the SCI is optional. The SERDES/PCS quad does NOT assume that the soft IP is present in the FPGA core.

9. SERDES Debug Capabilities

9.1. PCS Loopback Modes

The LatticeECP3 family provides three loopback modes controlled by control signals at the PCS/FPGA interface for convenient testing of the external SERDES/board interface and the internal PCS/FPGA logic interface. Two loop- back modes are provided to loop received data back onto the transmit data path. The loopback modes are useful for checking the high-speed serial SERDES package pin connections as well as the embedded SERDES and/or PCS logic.

RX-to-TX Serial Loopback Mode

Loops serial receive data back onto the transmit buffer without passing through the CDR or de-serializer. Selecting the RX-to-TX Serial Loopback option in the IPexpress GUI will set both the LB_CTL[1:0] to '10' and TDRV_DAT_SEL[1:0] register bits to '11' (see Table A.47 and Table A.50).

TX-to-RX Serial Loopback Mode

This mode loops back serial transmit data back onto the receiver CDR block. Selecting the TX-to-RX Serial Loop- back option in the IPexpress GUI will set LB_CTL[1:0] to '01' (see Table A.47).

SERDES Parallel Loopback Mode

Loops parallel receive data back onto the transmit data path without passing through the PCS logic. When disabled in the IPexpress GUI, the parallel loopback mode can be dynamically controlled from the FPGA core control signals sb_felb_ch[3:0]_c and sb_felb_rst_ch[3:0]_c.

If the dynamic feature of this loopback mode is not used, the two control signals should be tied to ground.

When enabled in the loopback mode in the IPexpress GUI, the control register bit sb_pfifo_lp(CH_03[5]) is set and the loopback mode is set. The control signals from the FPGA core, sb_felb_ch[3:0]_c and sb_felb_rst_ch[3:0]_c, are not available in the PCS module.

Refer to the Figure 9.1 for the discussion above.



Figure 9.1 Three Loopback Modes



Figure 9.2 Loopback Enable Signals



9.2. ORCAstra

Lattice ORCAstra software helps you quickly explore configuration options without going through a lengthy re-compile process or making changes to your board. Configurations created in the GUI can be saved to memory and re-loaded for later use. To use ORCAstra, the ORCASTRA module from IPexpress must be created and used in the FPGA design.

A macro capability is also available to support script-based configuration and testing. The GUI can also be used to display system status information in real time. Use of the ORCAstra software does not interfere with the programming of the FPGA.

Figure 9.3 shows the ORCAstra GUI top-level window. Users can read and write in this window without going through the subwindows for each PCS channel by read and write data at the address cell. When invoked, ORCAstra will automatically recognize the device type. Or, device types can be selected under the device pull-down menu.

📰 ORCAstra FPGA Control Center	(Default Configuration)	
File -Bowiec-ECP3 Interface-ispVM_JT.	AG_Hub-USB LPT Port=378 Network Custor	mProgrammability Options Help
Lattice [®] Semiconductor Corporation	ECP3 PCS 0	
	ECP3 PCS 1	
	ECP3 PCS 2	LatticeECP3
		Adrs = 00000 Rd Wr Data = 00
	ECP3 PCS 3	Update When Modified Update All Continuous Poling
During This game along scholars of the	denies that will be used. The successful estimated of	Poi All
device was autoselected.	device that will be used. The culterity selected d	evice is also uispidyeu, and is followed by a start (~) if that

Figure 9.3 ORCAstra Top-Level Screen Shot

By default, the data box shown in Figure 9.3 follows Big Endian byte order (i.e., the most significant bit is placed on the left). Users can change to Little Endian order by selecting **Display Data Reversed in Data Box** under the **Options** tab.

Click on the tab Interface=None and select 1 ispVM JTAG Hub USB Interface from the drop-down list.

Then select the C2 0A 80 80 from the Select Target JTAG Device window.

Comm Regio Siz	end 10 ter Code	Manufachurei. Deutsphen	
- 18	CZ 64-80-80	Latite Seniconductor	
- [8	CZ 09 14 80	Latice Seniconductor 021.444CH M4CH XD/Istres1200s_tgbs144	
- 8	C2 02 28 00	Lative Serviconductor 021/Power Manager/ippac_powr1220a/8t100	

Figure 9.4 JTAG Device Selection

Then click **OK** in the ORCAstra Hub I/O window.





Figure 9.5 Hub ID Selection

The figure shows there are activities on channel 0 and channel 1. In this example, we assume that the PCS SCI address is mapped to Quad 0 in the design.

Double-clicking on the **PCS0** (Quad 0) button will open the main window as shown in Figure 9.6.

These standard Windows menus control the selection of the device and interface. They also support various configuration options, including setting up and saving configurations with stored files.

ECP3-PCS 1	δ
lain << Pwr, Rst, Alrms >> SerDes Buffer Optio Main << ECP	ns >> Clocking >> Diagnostics >> Status >> 3-PCS
0001:* User-Configured Mode mode (r 0000:* 1 Gb Ethernet Mode mode (r cc_w cc_w char_mode fb_tx force_int ffs_ts g high_mark cc_w 7 low_mark cc_w 0 1 2 3	0 1 2 3 tx_gear_mode tx_gear_mode tx_gear_bypass tx_gear_bypass ch 1) Image: transformed by transf
000 000 000 000 cc_mai 11C 11C 000 000 cc_mai 11C 11C 000 000 cc_mai 283 283 000 000 cc_mai 17C 17C 000 000 udf_co 0FF 0FF 000 000 udf_co Lock Unlock 000 000 udf_co 10: +/· 4000ppm +/· 600 ppm x2 - - <td>ch_1 pfifo_clr_sel ch_2 reg2[pga_ctrl ch_3 tdrv_ldfine_set ch_4 000: mma_a mma_b rg_en/rg_set mma_mask 000: (disabled) tx_vco_ck_div pll_lol_set 000: divided by 1</td>	ch_1 pfifo_clr_sel ch_2 reg2[pga_ctrl ch_3 tdrv_ldfine_set ch_4 000: mma_a mma_b rg_en/rg_set mma_mask 000: (disabled) tx_vco_ck_div pll_lol_set 000: divided by 1

Figure 9.6 ORCAstra Main Window



Control Boxes and Buttons, Status Boxes and the Text Window

Moving the cursor over a control box and clicking the left mouse button sets the control bits. Both the bit location and function for the selected box are displayed in the text window and will match those of the register map tables in the LatticeECP3 Family Data Sheet. Only the function is displayed when the cursor is over the bit name. Status boxes are similar to control boxes but have an LED appearance and a colored background.

Figure 9.7 shows the SERDES Buffer Options window. Configuration options can be selected from the pull-down menu.

xin→→」 Pwr, Rst, Alrms >	> SerDes Buffer Options	<< Clocking >> Diagno	stics >> Status >>
SerDes Buffer Options <<	-		
Channel 0	Channel 1	Channel 2	Channel 3
Transn	nit	Receive	
000 00: 00%	 tdrv_pre_set 	00: Rovr Eq Disabled	▼ req_lvl_set, req_en
000: default (50 uA)	 tdrv_amp 	0: Rovr AC Coupling	rcv_dcc_en
00: 50 Ohm	rterm_tx	00 = 50 Ohm	▼ rterm_rx
00: 8 usec	 pcs_det_time_sel 	00: default	▼ rterm_rx_adj
000: divided by 1	rx_dco_ck_drv	00 00	dco_status
n	00: pole position for	high frequency range	 rate_sel

Figure 9.7 SERDES Buffer Options Window

More information and downloadable files for ORCAstra can be found on the Lattice Semiconductor website at the following address: www.latticesemi.com/products/designsoftware/orcastra.cfm.

9.3. Other Design Considerations

Simulation of the SERDES/PCS

Table 9.1. Simulation Model Locations

Simulator	Model Location
Active-HDL	ispTOOLS\cae_library\simulation\blackbox\pcsc-aldec.zip
ModelSim	ispTOOLS\cae_library\simulation\blackbox\pcsd-mti_6.0-V1-1.zip
NC-Verilog	ispTOOLS\cae_library\simulation\blackbox\pcsd-ncv.zip
VCS	ispTOOLS\cae_library\simulation\blackbox\PCSD_sim.vp.zip

9.4. 16/20-Bit Word Alignment

The PCS receiver cannot recognize the 16-bit word boundary. When Word Aligner is enabled, the PCS can only do BYTE alignment. The 16-bit word alignment should be done in the FPGA fabric and is fairly straight forward. The simulation model works in the same way. It can be enhanced if users implement an alignment scheme as described below.

For example, if transmit data at the FPGA interface are:

```
YZABCDEFGHIJKLM... (each letter is a byte, 8-bit or 10-bit)
Then the incoming data in PCS after 8b10b decoder and before rx_gearbox are:
YZABCDEFGHIJKLM...
```

After rx_gearbox, they can become:

```
    {ZY}{BA}{DC}{FE}{HG}{JI}{LK}...
    or
    {AZ}{CB}{ED}{GF}{IH}{KJ}{ML}...
```


Clearly, sequence 2 is not aligned. It has one byte offset, but 16/20-bit alignment is needed. Let us say the special character 'A' should be always placed in the lower byte.

Flopping one 20-bit data combines with the current 16/20-bit data to form 32/40-bit data as shown below: 1. {DCBA} {HGFE} {LKJI}...

```
^ | **Found the A in lower 10-bit, set the offset to '0', send out aligned data 'BA'
```

Next clock cycle:

{FEDC}{JIHG}{NMLK}...
^
| **send out aligned data 'DC'

etc.

After the 16/20-bit alignment, the output data are:

```
{ZY}{BA}{DC}{FE}{HG}{JI}{LK}...
```

After the 20-bit alignment, the output data are:

 ${ZY} {BA} {DC} {FE} {HG} {JI} {LK} ...$

Note: The LSB of a 8/10-bit byte or a 16/20-bit word is always transmitted first and received first.

For sample 16/20-bit word alignment code, send your request to techsupport@latticesemi.com.

Unused Quad/Channel and Power Supply

On unused quads and channels, VCCA should be powered up. VCCIB, VCCOB, HDINP/N, HDOUTP/N and REFCLKP/N should be left floating. Unused channel outputs are tristated, with approximately 10 KOhm internal resistor connecting between the differential output pair. During configuration, HDOUTP/N are pulled high to VCCOB.

Even when a channel is used as Rx Only mode or Tx Only mode, both the VCCOB and VCCIB of the channel must be powered up. Unused SERDES is configured in power down mode by default.

Reset and Power-Down Control

The SERDES quad has reset and power-down controls for the entire macro and also for each transmitter and receiver as shown in Figure 9.8. The reset signals are active high and the power-down is achieved by driving the pwrup signals low. The operation of the various reset and power-down controls are described in the following sections.

Note: When the device is powering up and the chip level power-on-reset is active, the SERDES control bits (in the PCS) will be cleared (or will take on their default value). This will put the SERDES quad into the power-down state.



	SERDES/PCS Quad		FPGA Core
CHO	RX	◄	rx serdes rst ch0
CHU	ТХ		tx_pwrup_ch0
CH1	RX		rx_pwrup_ch1 rx_serdes_rst_ch1
on	ТХ	◄	tx_pwrup_ch1
	AUX Channel	←	tx_serdes_rst serdes_rst_qd
CHO	RX		rx_pwrup_ch2 rx_serdes_rst_ch2
UH2 ·	ТХ	┥───	tx_pwrup_ch2
СНЗ	RX		rx_pwrup_ch3 rx_serdes_rst_ch3
	ТХ	◄	tx_pwrup_ch3

Figure 9.8 SERDES/PCS Quad Reset and Power-Down Controls

Typically, all resets are via power-on reset and various FPGA fabric resets. The reset logic is shown in Figure 9.9 and Table 9.2.



Figure 9.9 SERDES/PCS Reset Diagram



Table 9.2. SERDES/PCS Reset Table

Reset Signals	PCS ¹ TX	PCS ¹ RX	SERDES	SERDES	PCS CTRL	TX PLL	CDR PLL	
FPGA	Control Register			тх	RX	Registers		
tx_pcs_rst_ch[3:0]_c	lane_tx_rst[3:0]	Х						
rx_pcs_rst_ch[3:0]_c	lane_rx_rst[3:0]		Х					
rst_qd_c	quad_rst	Х	Х	Х	Х		Х	Х
serdes_rst_qd_c	serdes_rst			Х	Х		Х	Х
rx_serdes_rst_ch[3:0]_c	rrst[3:0] ²				Х			Х
tx_serdes_rst_c	trst						X ³	
TRI_ION (configuration)		Х	Х	Х	Х	Х		

Notes:

- 1. Includes SB (SERDES Bridge), PCS core and FB (FPGA Bridge) sub-blocks.
- 2. For internal use only. This reset should always be tied to '0' unless there is a need to reset the CDR PLL.
- 3. tx_serdes_rst_c reset does not reset the TX PLL. It only forces tx_pll_lol_qd_s to go high.

Rest Signal		Description		
FPGA	Control Register			
rst_qd_c	quad_rst	Active-high, asynchronous input. Resets all SERDES channels including the auxiliary channel and PCS. This reset includes serdes_rst, txpll, cdr, lane_tx_rst, and lane_rx_rst.		
serdes_rst_qd_c	serdes_rst	Active-high, asynchronous input to the SERDES quad. Gated with software register bit. This reset is for the SERDES block only and TXPLL and CDRPLL are included.		
tx/rx_pcs_rst_ch[3:0]_c	lane_tx/rx_rst[0:3]	Active-high, asynchronous input. Resets individual TX/RX channel in SB, PCS core and FB blocks.		
rx_serdes_rst_ch[3:0]_c	rrst[0:3]	Resets loss-of-lock (rlol), loss-of-signal and calibration circuits.		
tx_serdes_rst_c	trst	Resets the loss-of-lock of AUX PLL (plol).		

Table 9.3. Reset Controls Description^{1, 2, 3}

Notes:

- 1. For all channels in the quad running in full-data-rate mode, parallel side clocks are guaranteed to be in-phase.
- 2. For all channels in the quad running in half-data-rate mode, each channel has a separate divide-by-two circuit. Since there is no mechanism in the quad to guarantee that these divide-by-two circuits are in phase after de-assertion of "serdes_rst", the PCS design should assume that the dividers (and therefore the parallel side clocks) are NOT in phase.
- 3. In half-data-rate mode, since there is no guarantee that the parallel side clocks are in phase, this may add channel-to-channel skew to both transmit and receive sides of a multi-channel link.

Parameter	Description	Min.	Тур.	Max.	Units
tSERDES_RST_QD	Quad SERDES Reset high time	1			us
t _{RX_PCS_RST}	Channel RX PCS Reset high time	3			ns
^t TX_PCS_RST	Channel TX PCS Reset high time	3			ns
^t RX_SERDES_RST	Channel RX SERDES reset high time	3			ns
^t TX_SERDES_RST	Quad TX SERDES reset high time	3			ns

Table 9.4. Reset Pulse Specification

Power-Down Control Description

Each RX and TX channel can be individually powered-down by a software register bit or a control signal from the FPGA. The individual channel power-down control bits will only power-down selected blocks within the SERDES macro and the high-speed I/O buffers.



Table 9.5. Power-Down Control Description

Signal		Description
FPGA	Register	
serdes_pd		Active-low asynchronous input to the SERDES quad, acts on all channels including the auxiliary channel. When driven low, it powers down the whole macro including the transmit PLL. All clocks are stopped and the macro power dissipation is minimized. After release, both the TX and RX reset sequences should be followed.
tx_pwrup_ch[0:3]_c	tpwrup[0:3]	Active-high transmit channel power-up – Powers up the serializer and output driver. After release, the TX reset sequence should be followed.
rx_pwrup_ch[0:3]_c	rpwrup[0:3]	Active-high receive channel power-up – Powers up CDR, input buffer (equalizer and amplifier) and loss-of-signal detector. After release, the RX reset sequence should be followed.

Table 9.6. Power-Down/Power-Up Timing Specification

Parameter	Description	Min.	Тур.	Max.	Units
tpwrdn	Power-down time after serdes_pd	20			ns
^t PWRUP	Power-up time after serdes_pd	20			ns

10. SERDES/PCS RESET

10.1. Reset Sequence and Reset State Diagram

After power-up and configuration, all SERDES resets and FPGA resets are applied.

10.2. Reset Sequence Generation

Reset Sequence is included in the IPexpress GUI (available in Diamond 1.1 and later versions).

We recommend to select the reset sequence generation option in IPexpress as described in the Control Setup tab section. The HDL file generated for the SERDES/PCS will include the Tx Reset State Machine and Rx Reset State Machine.

10.2.1. Lock Status Signals Definitions

tx_pll_lol_qd_s:	: 1 = TX PLL loss of lock
	: 0 = TX PLL lock
	It takes 1,400,000 UI to declare the lock of TX PLL
rx_cdr_lol_ch[3:0]_s	: 1 = CDR loss of lock
	: 0 = Lock maintained
	It takes 400,000 reference clock cycles (worst case) to declare the lock of CDR PLL
rx_los_low_ch[3:0]_s	: 1 = Loss of signal detection for each channel
	: 0 = Signal detected

The rx_cdr_lol_ch[3:0]_s status signal is an indicator of the CDR lock status as defined above. However, during the CDR locking process the CDR PLL will lock to a reference clock when there is no input data present. This avoids ignoring the input data when it is restored.

In order to ensure the presence of input data during CDR lock status checking, it is recommended to use the rx_los_low_ch[3:0]_s signal in conjunction with the rx_cdr_lol_ch[3:0]_s signal.



10.3. TX Reset Sequence

- 1. QUAD_RESET: At power up, assert rst_qd_c and tx_pcs_rst_ch[3:0]_c.
- 2. WAIT FOR TIMER1: Start TIMER1. Wait for a minimum 20 ns.
- 3. CHECK_PLOL: Release rst_qd_c.
- 4. WAIT FOR TIMER2: Start TIMER2. If TIMER2 expires and the TX PLL is not locked, go to step 1.
- 5. NORMAL: Release tx_pcs_rst_ch#_c. If tx_pll_lol_qd_s goes high during normal operation, go to step 1.

10.4. RX Reset Sequence

1.	WAIT_FOR_PLOL:	Wait until the TX PLL locks and receive data is present. rx_serdes_rst_ch[3:0]_c is set
		to 0 because rx_los_low[3:0]_s goes high when it is asserted.
2.	RX_SERDES_RESET:	Assert rx_serdes_rst_ch[3:0]_c and rx_pcs_rst_ch[3:0]_c.
3.	WAIT_FOR_TIMER1:	Wait for a minimum of 3 ns.
4.	CHECK_LOL_LOS:	Release rx_serdes_rst_ch_c. Reset TIMER2.
5.	WAIT_FOR_TIMER2:	Wait for both cdr_lol_ch[3:0]_s and rx_los_low_ch[3:0] to go low.
		If there is a transition in rx_lol_los (rx_cdr_lol_ch_s rx_los_low_ch_s),
		go to step 4. If TIMER2 expires with rx_lol_los = 1, go to step 1.
6.	NORMAL:	Release rx pcs rst ch c. If rx lol los goes high, go to step 1.

6. NORMAL:

Note: The RX reset sequence provides the CDR re-locking feature when the input data source is interrupted during normal operation. The RX reset can be applied by channel base.

The reset sequence state diagrams are described in Figure 10.1 and Figure 10.2.

A set of sample reset sequence code is available on the Lattice web site.





Notes: TIMER 1: rst_qd_c asserted for a minimum of 20 ns. TIMER 2: Time to declare TX PLL lock: 1,400,000 UI.

Figure 10.1 TX Reset State Diagram





Notes:

TIMER 1: rx_serdes_rst_ch[3:0]_c asserted for minimum 3 ns.

TIMER 2: Time for rx_lol_los signal to stay low (400,000 reference clock cycles). Any FPGA clock can be used to satisfy the timer requirement.

In the diagram above, rx_lol_los is defined as rx_cdr_lol_ch[3:0]_s || rx_los_low_ch[3:0]_s.

The tx_pll_lol_qd_s input to the state diagram RTL code should be tied low in Rx Only mode or when the recovered clock is used as the Tx PLL reference clock, as in SDI applications.

When multiple receiver channels rx_serdes_rst_ch[3:0]_c are to be asserted, it is recommended to activate the reset signals one channel at a time. Simultaneous resetting of multiple receiver SERDES channels may cause a current surge in the SERDES/PCS quad.

The rx_los_low output from SERDES may be triggered for some input streams with continuous zeros, like the SDI pathological patern. For such applications, the rx_los_low input to the reset state machine must be connected to the carrier detect output (must be inverted) of the cable equalizer if available. In general, CD=1 means carrier is present. So this signal must be inverted to replace rx_los_low. If a cable equalizer is not available, users may tie it to zero but in this case, the CDR can lock to a local reference clock when there is no input data present.

Figure 10.2 RX Reset State Diagram

Power Supply Sequencing Requirements

When using the SERDES with 1.5 V VCCIB or VCCOB, the SERDES should not be left in a steady state condition with the 1.5 V power applied and the 1.2 V power not applied. Both the 1.2 V and the 1.5 V power should be applied to the



SERDES at nominally the same time. The normal variation in ramp_up times of power supplies and voltage regulators is not a concern.

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Appendix A. Configuration Registers

A.1. Quad Registers Overview

Table A.1. Quad Interface Registers Map

BA	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
Per (Quad PCS	Control Registers		•		•	•	•	
00	QD_00	reg_sync_toggle	force_int	char_mode	xge_mode				
01	QD_01	internal use only							
02	QD_02	high_mark[3]	high_mark[2]	high_mark[1]	high_mark[0]	low_mark[3]	low_mark[2]	low_mark[1]	low_mark[0]
03	QD_03						pfifo_clr_sel	internal use only	internal use only
04	QD_04	internal use only							
05	QD_05	internal use only							
06	QD_06	internal use only							
07	QD_07	internal use only							
80	QD_08	internal use only							
09	QD_09	ls_sync_status_3_i nt_ctl	ls_sync_status_2_int_ ctl	ls_sync_status_1_int_ ctl	ls_sync_status_0_int_ ctl	ls_sync_statusn_3_int_ ctl	ls_sync_statusn_2_int_ ctl	ls_sync_statusn_1_int_ ctl	ls_sync_statusn_0_int_ ctl
Per (Quad SER	DES Control Registe	ers						
0A	QD_0A	internal use only	reserved	tx_refck_sel	refck_dcc_en	refck_rterm		refck_out_sel[1]	refck_out_sel[0]
0B	QD_0B	refck25x	bus8bit_sel	reserved	reserved	reserved	reserved	refck_mode[1]	refck_mode[0]
0C	QD_0C	reserved	reserved	reserved	reserved	reserved	reserved	cdr_lol_sel[1]	cdr_lol_sel[0]
0D	QD_0D	internal use only	internal use only	internal use only	pll_lol_sel[1]	pll_lol_sel[0]	tx_vco_ck_div[2]	tx_vco_ck_div[1]	tx_vco_ck_div[0]
0E	QD_0E	internal use only	internal use only	internal use only	internal use only				
OF	QD_0F	plol_int_ctl	-plol_int_ctl	reserved	reserved	reserved	reserved	reserved	reserved
Per (Quad Cloo	k Reset Registers	-		-				
10	QD_10	reserved	reserved	reserved	reserved	serdes_pd	serdes_rst	quad_rst	trst
11	QD_11	reserved	reserved	reserved	reserved	reserved	reserved	reserved	reserved
Per (Quad PCS	Status Registers							
20	QD_20				int_qd_out	int_ch[3]	int_ch[2]	int_ch[1]	int_ch[0]
21	QD_21	ls_sync_status_3	ls_sync_status_2	ls_sync_status_1	ls_sync_status_0	ls_sync_statusn_3	ls_sync_statusn_2	ls_sync_statusn_1	ls_sync_statusn_0
22	QD_22	ls_sync_status_3_i nt	ls_sync_status_2_int	ls_sync_status_1_int	ls_sync_status_0_int	ls_sync_statusn_3_int	ls_sync_statuns_2_int	ls_sync_statusn_1_int	ls_sync_statusn_0_int
23	QD_23	internal use only	internal use only	internal use only	internal use only				
24	QD_24	internal use only	internal use only	internal use only	internal use only				
Per (Quad SER	DES Status Register	rs						
25	QD_25	plol	-plol	reserved	reserved	reserved	reserved	reserved	reserved
26	QD_26	plol_int	-plol_int	reserved	reserved	reserved	reserved	reserved	reserved
27	QD_27	reserved	reserved	reserved	reserved	reserved	reserved	reserved	reserved
28	QD_28	reserved	reserved	reserved	reserved	reserved	reserved	reserved	reserved

A.2. Per Quad PCS Control Registers Details

Table A.2. PCS Control Register QD_00

Bit	Name	Description	Туре	Default
7	reg_sync_toggle	Transition = Reset the four TX serializers to minimize TX lane-to-lane skew Level = Normal operation of TX serializers	RW	0
6	force_int	1 = Force to generate interrupt signal 0 = Normal operation	RW	0
5	char_mode	1 = Enable SERDES characterization mode 0 = Disable SERDES characterization mode	RW	0
4	xge_mode	1 = Selects 10Gb Ethernet 0 = Depends on Channel Mode Selection	RW	0
3:0	Reserved			



Table A.3. PCS Control Register QD_01

Bit	Name	Description	Туре	Default
7:0	Internal use only			

Table A.4. PCS Control Register QD_02

Bit	Name	Description	Туре	Default
7:4	high_mark[3:0]	Clock compensation FIFO high water mark. Mean is 4'b1000.	RW	4'b1001
3:0	low_mark[3:0]	Clock compensation FIFO low water mark. Mean is 4'b1000.	RW	4'b0111

Table A.5. PCS Control Register QD_03

Bit	Name	Description	Туре	Default
7:3	Reserved			
2	pfifo_clr_sel	 1 = pfifo_clr signal or channel register bit clears the FIFO 0 = pfifo_error internal signal self clears the FIFO 	RW	0
1	Internal use only			
0	Internal use only			

Table A.6. PCS Control Register QD_04

Bit	Name	Description	Туре	Default
7:0	Internal use only			

Table A.7. PCS Control Register QD_05

Bit	Name	Description	Туре	Default
7:0	Internal use only			

Table A.8. PCS Control Register QD_06

Bit	Name	Description	Туре	Default
7:0	Internal use only			

Table A.9. PCS Control Register QD_07

Bit	Name	Description	Туре	Default
7:0	Internal use only			

Table A.10. PCS Control Register QD_08

Bit	Name	Description	Туре	Default
7:0	Internal use only			

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Table A.11. PCS Control Register QD_09

Bit	Name	Description	Туре	Default
7	ls_sync_status_3_int_ctl	1 = Enable interrupt for ls_sync_status_3 (in sync) 0 = Disable interrupt for ls_sync_status_3 (in sync)	RW	0
6	ls_sync_status_2_int_ctl	1 = Enable interrupt for ls_sync_status_2 (in sync) 0 = Disable interrupt for ls_sync_status_2 (in sync)	RW	0
5	ls_sync_status_1_int_ctl	1 = Enable interrupt for ls_sync_status_1 (in sync) 0 = Disable interrupt for ls_sync_status_1 (in sync)	RW	0
4	ls_sync_status_0_int_ctl	1 = Enable interrupt for ls_sync_status_0 (in sync) 0 = Disable interrupt for ls_sync_status_0 (in sync)	RW	0
3	ls_sync_statusn_3_int_ctl	 1 = Enable interrupt for ls_sync_status_3 when it goes low (out of sync) 0 = Disable interrupt for ls_sync_status_3 when it goes low (out of sync) 	RW	0
2	ls_sync_statusn_2_int_ctl	 1 = Enable interrupt for ls_sync_status_2 when it goes low (out of sync) 0 = Disable interrupt for ls_sync_status_2 when it goes low (out of sync) 	RW	0
1	ls_sync_statusn_1_int_ctl	 1 = Enable interrupt for ls_sync_status_1 when it goes low (out of sync) 0 = Disable interrupt for ls_sync_status_1 when it goes low (out of sync) 	RW	0
0	ls_sync_statusn_0_int_ctl	 1 = Enable interrupt for ls_sync_status_0 when it goes low (out of sync) 0 = Disable interrupt for ls_sync_status_0 when it goes low (out of sync) 	RW	0

A.3. Per Quad PCS Control Registers Details

Table	A.12.	SERDES	Control	Register	OD	0A
i unic		2511055	00110101	I C BISCCI	<u>ч</u> ь	_0/1

Bit	Name	Description	Туре	Default
7	Internal use only			
6	Reserved		RW	0
5	TX_REFCK_SEL	TxPLL reference clock select 0 = REFCLKP/N 1 = FPGA core	RW	0
4	Reserved			
3	REFCK_RTERM	Termination at reference clock input buffer 0 = High impedance 1 = 50 OHm	RW	1
2	Reserved		RW	0
1	REFCLK_OUT_SEL[1]	0 = refclk2fpga output disable 1 = refclk2fpga output enable	RW	0
0	REFCLK_OUT_SEL[0]	0 = tx_refck_local output enable 1 = tx_refck_local_output disable	RW	0

Note: Refer to Figure 7.5 for Reference Clock Select Control signals.

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Table A.13. SERDES Control Register QD_0B

Bit	Name	Description	Туре	Default
7	REFCK25X	1 = Internal high-speed bit clock is 25x 0 = See REFCK_MODE	RW	0
6	BUS8BIT_SEL	1 = Select 8-bit bus width 0 = Select 10-bit bus width	RW	0
5	Reserved		RW	0
4	Reserved		RW	0
3	Reserved		RW	0
2	Reserved		RW	0
1:0	REFCK_MODE[1:0]	If REFCK25X = 0, then: 00 = Internal high-speed bit clock is 20x 01 = Internal high-speed bit clock is 10x 10 = Internal high-speed bit clock is 16x 11 = Internal high-speed bit clock is 8x If REFCLK25X = 1, then: xx = Internal high-speed bit clock is 25x	RW	00

Table A.14. PCS Control Register QD_0C

Bit	Name	Description	Туре	Default
7:2	Reserved			
1:0	CDR_LOL_SET[1:0]	CDR loss-of-lock setting Lock Unlock 00 = +/-1000ppm x2 +/-1500ppm x2 01 = +/-2000ppm x2 +/-2500ppm x2 10 = +/-4000ppm +/-7000ppm 11 = +/-300ppm +/-450ppm	RW	00

Table A.15. PCS Control Register QD_0D

Bit	Name	Description	Туре	Default
7:6	Internal use only			
5	Internal use only			
4:3	PLL_LOL_SET[1:0]	Lock Unlock 00 = +/- 300ppm x2 +/- 600ppm x2 01 = +/- 300ppm +/- 2000ppm 10 = +/- 1500ppm +/- 2200ppm 11 = +/- 4000ppm +/- 6000ppm	RW	0
2:0	TX_VCO_CK_DIV[2:0]	VCO output frequency select 00x = Divided by 101x = Divided by 2 100 = Divided by 4 101 = Divided by 8 110 = Divided by 16 111 = Divided by 32	RW	0

Table A.16. PCS Control Register QD_0E

Bit	Name	Description	Туре	Default
7:0	Internal use only			

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Table A.17. PCS Control Register QD_0F

Bit	Name	Description	Туре	Default
7	PLOL_INT_CTL	1 = Interrupt enabled for loss of lock on PLOL 0 = Interrupt disabled for loss of lock on PLOL	RO CR	0
6	-PLOL_INT_CTL	1 = Interrupt enabled for obtaining lock on PLOL 0 = Interrupt disabled for obtaining lock on PLOL	RO CR	0
5:0	Reserved			

A.4. Per Quad Reset and Clock Control Registers Details

Table A.18. PCS Control Register QD_10

Bit	Name	Description	Туре	Default
7:4	Reserved			
3	serdes_pd	0 = Assert power down	RW	1
2	serdes_rst	1 = Assert serdes reset	RW	0
1	quad_rst	1 = Assert quad reset	RW	0
0	trst	1 = TX reset	RW	0

Table A.19. PCS Control Register QD_11

Bit	Name	Description	Туре	Default
7:0	Reserved			

A.5. Per Quad PCS Status Registers Details

Table A.20. PCS Status Register QD_20

Bit	Name	Description	Туре	Int?
7:6	Reserved			
5	ion_delay	0 = Delayed global resetn from tri_ion	RO	No
4	int_qd_out	1 = Per quad interrupt status	RO	No
3:0	int_ch_out[3:0]	1 = Per channel interrupt status	RO	No

Table A.21. PCS Status Register QD_21

Bit	Name	Description	Туре	Int?
7	ls_sync_status_3	1 = Alarm generated on sync_status_3	RO	Yes
		0 = Alarm not generated on sync_status_3		
6	ls_sync_status_2	1 = Alarm generated on sync_status_2	RO	Yes
		0 = Alarm not generated on sync_status_2		
5	ls_sync_status_1	1 = Alarm generated on sync_status_1	RO	Yes
		0 = Alarm not generated on sync_status_1		
4	ls_sync_status_0	1 = Alarm generated on sync_status_0	RO	Yes
		0 = Alarm not generated on sync_status_0		
3	ls_sync_statusn_3	1 = Alarm generated on sync_status_3 when it goes	RO	Yes
		low (out of sync)		
		0 = Alarm not generated on sync_status_3 when it		
		goes low (out of sync)		



Bit	Name	Description	Туре	Int?
2	ls_sync_statusn_2	 1 = Alarm generated on sync_status_2 when it goes low (out of sync) 0 = Alarm not generated on sync_status_2 when it goes low (out of sync) 	RO	Yes
1	ls_sync_statusn_1	 1 = Alarm generated on sync_status_1 when it goes low (out of sync) 0 = Alarm not generated on sync_status_1 when it goes low (out of sync) 	RO	Yes
0	ls_sync_statusn_0	 1 = Alarm generated on sync_status_0 when it goes low (out of sync) 0 = Alarm not generated on sync_status_0 when it goes low (out of sync) 	RO	Yes

Table A.22. PCS Interrupt Status Register QD_22

Bit	Name	Description	Туре	Int?
7	ls_sync_status_3_int	1 = Interrupt generated on sync_status_3	RO CR	Yes
		0 = Interrupt not generated on sync_status_3		
6	ls_sync_status_2_int	1 = Interrupt generated on sync_status_2	RO CR	Yes
		0 = Interrupt not generated on sync_status_2		
5	ls_sync_status_1_int	1 = Interrupt generated on sync_status_1	RO CR	Yes
		0 = Interrupt not generated on sync_status_1		
4	ls_sync_status_0_int	1 = Interrupt generated on sync_status_0	RO CR	Yes
		0 = Interrupt not generated on sync_status_0		
3	ls_sync_statusn_3_int	1 = Interrupt generated on sync_status_3 when it	RO CR	Yes
		goes low (out of sync)		
		0 = Interrupt not generated on sync_status_3 when it		
		goes low (out of sync)		
2	ls_sync_statusn_2_int	1 = Interrupt generated on sync_status_2 when it	RO CR	Yes
		goes low (out of sync)		
		o = interrupt not generated on sync_status_2 when it goes low (out of sync)		
1	ls sync statusn 1 int	1 - Interrupt generated on sunc. status, 1 when it		Voc
1		goes low (out of sync)	NO CK	Tes
		0 = Interrupt not generated on sync status 1 when it		
		goes low (out of sync)		
0	ls_sync_statusn_0_int	1 = Interrupt generated on sync_status_0 when it	RO CR	Yes
		goes low (out of sync)		
		0 = Interrupt not generated on sync_status_0 when it		
		goes low (out of sync)		

Table A.23. PCS PCS Status Register QD_23

Bit	Name	Description	Туре	Default
7:0	Internal use only			

Table A.24. PCS Status Register QD_24

Bit	Name	Description	Туре	Default
7:0	Internal use only			

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A.6. Per Quad SERDES Status Registers Details

Table A.25. SERDES Status Register QD_25

Bit	Name	Description	Туре	Int?
7	PLOL	1 = PLL loss-of-lock	RO	Yes
6	-PLOL	1 = PLL lock obtained	RO	Yes
5:0	Reserved			

Table A.26. SERDES Interrupt Status Register QD_26

Bit	Name	Description	Туре	Int?
7	PLOL_INT	1 = Interrupt generated on PLOL	RO CR	Y
		0 = Interrupt not generated on PLOL		
6	-PLOL_INT	1 = Interrupt generated on -PLOL	RO CR	Y
		0 = Interrupt not generated on -PLOL		
5:0	Reserved			

Table A.27. SERDES Status Register QD_27

Bit	Name	Description	Туре	Default
7:0	Reserved			

Table A.28. SERDES Status Register QD_28

Bit	Name	Description	Туре	Default
7:0	Reserved			

A.7. Channel Registers Overview

Table A.29. Channel Interface Registers Map

BA	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
Per	Channel Gen	eral Control Registers	•		•	•	•		
00	CH_00					rio_mode	pcie_mode	fc_mode	uc_mode
01	CH_01	word_align_enable	internal use only	internal use only	ge_an_enable		internal use only	invert_tx	invert_rx
02	CH_02	pfifo_clr	pcie_ei_en	pcs_det_time_sel[1]	pcs_det_time_sel[0]	rx_gear_mode	tx_gear_mode	rx_ch	tx_ch
03	CH_03		sb_bypass	sb_pfifo_lp	internal use only	enc_bypass	internal use only	tx_gear_bypass	fb_loopback
04	CH_04	lsm_sel	ilsm_en	rx_gear_bypass	ctc_bypass	dec_bypass	wa_bypass	rx_sb_bypass	sb_loopback
05	CH_05	min_ipg_cnt[1]	min_ipg_cnt[0]	match_4_enable	match_2_enable				
06	CH_06	cc_match_1[7]	cc_match_1[6]	cc_match_1[5]	cc_match_1[4]	cc_match_1[3]	cc_match_1[2]	cc_match_1[1]	cc_match_1[0]
07	CH_07	cc_match_2[7]	cc_match_2[6]	cc_match_2[5]	cc_match_2[4]	cc_match_2[3]	cc_match_2[2]	cc_match_2[1]	cc_match_2[0]
08	CH_08	cc_match_3[7]	cc_match_3[6]	cc_match_3[5]	cc_match_3[4]	cc_match_3[3]	cc_match_3[2]	cc_match_3[1]	cc_match_3[0]
09	CH_09	cc_match_4[7]	cc_match_4[6]	cc_match_4[5]	cc_match_4[4]	cc_match_4[3]	cc_match_4[2]	cc_match_4[1]	cc_match_4[0]
0A	CH_0A	cc_match_4[9]	cc_match_4[8]	cc_match_3[9]	cc_match_3[8]	cc_match_2[9]	cc_match_2[8]	cc_match_1[9]	cc_match_1[8]
0B	CH_OB	udf_comma_mask[7]	udf_comma_mask[6]	udf_comma_mask[5]	udf_comma_mask[4]	udf_comma_mask[3]	udf_comma_mask[2]	udf_comma_mask[1]	udf_comma_mask[0]
0C	CH_0C	udf_comma_a[7]	udf_comma_a[6]	udf_comma_a[5]	udf_comma_a[4]	udf_comma_a[3]	udf_comma_a[2]	udf_comma_a[1]	udf_comma_a[0]
0D	CH_0D	udf_comma_b[7]	udf_comma_b[6]	udf_comma_b[5]	udf_comma_b[4]	udf_comma_b[3]	udf_comma_b[2]	udf_comma_b[1]	udf_comma_b[0]
0E	CH_0E	udf_comma_a[9]	udf_comma_a[8]	udf_comma_b[9]	udf_comma_b[8]	udf_comma_mask[9]	udf_comma_mask[8]		
0F	CH_0F					cc_underrun_int_ctl	cc_overrun_int_ctl	fb_rx_fifo_error_int_ctl	fb_tx_fifo_error_int_ctl
Per	Channel SERI	DES Control Registers							
10	CH_10	req_en	req_lvl_set	rcv_dcc_en	rate_sel[1]	rate_sel[0]	rx_dco_ck_div[2]	rx_dco_ck_div[1]	rx_dco_ck_div[0]
11	CH_11	internal use only	internal use only	lb_ctl[1]	lb_ctl[0]	internal use only	internal use only	rterm_rx[1]	rterm_rx[0]
12	CH_12	tdrv_amp[2]	tdrv_amp[1]	tdrv_amp[0]	tdrv_pre_set[4]	tdrv_pre_set[3]	tdrv_pre_set[2]	tdrv_pre_set[1]	tdrv_pre_set[0]
13	CH_13	ldr_core2tx_sel				internal use only	internal use only	internal use only	internal use only
14	CH_14	tx_div11_sel	tdrv_dat_sel[1]	tdrv_dat_sel[0]	tdrv_ppre_en	rterm_tx[1]	rterm_tx[0]	rate_mode_tx	tpwrup
15	CH_15	internal use only	internal use only	internal use only	internal use only	ldr_rx2core_en	rx_refck_sel	rate_mode_rx	rpwrup
16	CH_16	rx_div11_sel	rlos_sel				rlos_lset[2]	rlos_lset[1]	rlos_lset[0]
17	CH_17		pci_det_done_int_ctl	rlos_lo_int_ctl	-rlos_lo_int_ctl			rlol_int_ctl	~rlol_int_ctl

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BA	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
Per	Channel Cloc	k Reset Registers					-		
18	CH_18	internal use only	internal use only				rrst	lane_rx_rst	lane_tx_rst
19	CH_19				tx_f_clk_dis	tx_h_clk_en	rx_f_clk_dis	rx_h_clk_en	sel_sd_rx_clk
Per	Channel Gen	eral Status Registers							
20	CH_20					cc_underrun	cc_overrun	fb_rx_fifo_error	fb_tx_fifo_error
21	CH_21	prbs_error_cnt[7]	prbs_error_cnt[6]	prbs_error_cnt[5]	prbs_error_cnt[4]	prbs_error_cnt[3]	prbs_error_cnt[2]	prbs_error_cnt[1]	prbs_error_cnt[0]
22	CH_22					wa_offset[3]	wa_offset[2]	wa_offset[1]	wa_offset[0]
23	CH_23					cc_underrun_int	cc_overrun_int	fb_rx_fifo_error_int	fb_tx_fifo_error_int
24	CH_24		ffs_ls_sync_status	fb_rxrst_o	fb_txrst_o			cc_re_o	cc_we_o
25	CH_25								
Per	Channel SER	DES Status Registers							
26	CH_26		pcie_det_done	rlos_lo	-rlos_lo	rlos_hi	-rlos_hi	rlol	-rlol
27	CH_27	internal use only	internal use only	internal use only	internal use only			cdr_traine_done	pci_connect
28	CH_28	internal use only	internal use only	internal use only	internal use only	internal use only	internal use only	internal use only	internal use only
29	CH_29	internal use only	internal use only	internal use only	internal use only	internal use only	internal use only	internal use only	internal use only
2A	CH_2A		pci_det_done_int	rlos_lo_int	-rlos_lo_int	rlos_hi_int	-rlos_hi_int	rlol_int	-rlol_int
2B	CH_2B								
2C	CH_2C								

A.8. Per Channel PCS Control Registers Details

Table A.30. PCS Control Register CH_00

Bit	Name	Description	Туре	Default
7:4	Reserved			
3	rio_mode	1 = Selects RapidIO mode 0 = Selects other mode (10GbE, 1GbE)	RW	0
2	pcie_mode	1 = Selects PCI Express mode 0 = Selects other mode (RapidIO, 10GbE, 1GbE)	RW	0
1	fc_mode	1 = Selects Fibre Channel mode 0 = Selects other mode (PCI Express, RapidIO, 10GbE, 1GbE)	RW	0
0	uc_mode	1 = Selects User Configured (G8B10B, 8BSER only, 10BSER only) mode 0 = Selects other mode (Fibre Channel, PCI Express, RapidIO, 10GbE, 1GbE)	RW	0

Table A.31. PCS Control Register CH_01

Bit	Name	Description	Туре	Default
7	word_align_enable	1 = Enable continuous comma alignment 0 = Disable continuous comma alignment	RW	0
6	Internal use only			
5	Internal use only			
4	ge_an_enable	1 = Enable GbE Auto-negotiation 0 = Disable GbE Auto-negotiation	RW	0
3	Reserved			
2	Internal use only			
1	invert_tx	1 = Invert transmit data 0 = Do not invert transmit data	RW	0
0	invert_rx	1 = Invert received data 0 = Do not invert received data	RW	0



Table A.32. PCS Control Register CH_02

Bit	Name	Description	Туре	Default
7	pfifo_clr	 1 = Clears PFIFO if quad register bit pfifo_clr_sel is set to 1. This signal is or'ed with interface signal pfifo_clr. 0 = Normal operation 	RW	0
6	pcie_ei_en	1 = PCI Express Electrical Idle enabled 0 = Normal operation	RW	0
5:4	pcs_det_time_sel[1:0]	PCS connection detection time 11 = 16 us 10 = 4us 01 = 2us 00 = 8us	RW	0
3	rx_gear_mode	 1 = Enable 2:1 gearing for receive path on selected channels 0 = Disable 2:1 gearing for receive path on selected channels 		
2	tx_gear_mode	 1 = Enable 2:1 gearing for transmit path onselected channels 0 = Disable 2:1 gearing for transmit path onselected channels 	RW	0
1	rx_ch	1 = Received output can be monitored on the test characterization pins. The test characterization mode (bit 6 in PCS controller register QD_03) should be set to '1'.	RW	0
0	tx_ch	1 = Transmit PCS inputs are sourced from test char- acterization ports. The test characterization mode should be enabled.	RW	0

Table A.33. PCS Control Register CH_03

Bit	Name	Description	Туре	Default
7	Reserved			
6	sb_bypass	1 = Bypass TX SERDES Bridge 0 = Normal operation	RW	0
5	sb_pfifo_lp	1 = Enable parallel loopback from RX to TX via parallel FIFO 0 = Normal operation	RW	0
	Sate west was a sub-			
4	Internal use only			
3	enc_bypass	1 = Bypass 8b10b encoder 0 = Normal operation		
2	internal use only			
1	tx_gear_bypass	1 = Bypass PCS TX gear 0 = Normal operation	RW	0
0	internal use only			

Table A.34. PCS Control Register CH_04

Bit	Name	Description	Туре	Default
7	lsm_sel	1 = Select external RX link state machine 0 = Select internal link state machine	RW	0
6	ilsm_en	1 = Force enabling the RX link state machine 0 = Force disabling the RX link state machine.	RW	0
5	rx_gear_bypass	1 = Bypass PCS RX gear 0 = Normal operation	RW	0
4	ctc_bypass	1 = Bypass clock tolerance compensation 0 = Select Normal data	RW	0
3	dec_bypass	1 = Bypass 8b10b decoder 0 = Normal operation		
2	wa_bypass	1 = Bypass word alignment 0 = Normal operation	RW	0

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Bit	Name	Description	Туре	Default
1	rx_sb_bypass	1 = Bypass RX SERDES bridge 0 = Normal operation	RW	0
0	sb_loopback	1 = Enable loopback in the PCS from TX to RX in SERDES bridge 0 = Normal operation	RW	0

Table A.35. PCS Control Register CH_05

Bit	Name	Description	Туре	Default
7:6	min_ipg_cnt[1:0]	Minimum IPG to enforce	RW	11
5	match_4_enable	1 = Enable four character skip matching (using match 4, 3, 2, 1)	RW	0
4	match_2_enable	1 = Enable two character skip matching (using match 4, 3)	RW	1
3:0	Reserved			

Table A.36. PCS Control Register CH_06

Bit	Name	Description	Туре	Default
7:0	cc_match_1[7:0]	Lower bits of user-defined clock compensator skip pattern 1	RW	8'h00

Table A.37. PCS Control Register CH_07

Bit	Name	Description	Туре	Default
7:0	cc_match_2[7:0]	Lower bits of user-defined clock compensator skip	RW	8'h00
		pattern 2		

Table A.38. Control Register CH_08

Bit	Name	Description	Туре	Default
7:0	cc_match_3[7:0]	Lower bits of user-defined clock compensator skip pattern 3	RW	8'hBC

Table A.39. PCS Control Register CH_09

Bit	Name	Description	Туре	Default
7:0	cc_match_4[7:0]	Lower bits of user-defined clock compensator skip pattern 4	RW	8'h50

Table A.40. PCS Control Register CH_0A

Bit	Name	Description	Туре	Default
7:6	cc_match_4[9:8]	Upper bits of user-defined clock compensator skip pattern 4 [9] = Disparity error	RW	2'b01
5:4	cc_match_3[9:8]	Upper bits of user-defined clock compensator skip pattern 3 [9] = Disparity error [8] = K control	RW	2'b01
3:2	cc_match_2[9:8]	Upper bits of user-defined clock compensator skip pattern 2 [9] = Disparity error [8] = K control	RW	2'b00

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Bit	Name	Description	Туре	Default
1:0	cc_match_1[9:8]	Upper bits of user-defined clock compensator skip pattern 1 [9] = Disparity error [8] = K control	RW	2′b00

Table A.41. PCS Control Register CH_0B

Bit	Name	Description	Туре	Default
7:0	udf_comma_mask[7:0]	Lower bits of user-defined comma mask	RW	8'hFF

Table A.42. PCS Control Register CH_0C

Bit	Name	Description	Туре	Default
7:0	udf_comma_a[7:0]	Lower bits of user-defined comma character 'a'	RW	8'h83

Table A.43. PCS Control Register CH_0D

Bit	Name	Description	Туре	Default
7:0	udf_comma_b[7:0]	Lower bits of user-defined comma character 'b'	RW	8'h7C

Table A.44. PCS Control Register CH_0E

Bit	Name	Description	Туре	Default
7:6	udf_comma_a[9:8]	Upper bits of user-defined comma character 'a'	RW	2'b10
5:4	udf_comma_b[9:8]	Upper bits of user-defined comma character 'b'	RW	2'b01
3:2	udf_comma_mask[9:8]	Upper bits of user-defined comma mask	RW	2'b11 ¹
1:0	Reserved			

Note:

1. In most applications, K28.5 is used as the comma character. The default value of the mask is 1111111111. In G8B10B mode, any comma can be used so the mask will be 111111100 to detect any of the three comma characters, K28.1, 28.5, 28.7.

Table A.45. PCS Interrupt Control Register CH_0F

Bit	Name	Description	Туре	Default
7:4	Reserved			
3	cc_underrun_int_ctl	1 = Enable interrupt for cc_underrun 0 = Disable interrupt for cc_underrun	RW	0
2	cc_overrun_int_ctl	1 = Enable interrupt for cc_overrun 0 = Disable interrupt for cc_overrun	RW	0
1	fb_rx_fifo_error_int_ctl	1 = Enable interrupt on empty/full condition in the receive FPGA bridge FIFO	RW	0
0	fb_tx_fifo_error_int_ctl	1 = Enable interrupt on empty/full condition in the transmit FPGA bridge FIFO	RW	0

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FPGA-TN-02190-2.9



A.9. Per Channel SERDES Control Registers Details

Unless indicated, all channels must be reset after writing any SERDES Control Register.

Bit	Name	Description	Туре	Default
7	REQ_EN	1= Enable receiver equalization 0 = Disable receiver equalization	RW	0
6	REQ_LVL_SET	Level setting for equalization 1 = Long-reach equalization 0 = Mid-length route equalization	RW	0
5	RCV_DCC_EN	1 = Enable receiver DC coupling 0 = Enable receiver AC coupling	RW	0
4:3	RATE_SEL[1:0]	Equalizer pole position select: 00 = HIGH Equalization 01 = MED Equalization 10 = LOW Equalization 11 = Reserved	RW	00
2:0	RX_DCO_CK_DIV[2:0]	VCO output frequency select: 00x = Divide by 1 01x = Divide by 2 100 = divide by 4 101 = Divide by 8 110 = divide by 16 111 = Divide by 32	RW	000

Table A.46. SERDES Control Register CH_10

Table A.47. SERDES Control Register CH_11

Bit	Name	Description	Туре	Default
7:4	LB_CTL[3:0]	Loop back control:	R/W	4'h0
		[3] = internal use only		
		[2] = internal use only		
		[1] = slb_eq2t_en, serial LB from equalizer to driver		
		enable		
		<pre>[0] = slb_t2r_en, serial tx to rx LB enable</pre>		
3:2	Reserved			
1:0	RTERM_RX[1:0]	00 = HiZ, 01 = 50 Ohm, 10 = 60 Ohm, 11 = 75 Ohm	R/W	2'b01

Table A.48. SERDES Control Register CH_12

Bit	Name	Description	Туре	Default
		CML driver amplitude setting:		
		000 = 0%		
		001 = +8%		
		010 = +11%		
7:5	TDRV_AMP[2:0]	011 = +20%	RW	000
		100 = -17%		
		101 = -12%		
		110 = -10%		
		111 = -6%		
		TX drive pre-emphasis level setting [2:0]		
		000 = 0%		
		001 = 5%		
		010 = 12%		
		011 = 18%		
		100 = 25%		
		101 = 33%		
4:0	TDRV_PRE_SET[4:0]	110 = 40%	RW	5'b00000
		111 = 48%		



Bit	Name	Description	Туре	Default
		[4:3] Fine tune (added to any value chosen by		
		bits[2:0] settings above)		
		00 = 0%		
		01 = 2%		
		10 = 3%		
		11 = 5%		

Table A.49. SERDES Control Register CH_13

Bit	Name	Description	Туре	Default
7	ldr_core2tx_sel	1 = Select low speed serial data from FPGA core	RW	0
6	pden_sel	Reserved	RW	0
5:4	Reserved			
3	TDRV_AMP_BOOST	TX Drive amplitude boost 0 = 0%	RW	0
		1 = -25%		
2:0	TDRV_DRVCUR_SET[2:0]	000 = 48%	RW	100
		001 = 30%		
		010 = 60%		
		011 = 50%		
		100 = 0%		
		101 = -7%		
		110 = 19%		
		111 = 8%		

Table A.50. SERDES Control Register CH_14

Bit	Name	Description	Туре	Default
7	TX_DIV11_SEL	0 = Full-rate selection for transmit (high definition SMPTE) 1 = Divide-by-11 selection for transmit (standard definition SMPTE)	RW	0
6:5	TDRV_DAT_SEL [1:0]	Driver output select: 00 = Data from Serializer muxed to driver (normal operation) 11 = Serial LB from equalizer to driver if slb_eq2t_en='1'	RW	00
4	TDRV_PRE_EN	1 = TX driver pre-emphasis enable 0 = TX driver pre-emphasis disable	RW	0
3:2	RTERM_TX[1:0]	TX resistor termination select. Disable when PCI Express mode is selected. 0x = 5K OHm 10 = 50 Ohm 11 = 75 OHm	RW	10
1	RATE_MODE_TX	0 = Full-rate selection for transmit 1 = Half-rate selection for transmit	RW	0
0	tpwrup	0 = Power-down transmit channel 1 = Power-up transmit channel	RW	0

Table A.51. SERDES Control Register CH_15

Bit	Name	Description	Туре	Default
7	Internal use only			
6	Internal use only			
5	Internal use only			
4	Internal use only			

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Bit	Name	Description	Туре	Default
3	ldr_rx2core_en	1 = Enables boundary scan input path for routing the high-speed receive inputs to a lower-speed SERDES in the FPGA (for out-of-band applications)	RW	0
2	rx_refck_sel	RX CDR reference clock select 0 = REFCLKP/N 1 = FPGA core	RW	0
1	RATE_MODE_RX	0 = Full-rate selection for receive 1 = Half-rate selection for receive	RW	0
0	rpwrup	0 = Power-down receive channel 1 = Power-up receive channel	RW	0

Table A.52. SERDES Control Register CH_16

Bit	Name	Description	Туре	Default
7	RX_DIV11_SEL	0 = Full-rate selection for receive (high-definition SMPTE) 1 = Divide by 11 selection for receive (standard- definition SMPTE)	RW	0
6	rlos_sel	1 = Select rlos_hi 0 = Select rlos_lo	RW	0
5:3	Reserved		RW	000
2:0	RLOS_LSET[2:0]	LOS detector reference current adjustment for smaller swing 000 = default 010 = +15% 011 = +25%	RW	010

Table A.53. SERDES Interrupt Control Register CH_17

Bit	Name	Description	Туре	Default
7	Reserved			
6	pci_det_done_int_ctl	1 = Enable interrupt for detection of far-end receiver for PCI Express	RW	0
5	rlos_lo_int_ctl	1 = Enable interrupt for RX loss of signal when input levels fall below the programmed LOW threshold (using rlos_set)	RW	0
4	-rlos_lo_int_ctl	1 = Enable interrupt for RX loss of signal when input level meets or is greater than programmed LOW threshold	RW	0
3	Reserved			
2	Reserved			
1	rlol_int_ctl	1 = Enable interrupt for receiver loss of lock	RW	0
0	-rlol_int_ctl	1 = Enable interrupt when receiver recovers from loss of lock	RW	0

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A.10. Per Channel Reset and Clock Control Registers Details

Bit	Name	Description	Туре	Default
7	Internal use only			
6	Internal use only			
5:3	Reserved			
2	rrst	1 = RX reset	RW	0
1	lane_rx_rst	1 = Assert reset signal to receive logic	RW	0
0	lane_tx_rst	1 = Assert reset signal to transmit logic	RW	0

Table A.54. Reset and Clock Control Register CH 18

Table A.55. Reset and Clock Control Register CH_19

Bit	Name	Description	Туре	Default
7:5	Reserved			
4	tx_f_clk_dis	1 = Disable tx_f_clk	RW	0
3	tx_h_clk_en	1 = Enable tx_h_clk	RW	0
2	rx_f_clk_dis	1 = Disable rx_f_clk	RW	0
1	rx_h_clk_en	1 = Enable rx_h_clk	RW	0
0	sel_sd_rx_clk	1 = Select sd_rx_clk	RW	0

A.11. Per Channel PCS Status Registers Details

Table A.56. PCS Status Register CH_20

Bit	Name	Description	Туре	Int?
7:5	Reserved			
4	pfifo_error	1 = Parallel FIFO error	RO	Yes
		0 = No parallel FIFO error		
3	cc_underrun	1 = CTC FIFO underrun	RO	Yes
		0 = CTC FIFO not underrun		
2	cc_overrun	1 = CTC FIFO overrun	RO	Yes
		0 = CTC FIFO not overrun		
1	fb_rx_fifo_error	1 = FPGA bridge (FB) RX FIFO overrun 0 = FB RX FIFO	RO	Yes
		not overrun		
0	fb_tx_fifo_error	1 = FPGA bridge (FB) TX FIFO overrun 0 = FB TX FIFO	RO	Yes
		not overrun		

Table A.57. PCS Status Register CH_21

Bit	Name	Description	Туре	Int?
7:0	prbs_errors ¹	Count of the number of PRBS errors. Clears to zero on read. Sticks at flip-flop.	RO CR	No

Note:

1. Built-in PRBS generator and checker are for internal use only.

Table A.58. PCS Status Register CH_22

Bit	Name	Description	Туре	Int?
7:4	Reserved			
3:0	wa_offset[3:0]	Word aligner offset	RO	No



Table A.59. PCS Interrupt Status Register CH_23

Bit	Name	Description	Туре	Int?
7:4	Reserved			
3	cc_underrun_int	1 = Interrupt generated on cc_underrun0 = Interrupt not generated on cc_underrun	RO CR	Yes
2	cc_overrun_int	1= Interrupt generated on cc_overrun 0 = Interrupt not generated on cc_overrun	RO CR	Yes
1	fb_rx_fifo_error_int	1 = Interrupt generated on fb_rx_fifo_error 0 = Interrupt not generated fb_rx_fifo_error	RO CR	Yes
0	fb_tx_fifo_error_int	1 = Interrupt generated on fb_tx_fifo_error 0 = Interrupt not generated on fb_tx_fifo_error	RO CR	Yes

Table A.60. PCS Status Register CH_24

Bit	Name	Description	Туре	Int?
7	Reserved			
6	ffs_ls_sync_status	1 = Sync in the link state machine 0 = Not sync in the LSM	RO	No
5	fb_rxrst_o	1 = FPGA bridge RX normal operation 0 = FPGA bridge RX reset	RO	No
4	fb_txrst_o	1 = FPGA bridge TX normal operation 0 = FPGA bridge TX reset	RO	No
3	Reserved			
2	Reserved			
1	cc_re_o	1 = CTC FIFO read enable 0 = CTC FIFO read disable	RO	No
0	cc_we_o	1 = CTC FIFO write enable 0 = CTC FIFO write disable	RO	No

Table A.61. PCS Status Register CH_25

Bit	Name	Description	Туре	Int?
7	Reserved			

A.12. Per Channel SERDES Status Registers Details

Table A.62. SERDES Status Register CH_26

Bit	Name	Description	Туре	Int?
7	Reserved			
6	pci_det_done	 1 = Receiver detection process not completed by SERDES transmitter 0 = Receiver detection process completed by SERDES transmitter 	RO CR	Yes
5	rlos_lo	1 = Indicates that the input signal detected by receiver is below the programmed LOW threshold	RO CR	Yes
4	-rlos_lo	1 = Indicates that the input signal detected by receiver is greater or equal to the programmed LOW threshold	RO CR	Yes
3	Reserved		RO CR	Yes
2	Reserved		RO CR	Yes
1	rlol	1 = Indicates CDR loss of lock to data. CDR is locked to reference clock	RO	Yes

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Bit	Name	Description	Туре	Int?
0	-rlol	1 = Indicates that CDR has locked to data	RO	Yes

Table A.63. SERDES Status Register CH_27

Bit	Name	Description	Туре	Int?
7	Internal use only			
6	Internal use only			
5	Internal use only			
4	Internal use only			
3:2	Reserved			
1	cdr_trained	1 = Indicates CDR training is done	RO	No
0	pci_connect	1 = Receiver detected by SERDES transmitter (at the transmitter device)	RO	No
		0 = Receiver not detected by SERDES transmitter (at the transmitter device)		

Table A.64. SERDES Status Register CH_28

Bit	Name	Description	Туре	Int?
7:0	Internal use only			

Table A.65. SERDES Status Register CH_29

Bit	Name	Description	Туре	Int?
7:0	Internal use only			

Table A.66. SERDES Interrupt Status Register CH_2A

Bit	Name	Description	Туре	Int?
7	Reserved			
6	pci_det_done_int	1 = Interrupt generated for pci_det_done	RO CR	Yes
5	rlos_lo_int	1 = Interrupt generated for rlos_lo	RO CR	Yes
4	-rlos_lo_int	1 = Interrupt generated for -rlos_lo	RO CR	Yes
3	Reserved		RO CR	Yes
2	Reserved		RO CR	Yes
1	rlol_int	1 = Interrupt generated for rlol	RO CR	Yes
0	-rlol_int	1 = Interrupt generated for -rlol	RO CR	Yes

Table A.67. PCS Status Register CH_2B

Bit	Name	Description	Туре	Int?
7	Reserved			

Table A.68. PCS Status Register CH_2C

Bit	Name	Description	Туре	Int?
7	Reserved			

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Appendix B. Register Settings for Various Standards

B.1. Per Channel Register Settings for Various Standards

Table B.1. Per Channel Register Settings for Various Standards

Character	1GbE	10GbE	1GFC	PCI-Ex	RapidIO
K23.7 (F7)	Carrier extend			PAD	
K27.7 (FB)	SOP	ST		Start TLP	A (align)
K28.0 (1C)		SKIP R		SKIP	SC
K28.1 (3C)				FTS	
K28.2 (5C)		SoS		Start DLP	
K28.3 (7C)		ALIGN A		IDLE	PD
K28.4 (9C)		SEQ			
K28.5 (BC)	+D5.6 or D16.2 = IDLE	SYNC K	+D21.4+D21.5 +D21.5 = IDLE	COMMA (used for alignment)	к
K28.6 (DC)					
K28.7 (FC)					R (skip)
K29.7 (FD)	EOP	Т		END	
K30.7 (FE)	ERR	ERR		END BAD	

B.2. Per Quad Register Settings for Various Standards

Table B.2. Per Quad Register Settings for Various Standards

Register	1GbE	10GbE	1G, 2G FC	PCI-Ex 1x	PCI-Ex 4x	RapidIO 1x	RapidIO 4x
comma_a_lo	hex 03	hex 03	hex 03	hex 03	hex 03	hex 03	hex 03
comma_b_lo	hex FC	hex FC	hex FC	hex FC	hex FC	hex FC	hex FC
comma_mask_lo	hex 7F	hex 7F	hex 7F	hex 7F	hex 7F	hex 7F	hex 7F



Appendix C. Attribute Cross Reference Table

Independent Attribute Name	Dependent Attribute Name	Attribute Value	Register Map
QUAD_MODE	{Qn_REFCK_NQ_EN} ⁸	SINGLE :{0} MASTER :{1} SLAVE :{1} SLAVE_END :{0}	{QD_0b[2]}
CHn_PROTOCOL	<pre>{10G_MODE, CHn_PROT_MODE, CHn_RX_DET, CHn_GE_AN_EN}</pre>	GIGE :{0, 0000,00,1} FC :{0,0010,00,0} XAUI :{1,0000,00,0} SRIO :{0,1000,00,0} PCIE :{0,0100,00,0} SDI :{0,0001,00,0} G8B10B :{0,0001,00,0} 10BSER :{0,0001,00,0} 8BSER :{0,0001,00,0} CPRI :{0,0001,00,0} OBSAI :{0,0001,00,0}	{QD_00[4], CH_00[3:0], CH_02[5:4], CH_01[4]}
CHn_MODE	{CHn_TXPWDNB, CHn_RXPWDNB}	RXTX : {11} RXONLY : {01} TXONLY : {10} DISABL : {00} ED :	{CH_14[0], CH_15[0]}
TX_DATARATE_RANGE	{PLL_DIV}	LOWLOW : {110} LOW : {101} MEDLOW : {100} MED : {010} MEDHIG : {010} H HIGH : {000}	{QD_0D[2:0]}
CHn_RX_DATARATE_ RANGE	{CHn_CDR_DIV}	LOWLOW : {110} LOW : {101} MEDLOW : {100} MED : {010} MEDHIG : {000} H HIGH : {000}	{CH_10[2:0]}
REFCK_MULT	{REFCK25X, REFCK_MODE}	8X :{0,11} 10X:{0,01} 16X:{0,10} 20X:{0,00} 25X:{1,00}	{QD_0b[7], QD_0b[1:0]}
CHn_RX_DATA_RATE	{CHn_RX_RATE_MODE, CHn_RX_DIV11}	FULL :{00} DIV2 :{10} DIV11:{01}	{CH_15[1], CH_16[7]}
CHn_TX_DATA_RATE	{CHn_TX_RATE_MODE, CHn_TX_DIV11}	FULL :{00} DIV2 :{10} DIV11:{01}	{CH_14[1], CH_14[7]}
CHn_TX_DATA_WIDTH	{CHn_TXCLKF, CHn_TXCLKH, CHn_TX_GEAR}	8 :{0,1,0} 10:{0,1,0} 16:{0,1,1} 20:{0,1,1}	{CH_19[4], CH_19[3], CH_02[2]}
CHn_RX_DATA_WIDTH	{CHn_RXCLKF, CHn_RXCLKH, CHn_RX_GEAR}	8 :{0,0,0} 10:{0,0,0} 16:{1,1,1} 20:{1,1,1}	{CH_19[2], CH_19[1], CH_02[3]}

Table C.1. Attribute Cross-Reference Table

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Independent Attribute Name	Dependent Attribute Name	Attribute Value	Register Map
CHn_TX_FIFO		DISABLED:{1} ENABLED :{0}	{CH_03[1]}
CHn_RX_FIFO		<pre>DISABLED:{1} ENABLED :{0}</pre>	{CH_04[5]}
PLL_SRC	{TXREFCK_NQ_SEL, TXREFCK_SEL}	REFCLK_EXT :{0,0} REFCLK_CORE:{0,1} REFCLK_NQ :{1,0} ⁸	{QD_0B[3], QD_0A[5]}
CHn_CDR_SRC	{RXREFCK_NQ_SEL, CHn_RXREFCK_SEL, CHn_TRAIN_EN, CHn_TRAIN_DIV }	<pre>REFCLK_EXT :{0,0,0,0} REFCLK_CORE:{0,1,0,0} REFCLK_NQ :{1,0,0,0}* TRAIN_DIV4 :{0,0,1,0}* TRAIN_DIV8 :{0,0,1,1}*</pre>	{QD_0B[4], CH_15[2], CH_15[7], CH_15[6]}
CHn_TDRV ⁷	{CHn_TDRV_AMP, CHn_TDRV_DRVCUR_SET, CHn_TDRV_AMP_BOOST}	-4: {110,100,1} -3: {100,101,0} -2: {100,100,0} -1: {101,100,0} 0: {000,100,0} 1: {001,100,0} 2: {011,100,0} 3: {100,000,0} 4: {000,000,0}	{CH_12[7:5], CH_13[2:0], CH_13[3]}
CHn_TDRV	{CHn_TDRV_AMP,	2: {100,000,0,1,00101}	{CH_12[7:5],
(for PCI Express Protocol only)	CHn_TDRV_DRVCUR_SET, CHn_TDRV_AMP_BOOST, CHn_TDRV_PRE_EN,		CH_13[2:0], CH_13[3], CH_14[4],
CHn_TX_PRE	{CHn_TDRV_PRE_EN, CHn_TDRV_PRE_SET}	DISABLED: {0,00000} 0: {1,00000} 1: {1,00001} 2: {1,00010} 3: {1,00011} 4: {1,00100} 5: {1,00101} 6: {1,00110} 7: {1,00111}	{CH_14[4], CH_12[4:0]}
CHn_RTERM_TX		50:{10} 75:{11} 5K:{0X}	{CH_14[3:2]}
CHn_RX_EQ	{CHn_REQ_EN, CHn_REQ_LVL_SET, CHn_RATE_SEL}	DISABLED :{0,0,00} MID_LOW :{1,0,10} MID_MED :{1,0,01} MID_HIGH :{1,0,00} LONG_LOW :{1,1,10} LONG_MED :{1,1,01} LONG_HIGH:{1,1,00}	{CH_10[7], CH_10[6], CH_10[4:3]}
CHn_RTERM_RX	{CHn_RX_RTERM}	50 :{01} 60 :{10} 75 :{11} HIGH:{00}	{CH_11[1:0]}
CHn_RX_DCC		AC:{0}	{CH_10[5]}



Independent Attribute Name	Dependent Attribute Name	Attribute Value	Register Map
		DC:{1}	
CHn_LOS_THRESHOLD_L O ¹	{CHn_RLOS_E}	0:{0000} 1:{0001} 2:{0010}	<pre>{mc1_ser_ctl_chN[75], CH_16[2:0]}</pre>
		4:{0100} 5:{0101} 6:{0110} 7:{0111}	
PLL_TERM		50:{1} 2K:{0}	{QD_0A[3]}
PLL_DCC		AC:{0} DC:{1}	{QD_0A[4]}
PLL_LOL_SET		0:{00} 1:{01} 2:{10} 3:{11}	{QD_0D[4:3]}
CHn_TX_SB	{CHn_TXPOL, CHn_TXSBBYP}	DISABLED:{0,0} ENABLED :{1,0}	{CH_01[1], CH 03[6]}
CHn_RX_SB	{CHn_RXPOL, CHn_RXSBBYP}	DISABLED:{0,0} ENABLED :{1,0}	{CH_01[0], CH_04[1]}
CHn_TX_8B10B		ENABLED :{0} DISABLED:{1}	{CH_03[3]}
CHn_RX_8B10B		ENABLED :{0} DISABLED:{1}	{CH_04[3]}
CHn_COMMA_A		Note 2	{QD_0C[0:7], QD_0E[6:7]}
CHn_COMMA_B		Note 2	{QD_0D[0:7], OD_0E[4:5]}
CHn_COMMA_M		Note 2	{QD_0B[0:7], QD_0E[2:3]}
CHn_RXWA		<pre>DISABLED:{1} ENABLED :{0}</pre>	{CH_04[2]}
CHn_ILSM		<pre>DISABLED:{1} ENABLED :{0}</pre>	{CH_04[7]}
CHn_CTC	{CHn_RXRECCLK}	ENABLED :{0,0} DISABLED{1,1}	{CH_19[0] , CH_04[4]}
CHn_CC_MATCH1		Note 2	{QD_0A[1:0], CH_06[7:0]}
CHn_CC_MATCH2		Note 2	{QD_0A[3:2], CH_07[7:0]}
CHn_CC_MATCH3		Note 2	{QD_0A[5:4], CH_08[7:0]}
CHn_CC_MATCH4		Note 2	{QD_0A[7:6], QD_09[7:0]}
CHn_CC_MATCH_MODE	{CHn_MATCH_2_EN, CHn_MATCH_4_EN}	1:{0,0} 2:{1,0} 4:{0,1}	{CH_05[4], CH_05[5]}
CHn_CC_MIN_IPG		0:{00} 1:{01} 2:{10} 3:{11}	{CH_05[7:6]}
CCHMARK		0 :{0000} 1 :{0001}	{QD_02[7:4]}



Independent Attribute Name	Dependent Attribute Name	Attribute Value	Register Map
		2 :{0010} 3 :{0011} 4 :{0100} 5 :{0101} 6 :{0110} 7 :{0111} 8 :{1000} 9 :{1001} 10:{1010} 11:{1011} 12:{1100} 13:{1101} 14:{1110} 15:{1111}	
CCLMARK		<pre>0 : {0000} 1 : {0001} 2 : {0010} 3 : {0011} 4 : {0100} 5 : {0101} 6 : {0110} 7 : {0111} 8 : {1000} 9 : {1001} 10: {1010} 11: {1011} 12: {1100} 13: {1101} 14: {1110} 15: {1111}</pre>	{QD_02[3:0]}
CHn_SSLB		DISABLED :{0000, 00} ENABLED_EQ2T:{0010, 11} ENABLED_T2R :{0001, 00}	{CH_11[7:4], CH_14[6:5]}
CHn_SPLBPORTS ⁴	{PFIFO_CLR_SEL, CHn_SB_PFIFO_LP}	DISABLED:{0,0} ENABLED :{1,1}	{QD_03[2], CH_03[5]}
QD_REFCK2CORE		<pre>DISABLED:{0} ENABLED :{1}</pre>	{QD_0a[1]}
INT_ALL	<pre>{PLOLINT, PLOLNINT, CHn_PCIDETINT, CHn_RLOSLINT, CHn_RLOSLNINT, CHn_RLOLINT, CHn_RLOLNINT, CHn_LSSYNCINT, CHn_LSSYNCNINT, CHn_TXFIFOINT, CHn_RXFIFOINT, CHn_CCORUNINT, CHn_CCURUNINT}</pre>	DISABLED:{ 0,0,0,0,0,0,0,0000,00 00, 0,0,0,0} ENABLED:{ 1,1,1,1,1,1,1,1111,11 11, 1,1,1,1}	<pre>{QD_0F[7], QD_0F[6], CH_17[6], CH_17[5], CH_17[4], CH_17[1], CH_17[0], QD_09[7:4], QD_09[3:0], CH_0F[0], CH_0F[1], CH_0F[2], CH_0F[3]}</pre>
CHn_LDR	{CHn_LDR_RX_EN, CHn_LDR_TX_SEL}	DISABLED:{0,0} RXTX :{1,1} RXONLY :{1,0}	{CH_15[3], CH_13[7]}



Independent Attribute Name	Dependent Attribute Name	Attribute Value	Register Map
		TXONLY :{0,1}	
{PLL_SRC, CHn_CDR_SRC}	{REFCKLOCAL}	Note 5	{QD_0A[0]}
{CHn_TX_8B10B, CHn_RX_8B10B}	{BUS8BIT_SEL}	Note 6	{QD_0B[6]}
{CHn_RXWA, CHn_ILSM}	{CHn_SIG_DET}	<pre>{DISABLED, X}³ {0} {ENABLED, DISABLED}{0} {ENABLED, ENABLED} {1}</pre>	{CH_04[6]}
{CHn_RXWA, CHn_ILSM}	{CHn_C_ALIGN}	<pre>{DISABLED, X}2³ {0} {ENABLED, DISABLED}{0} {ENABLED, ENABLED}{0}</pre>	{CH_01[7]}

Notes:

- rx_los_low will only show that a signal has been detected for data rates above 1 Gbps with a maximum CID (Consecutive Identical Digits) of 7 bits (i.e., a minimum input signal transition density as is sent by 8b10b). rx_los_low is only supported with a default setting of rlos_lset[2:0] = 2 for all protocols except PCI Express and SDI. For PCI Express, 2 and 3 are supported. In SDI mode, it is recommended to use the carrier detect output signal (/CD) from the external SDI cable equalizer. rlos_hset is not supported.
- 2. 10-bit symbol code default / populated by the user in the "PCS Advanced Setup" configuration GUI. Since the 10-bit symbol code representation in the GUI is LSB to MSB, the bit representation is swapped appropriately in the table for software use.
- 3. X = do not care.
- 4. If any of the channels is enabled, the quad bit will be set to 1.
- 5. If PLL_SRC and all of the enabled CHn_CDR_SRC is set to REFCLK_CORE then this bit should be 1, else this bit should be 0.
- 6. If any of the enabled channels CHn_TX_8B10B or CHn_RX_8B10B are DISABLED then this bit should be 1 or else this bit should be set to 0.
- 7. The TDRV_AMP attribute has been replaced by TDRV. When the .lpc file is opened, the software will automatically replace the TDRV_AMP attribute with TDRV. If the user attempts to re-compile without re-generating the PCS module, the software will generate an error in the auto- make.log file. Users should either edit the .txt file or re-generate the PCS module using IPexpress.
- 8. refclk_to/from_nq signals are for internal use only.

Protocol	DATARATE	DATARATE Range	REFCK Multiplier	Data Width	RX Equalization ¹
GbE	1.25G	MED	10x, 20x, 25x	8, 16	DISABLE,
SGMII	1.25G	MED	10x, 20x, 25x	8	MID_MED, LONG_MED
PCI Express	2.5G	HIGH	25x, 20x	8, 16	MID_LOW,
XAUI	3.125	HIGH	20x, 10X	16	DISABLE, MID_HIGH, LONG_HIGH
CPRI	614.4M, 1.2288G, 2.4576G, 3.072G	MEDLOW, MED, MEDHIGH, HIGH	10x, 20x, 25x	8, 16	DISABLE, MID_LOW, MID_MED, MID_HIGH, LONG_LOW, LONG_MED, LONG_HIGH
SDI	270M, 1.485G, 2.97G	LOW, MED, HIGH	20x	10, 20	DISABLE, MID_LOW, MID_MED, MID_HIGH, LONG_LOW,

Table C.2. Protocol-Specific SERDES Setup Options



Protocol	DATARATE	DATARATE	REFCK Multiplier	Data Width	RX Equalization ¹
		Range			
					LONG_MED,
					LONG_HIGH
G8B10B	ANY_VALUE	LOWLOW, LOW,	10x, 20x, 25x	8, 16	DISABLE,
8-Bit SERDES		MEDLOW, MED,	8x, 16x	8, 16	MID_LOW,
10-Bit SERDES		MEDHIGH, HIGH	10x, 20x, 25x	8, 16	MID_MED,
USER_DEF			8x, 10x, 16x, 20x, 25x	8, 16	LONG_LOW,
					LONG_MED,
					LONG_HIGH

Notes:

1. Rx Equalization is based on user signal traces. MID ~20", LONG ~40". LOW/MED/HIGH is amount of equalization user needs to test out.

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Appendix D. Lattice Diamond Overview

This appendix discusses the use of Lattice Diamond design software for projects that include the LatticeECP2M SERDES/PCS module.

For general information about the use of Lattice Diamond, refer to the Lattice Diamond User Guide.

If you have been using ispLEVER software for your FPGA design projects, Lattice Diamond may look like a big change. But if you look closer, you will find many similarities because Lattice Diamond is based on the same toolset and work flow as ispLEVER. The changes are intended to provide a simpler, more integrated, and more enhanced user interface.

D.1. Converting an ispLEVER Project to Lattice Diamond

Design projects created in ispLEVER can easily be imported into Lattice Diamond. The process is automatic except for the ispLEVER process properties, which are similar to the Diamond strategy settings, and PCS modules. After importing a project, you need to set up a strategy for it and regenerate any PCS modules.

Importing an ispLEVER Design Project

Make a backup copy of the ispLEVER project or make a new copy that will become the Diamond project.

- 1. In Diamond, choose File > Open > Import ispLEVER Project.
- 2. In the ispLEVER Project dialog box, browse to the project's .syn file and open it.
- 3. If desired, change the base file name or location for the Diamond project. If you change the location, the new Diamond files will go into the new location, <u>but the original source files will not move or be copied. The Diamond project will reference the source files in the original location</u>.

The project files are converted to Diamond format with the default strategy settings.

D.2. Adjusting PCS Modules

PCS modules created with IPexpress have an unusual file structure and need additional adjustment when importing a project from ispLEVER. There are two ways to do this adjustment. The preferred method is to regenerate the module in Diamond. However this may upgrade the module to a more recent version. An upgrade is usually desirable but if, for some reason, you do not want to upgrade the PCS module, you can manually adjust the module by copying its .txt file into the implementation folder. If you use this method, you must remember to copy the .txt file into any future implementation folders.

D.3. Regenerate PCS Modules

- 1. Find the PCS module in the Input Files folder of File List view. The module may be represented by an .lpc, .v, or .vhd file.
- 2. If the File List view shows the Verilog or VHDL file for the module, and you want to regenerate the module, import the module's .lpc file:
 - a. In the File List view, right-click the implementation folder (
 - b. Browse for the module's .lpc file, <module_name>.lpc, and select it.
 - c. Click Add. The .lpc file is added to the File List view.
 - d. Right-click the module's Verilog or VHDL file and choose Remove.
- 3. In File List, double-click the module's .lpc file. The module's IPexpress dialog box opens.
- 4. In the bottom of the dialog box, click **Generate**. The Generate Log tab is displayed. Check for errors and close.

In File List, the .lpc file is replaced with an .ipx file. The IPexpress manifest (.ipx) file is new with Diamond. The .ipx file keeps track of the files needed for complex modules.

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D.4. Using IPexpress with Lattice Diamond

Using IPexpress with Lattice Diamond is essentially the same as with ispLEVER.

The configuration GUI tabs are all the same except for the Generation Options tab. Figure D.1 shows the Generation Options tab window.

retclkp retclkn hdnp_ch0 hdnn_ch0 sci_sel_ch0	hdoutp_ch0→ hdoutn_ch0→	Automatic (Generate Module and Settings as needed) Force Place & Route Process Reset Setematic Section Place & Route Process Reset
 nick_ch0 bick_ch0 [150] bdds_ch0 [150] bcl_cch0 [150] bcl_cch0 [150] bcl_ccc_dip_ch0 [150] bcl_ccc_dip_ch0 [150] bcl_ccc_dip_ch0_c bc_pre_ist_ch0_c bc_pre_ist_ch0_c nc_pres_ch0_c bc_droi_mode_ch0_c bc_droi_mode_ch0_c bcdroi_mode_ch0_c bdroi_ch1 	n_tul_ck_ch0 → n_thal_ck_ch0 → b_thal_ck_ch0 → b_thal_ck_ch0 → [1:0] n_tk_ch0 → [1:0] n_tk_ch0 → [1:0] n_tk_ch0 → [1:0] n_tk_ch0 → [1:0] n_tk_ch0 → n_to_to_to_to_t → n_to_to_to_to_t → n_to_to_to_to_t → hdoutp_ch1 →	Force Node and Setting: Generation Force Setting: Generation Only (error of module generation required) Force Place & Rouse Trace Process Reset Force Place & Rouse Trace Process Reset

Figure D.1 Generation Options Tab

Table D.1. SERDES_PCS GUI Attributes – Generation Options Tab

GUI Text	Description
Automatic	Automatically generates the HDL and configuration(.txt) files as needed. Some changes do not require regenerating both files.
Force Module and Settings Generation	Generates both the HDL and configuration files.
Force Settings Generation Only	Generates only the attributes file. You get an error message if the HDL file also needs to be generated.
Force Place & Route Process Reset	Resets the Place & Route Design process, forcing it to be run again with the newly- generated PCS module.
Force Place & Route Trace Process Reset	Resets the Place & Route Trace process, forcing it to be run again with the newly- generated PCS module.

Note:

Automatic is set as the default option. If either Automatic or Force Settings Generation Only and no sub-options (Process Reset Options) are checked and the HDL module is not generated, the reset pointer is set to Bitstream generation automatically.

After the Generation is finished, the reset marks in the process window will be reset accordingly.

D.5. Creating a New Simulation Project Using Simulation Wizard

This section describes how to use the Simulation Wizard to create a simulation project (.spf) file so you can import it into a standalone simulator.

- 1. In Project Navigator, click Tools > Simulation Wizard. The Simulation Wizard opens.
- 2. In the Preparing the Simulator Interface page click Next.



3. In the Simulator Project Name page, enter the name of your project in the Project Name text box and browse to the file path location where you want to put your simulation project using the Project Location text box and Browse button.

When you designate a project name in this wizard page, a corresponding folder will be created in the file path you choose. Click Yes in the pop-up dialog that asks you if you wish to create a new folder.

- 4. Click either the Active-HDL® or ModelSim® simulator check box and click Next.
- 5. In the Process Stage page choose which type of Process Stage of simulation project you wish to create Valid types are RTL, Post-Synthesis Gate-Level, Post-Map Gate-Level, and Post-Route Gate-level+Timing. Only those process stages that are available are activated.

Note that you can make a new selection for the current strategy if you have more than one defined in your project.

The software supports multiple strategies per project implementation which allow you to experiment with alternative optimization options across a common set of source files. Since each strategy may have been processed to different stages, this dialog allows you to specify which stage you wish to load.

- 6. In the Add Source page, select from the source files listed in the Source Files list box or use the browse button on the right to choose another desired source file. Note that if you wish to keep the source files in the local simulation project directory you just created, check the **Copy Source to Simulation Directory option**.
- 7. Click **Next** and a Summary page appears and provides information on the project selections including the simulation libraries. By default, the Run Simulator check box is enabled and will launch the simulation tool you chose earlier in the wizard in the Simulator Project Name page.
- 8. Click Finish.

The Simulation Wizard Project (.spf) file and a simulation script DO file are generated after running the wizard. You can import the DO file into your current project if desired. If you are using Active-HDL, the wizard will generate an

.ado file and if you are using ModelSim, it creates and .mdo file. Note: PCS configuration file, (.txt) must be added in step 6.



References

- High-Speed PCB Design Considerations (FPGA-TN-02178)
- Electrical Recommendations for Lattice SERDES (FPGA-TN-02077)
- LatticeECP3 Family Handbook (HB1009)
- LatticeECP3 Family Data Sheet (FPGA-DS-02074)

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Revision History

Revision 2.9, January 2020

Section	Change Summary
All	Changed document number from TN1176 to FPGA-TN-02190.
	Updated document template.
Disclaimers	Added this section.

Revision 2.8, August 2014

Section	Change Summary
SERDES	 Updated Rate Modes, section. Revised information on SERDES settings in Note. Updated Generic 8b10b Mode section. Changed K28.1 (k=1, Data=0xFC) to K28.7 (k=1, Data=0xFC) in the example. Updated PCI Express Electrical Idle Transmission section. Changed K28.5 (IDL) to K28.3
	(IDL).

Revision 2.7, April 2014

Section	Change Summary
Architecture Overview	Updated Table 5.4, SERDES_PCS I/O Descriptions. Revised control comma aligner description.
SERDES	Updated External Link State Machine Option section. Revised word aligner and Link State Machine options information.

Revision 2.6, March 2014

Section	Change Summary
SERDES/PCS Block Latency	Updated Table 8.1, SERDES/PCS Latency Breakdown. Revised units.
Appendix A. Configuration	Updated Table A.15, PCS Control Register QD_0D. Revised PLL_LOL_SET[1:0] description.
Registers	

Revision 2.5, June 2013

Section	Change Summary
SERDES	Added note on possible lsm_status_ch(0:3)_s glitches.
	Updated note on the SERDES/PCS GUI – PCS Advanced2 Setup Tab table.
Appendix C. Attribute Cross Reference Table	Updated the Protocol-Specific SERDES Setup Options table.
Appendix A. Configuration Registers	Updated the SERDES Control Register CH_10 table.
All	Added information on the SERDES Equalizer and Pre-Emphasis settings.
Technical Support Assistance	Updated Technical Support Assistance information.

Revision 2.4, August 2012

Section	Change Summary
All	Added LatticeECP3-17EA 328 csBGA limited channels availability.
Architecture Overview	SERDES_PCS I/O Descriptions table – Added footnote 3.
SERDES/PCS RESET	RX Reset State Diagram footnote updated.

Revision 2.3, May 2012

Section	Change Summary
All	Clarified data pattern requirements for LSM synchronization in generic 8b10b mode.

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Revision 2.2, April 2012

Section	Change Summary
Architecture Overview	Updated Number of SERDES/PCS Quads per LatticeECP3 Device table for 328-ball csBGA.
	SERDES_PCS I/O Descriptions table – Updated description for refclk2tpga.
SERDES	 SERDES_PCS GUI Attributes - SERDES Advanced Setup Tab table - Updated footnote 3. Added new Reference Clock to FPGA Core and Reset Sequence text section. Updated Generic 8b10b Mode text section. Updated FPGA Interface Clocks text section.
Appendix A. Configuration Registers	 Appendix A, Channel Interface Registers Map table – Updated information for CH_16, CH_17 and CH_23. Appendix A, SERDES Control Register CH_11 table – Changed Bit 3:2 to "Reserved".

Revision 2.1, February 2012

Section	Change Summary
All	Updated document with new corporate logo.

Revision 2.0, November 2011

Section	Change Summary
Architecture Overview	SERDES_PCS I/O Descriptions table – Updated descriptions for tx_full_clk_ch[3:0] and tx_half_clk_ch[3:0].
SERDES	 Updated Tx Lane-to-Lane Skew text section. Updated word alignment control bullet in the Word Alignment (Byte Boundary Detect) section. Updated External Link State Machine Option text section.
SERDES Debug Capabilities	Power-Down Control Description table – Updated description for tx_pwrup_ch[0:3]_c signal.
Appendix A. Configuration Registers	 Appendix A, SERDES Control Register QD_0B table – Updated description for Bit 7. Appendix A, PCS Control Register CH_01 table – Updated description for Bit 7.
Appendix C. Attribute Cross Reference Table	Appendix C, Attribute Cross-Reference table – Updated attribute value for {CHn_RXWA, CHn_ILSM}.

Revision 1.9, September 2011

Section	Change Summary
Appendix A. Configuration Registers	 SERDES Control Register CH_14, corrected default value of tpwrup register bit. PCS Control Register QD_02, updated default values.
Appendix C. Attribute Cross Reference Table	Attribute Cross-Reference Table, removed all int_all reserved bits and los hi bits.

Revision 1.8, July 2011

Section	Change Summary
Standards Supported	Standards Supported by SERDES table – updated information for Gigabit
	Ethernet, SGMII, 10-Bit SERDES, 8-Bit SERDES, Generic 8b10b.
Architecture Overview	Transmit Data Bus section updated.
	Receive Data Bus section updated.
SERDES	Updated footnotes for Loss of Signal Detector figure.
	• SERDES_PCS GUI Attributes - Quad Tab Setup table – Added SGMII to Protocol Range.
SERDES/PCS Block Latency	SERDES/PCS Latency Breakdown table – updated gearing information
SERDES Debug Capabilities	Simulation Model Locations table – Added VCS row.
	Updated SERDES/PCS Reset Diagram.
SERDES/PCS RESET	Updated footnotes of the Rx Reset State Diagram.
Appendix A. Configuration	 Updated information for bit 5 in the SERDES Control Register QD_0A table.
Registers	• Updated information for bits 3 and 2:0 in the SERDES Control Register CH_13 table.
	Added footnote to PCS Status Register CH_21 table.

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Section	Change Summary
Appendix C. Attribute Cross	Attribute Cross Reference Table – Updated attribute values for TX_DATARATE_RANGE and
Reference Table	CHn_RX_DATARATE_RANGE. Updated first footnote

Revision 1.7, December 2010

Section	Change Summary
SERDES/PCS RESET	Added Reset Sequence Generation option in the IPexpress GUI.
All	Added detailed information about comma mask.

Revision 1.6, June 2010

Section	Change Summary
All	Updated for Lattice Diamond design software support.
SERDES	refclk_to/from_nq signals removed from clock diagram.

Revision 1.5, March 2010

Section	Change Summary
SERDES	Added Generation Options tab in IPexpress GUI.

Revision 1.4, February 2010

Section	Change Summary
SERDES/PCS RESET	Reset sequence state diagram updated.

Revision 1.3, November 2009

Section	Change Summary
SERDES/PCS RESET	Updated Reset Sequence State Diagrams are provided, tx and rx side separately.
All	los settings are updated.
	Added SONET support.
	Removed Far End Parallel Loopback feature.
	Data rate ranges are re-defined.
	Reduced minimum data rate to 150 Mbps.

Revision 1.2, June 2009

Section	Change Summary
All	tdrv_amp attribute setting changed to tdrv attribute.
	• GUI screen shots updated.
	Word alignment latency updated.
SERDES	Added External Link State Machine Option section.
	Added Idle Insert for Gigabit Ethernet Mode section.

Revision 1.1, March 2009

Section	Change Summary
Multiple	Updated Data Bus Usage for Each Mode table.
All	Updated Reference Clock Usage Block Diagram.

Revision 1.0, February 2009

Section	Change Summary
All	Initial release.

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